

HCD-MD1EX

SERVICE MANUAL

Self Diagnosis
Supported model

Ver 1.1 2001.02



US Model
Canadian Model
AEP Model
UK Model
E Model

HCD-MD1EX is the Amplifier, CD player,
Mini disc Deck and Tuner section in
CMT-MD1.

U.S. and foreign patents licensed form Dolby Laboratories
Licensing Corporation.

CD Section	Model Name Using Similar Mechanism	HCD-MD333
	Base Unit Name	BU-22BD19
	Optical Pick-up Name	KSS-213B/K-N
MD Section	Model Name Using Similar Mechanism	HCD-MD333
	Mechanism Name	MDM-3J
	Optical Pick-up Name	KMS-260A/J1N

SPECIFICATIONS

Amplifier section

AUDIO POWER SPECIFICATIONS: (USA models only)

POWER OUTPUT AND TOTAL HARMONIC DISTORTION:

with 4 ohm loads both channels driven, from
90-15,000 Hz; rates 15 watts per channel
minimum RMS power, with no more than
0.9% total harmonic distortion from
250 milliwatts to rated output.

Canadian model:

Continuous RMS power output
17 + 17 watts
(4 ohms at 1 kHz, 10%
THD, 120 V) (Reference)

European model:

DIN power output (Rated)
15 + 15 watts
(4 ohms at 1 kHz, DIN,
230 V)

Continuous RMS power output (Reference)
17 + 17 watts
(4 ohms at 1 kHz,
10% THD, 230 V)

Music power output (Reference)
22 + 22 watts

Other models:

Continuous RMS power output (Reference)
15 + 15 watts
(4 ohms at 1 kHz,
10% THD, 240 V)

Peak music power output 280 watts

Inputs

TAPE IN (phono jacks):
voltage 250 mV/125 mV,
impedance 47 kilohms
TAPE OUT (phono jacks):
voltage 250 mV
impedance 1 kilohms

Outputs

PHONES (Stereo minijack):

accepts headphones of 8
ohms or more.

SPEAKER:

accepts impedance of 4 to
16 ohms.

– Continued on next page –

COMPACT Hi-Fi COMPONENT SYSTEM

9-922-950-12
2001B0500-1
© 2001.2

Sony Corporation
Audio Entertainment Group
General Engineering Dept.

SONY®

CD player section

System	Compact disc and digital audio system
Laser	Semiconductor laser ($\lambda=780$ nm) Emission duration: continuous
Laser output	Max. $44.6 \mu W^*$ *This output is the value measured at a distance of 200 mm from the objective lens surface on the Optical Pick-up Block with a 7 mm aperture.
Frequency response	20 Hz - 20 kHz

MD deck section

System	MiniDisc digital audio system
Laser	Semiconductor laser ($\lambda=780$ nm) Emission duration: continuous
Laser output	Max. $44.6 \mu W^*$ *This output is the value measured at a distance of 200 mm from the objective lens surface on the Optical Pick-up Block with a 7 mm aperture.
Recording time	74 minutes max. (using MDW-74)
Sampling frequency	44.1 kHz
Frequency response	20 Hz to 20 kHz

Tuner section

FM stereo, FM/AM superheterodyne tuner

FM tuner section

Tuning range	87.5 - 108.0 MHz (50 kHz step)
Antenna	FM lead antenna
Antenna terminals	75 ohms unbalanced
Intermediate frequency	10.7 MHz

AM tuner section

Tuning range	
European model:	
AM:	531 - 1,602 kHz (with the interval set at 9 kHz)
Other models:	
AM:	531 - 1,602 kHz (with the interval set at 9 kHz) 530 - 1,710 kHz (with the interval set at 10 kHz)
Antenna	AM loop antenna External antenna terminals
Intermediate frequency	450 kHz

General

Power requirements	
North American model:	120 V AC, 60 Hz
European model:	230 V AC, 50/60 Hz
Other models:	110 - 120 V or 220 - 240 V AC, 50/60 Hz

Power consumption	
North American and European models:	70 watts

Other models:	80 watts
---------------	----------

Dimensions	
Amplifier/Tuner/MD/CD section:	Approx. $130 \times 215 \times 245$ mm ($5 \frac{1}{8} \times 8 \frac{1}{2} \times 9 \frac{3}{4}$ in) (w/h/d) incl. projecting parts and controls
Speaker:	Approx. $215 \times 215 \times 160$ mm ($8 \frac{1}{2} \times 8 \frac{1}{2} \times 6 \frac{3}{8}$ in) (w/h/d) incl. projecting parts and controls

Mass	
Amplifier/Tuner/MD/CD section:	Approx. 4.6 kg (10 lb 2 oz.)

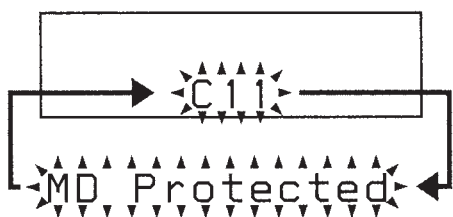
Design and specifications are subject to change without notice.

SELF-DIAGNOSIS FUNCTION

The self-diagnosis function consists of error codes for users which are displayed automatically when errors occur, and error codes which show the error history in the test mode during servicing. For details on how to view error codes for users, refer to the following box in the instruction manual. For details on how to perform checks during servicing, refer to the following "Procedure for Using the Self-Diagnosis Function (Error History Display Mode)".

Self-diagnosis Display

This system has the Self-diagnosis display function to let you know if there is a system malfunction. The display shows a code made up of three letters and a message alternately to show you the problem. To solve the problem refer to the following list. If any problem persists, consult your nearest Sony dealer.



C11/MD Protected

The MD is protected against erasure.

→Remove the MD and slide the tab to close the slot

C13/REC Error

Recording is not possible.

→Move the system to a stable place and start recording over from the beginning.

The MD is dirty or is scratched or the MD does not meet the standards.

→Change the MD with another one and start recording over from the beginning.

C13/Disc Error

The system cannot read the disc information correctly.

→Eject the MD once, then insert it again.

C14/Disc Error

The system cannot read the disc information correctly.

→Change the MD with another one.

→Erase all the recorded contents of the MD using the Erase function.

Procedure for Using the Self-Diagnosis Function (Error History Display Mode)

Note: Perform the self-diagnosis function in the "error history display mode" in the test mode. The following describes the least required steps. Be careful not to enter other modes by mistake. If other modes are set accidentally, press the **▶|| (CD)** button to exit that mode.

1. With the power off, press the **◀◀◀** button while pressing the **VOLUME-** button.
2. Press the **VOLUME+/-** button to display "ERR DP MODE".
3. Pressing the **■ (CD)** button sets the error history mode and displays "total rec".
4. Select the contents to be displayed or executed with pressing the **VOLUME+/-** button.
5. Pressing the **▲ (CD)** button displays or executes the contents selected.
6. Pressing the **▲ (CD)** button another time returns to step 4.
7. Pressing the **▶|| (CD)** button displays "ERR DP MODE" and exits the error history mode.
8. To exit the test mode, press the **■ (MD)** button while pressing the **FUNCTION** button. The unit sets into the STANDBY state, and the test mode ends.

ITEM OF ERROR HISTORY MODE ITEMS AND CONTENTS

Selecting the Test Mode

Display	Details of History
total rec	Displays the recording time in the form of “r□□□□□h”. The displayed time is the total number of hours the laser is high power, which is about one-fourth of the actual recording time. The time is displayed in decimal digits between 0h to 65535h.
total play	Displays the playback time in the form of “p□□□□□h”. The displayed time is the total actual play time. The paused time is not counted. The time is displayed in decimal digits between 0h to 65535h.
retry err	Displays the total number of retries during recording and retry errors during playback in the form of “r□□p□□”. “r” indicates the retries during recording while “p” indicates the retry errors during playback. The number of retries is displayed in hexadecimal digits between 00 to FF.
total err	Displays the total number of errors in the form of “total □□”. The number of errors is displayed in hexadecimal digits between 00 to FF.
err history	Displays the 10 latest errors in the form of “0□ E@@”. The □ indicates the history number. The smaller the number, the newer is the error. (00 is the latest error.) The @@ indicates the error code. Refer to the following table for details. Press the [VOLUME+/-] button to switch the error history.
er refresh?	Mode which erases all the error histories. The error history serves as a reference for when to replace the optical pick-up. Perform this procedure when the optical pick-up has been replaced in order to erase past error histories and not at other times. Press the [CD] button when “er refresh??” is displayed. The history will be erased and “Complete!” will be displayed momentarily. Be sure to check the following when this mode has been executed. <ul style="list-style-type: none"> • Check that the data has been erased. • Perform recording and playback, and check that the mechanism operates normally.

Table of Error Codes

Error Code	Details of Error	Error Code	Details of Error
E00	No error	E05	FOK has deviated
E01	Disc error. Cannot read PTOC (Disc is ejected out)	E06	Unfocused (Servo has deviated)
		E07	Recording retry
E02	Disc error. UTOC error (Disc is not ejected out)	E08	Recording retry error
		E09	Play retry error
E03	Loading error		
E04	Cannot read address (Servo has deviated)	E0A	Playback retry error (C2 error)

TABLE OF CONTENTS

SELF-DIAGNOSIS FUNCTION	3
1. SERVICING NOTES	6
2. GENERAL	9
3. DISASSEMBLY	12
4. SERVICE MODE	19
5. TEST MODE	20
6. ELECTRICAL ADJUSTMENTS	
MD Section	26
CD Section	31
7. DIAGRAMS	
7-1. Block Diagram – CD Section –	33
7-2. Block Diagram – MD Section –	35
7-3. Block Diagram – MAIN Section –	37
7-4. Block Diagram – DISPLAY/POWER SUPPLY Section –	39
7-5. Note for Printed Wiring Boards and Schematic Diagrams	42
7-6. Printed Wiring Board – BD (CD) Section –	43
7-7. Schematic Diagram – BD (CD) Section –	45
7-8. Printed Wiring Board – BD (MD) Section –	47
7-9. Schematic Diagram – BD (MD) Section (1/3) –	49
7-10. Schematic Diagram – BD (MD) Section (2/3) –	51
7-11. Schematic Diagram – BD (MD) Section (3/3) –	53
7-12. Printed Wiring Board – MAIN Board (side A) –	55
7-13. Printed Wiring Board – MAIN Board (side B) –	57
7-14. Schematic Diagram – MAIN Section (1/2) –	59
7-15. Schematic Diagram – MAIN Section (2/2) –	61
7-16. Printed Wiring Boards – PANEL Section –	63
7-17. Schematic Diagram – PANEL Section –	65
7-18. Printed Wiring Boards – AMP/TRANSFORMER Section –	67
7-19. Schematic Diagram – AMP/TRANSFORMER Section –	69
7-20. Printed Wiring Board – POWER Section –	71
7-21. Schematic Diagram – POWER Section –	73
7-22. Printed Wiring Boards – MOTOR/SW Section –	75
7-23. Schematic Diagram – MOTOR/SW Section –	76
7-24. IC Pin Function Description	86
8. EXPLODED VIEWS	96
9. ELECTRICAL PARTS LIST	103

SECTION 1

SERVICING NOTES

Flexible Circuit Board Repairing

- Keep the temperature of the soldering iron around 270 °C during repairing.
- Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
- Be careful not to apply force on the conductor when soldering or unsoldering.

Notes on chip component replacement

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

CAUTION

Danger of explosion if battery is incorrectly replaced.
Replace only with the same or equivalent type recommended by the manufacturer.
Discard used batteries according to the manufacturer's instructions.

ADVARSEL!

Lithiumbatteri-Eksplosionsfare ved fejlagtig håndtering.
Udskiftning må kun ske med batteri
af samme fabrikat og type.
Levér det brugte batteri tilbage til leverandøren.

ADVARSEL

Eksplosjonsfare ved feilaktig skifte av batteri.
Benytt samme batteritype eller en tilsvarende type
anbefalt av apparatfabrikanten.
Brukte batterier kasseres i henhold til fabrikantens
instruksjoner.

WARNING

Explosionsfara vid felaktigt batteribyte.
Använd samma batterityp eller en likvärdig typ som
rekommenderas av apparattillverkaren.
Kassera använt batteri enligt gällande föreskrifter.

VAROITUS

Paristo voi räjähtää, jos se on virheellisesti asennettu.
Vaihda paristo ainoastaan laitevalmistajan suosittelemaan tyyppiin.
Hävittä käytetty paristo valmistajan ohjeiden mukaisesti.

SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY A \triangle MARK ON THE SCHEMATIC DIAGRAMS, EXPLODED VIEWS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic break-down because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body.

During repair, pay attention to electrostatic break-down and also use the procedure in the printed matter which is included in the repair parts.

The flexible board is easily damaged and should be handled with care.

NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe from more than 30 cm away from the objective lens.

LASER DIODE AND FOCUS SEARCH OPERATION CHECK

Carry out the "S curve check" in "CD section adjustment" and check that the S curve waveforms is output three times.

Notes on chip component replacement

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

Flexible Circuit Board Repairing

- Keep the temperature of the soldering iron around 270 °C during repairing.
- Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
- Be careful not to apply force on the conductor when soldering or unsoldering.

Note:

Be sure to connect all wires (including FFC) in the MD section before applying power or ICs may be damaged.

ATTENTION AUX COMPOSANTS RELATIFS À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFIÉS PAR UNE MARQUE \triangle SUR LES SCHÉMAS DE PRINCIPE, LES VUES EXPLOSÉES ET LES LISTES DE PIÈCES

SONT D'UNE IMPORTANCE CRITIQUE POUR LA SÉCURITÉ DU FONCTIONNEMENT. NE LES REMPLACER QUE PAR DES COMPOSANTS SONY DONT LE NUMÉRO DE PIÈCE EST INDIQUÉ DANS LE PRÉSENT MANUEL OU DANS LES SUPPLÉMENTS PUBLIÉS PAR SONY.

CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

This appliance is classified as a CLASS 1 LASER product. The CLASS 1 LASER PRODUCT MARKING is located on the rear exterior.



Laser component in this product is capable of emitting radiation exceeding the limit for Class 1.

The following caution label is located inside the unit.



SAFETY CHECK-OUT

After correcting the original service problem, perform the following safety check before releasing the set to the customer: Check the antenna terminals, metal trim, “metallized” knobs, screws, and all other exposed metal parts for AC leakage. Check leakage as described below.

LEAKAGE TEST

The AC leakage from any exposed metal part to earth ground and from all exposed metal parts to any exposed metal part having a return to chassis, must not exceed 0.5 mA (500 microamperes.). Leakage current can be measured by any one of three methods.

1. A commercial leakage tester, such as the Simpson 229 or RCA WT-540A. Follow the manufacturers’ instructions to use these instruments.
2. A battery-operated AC milliammeter. The Data Precision 245 digital multimeter is suitable for this job.
3. Measuring the voltage drop across a resistor by means of a VOM or battery-operated AC voltmeter. The “limit” indication is 0.75 V, so analog meters must have an accurate low-voltage scale. The Simpson 250 and Sanwa SH-63Trd are examples of a passive VOM that is suitable. Nearly all battery operated digital multimeters that have a 2 V AC range are suitable. (See Fig. A)

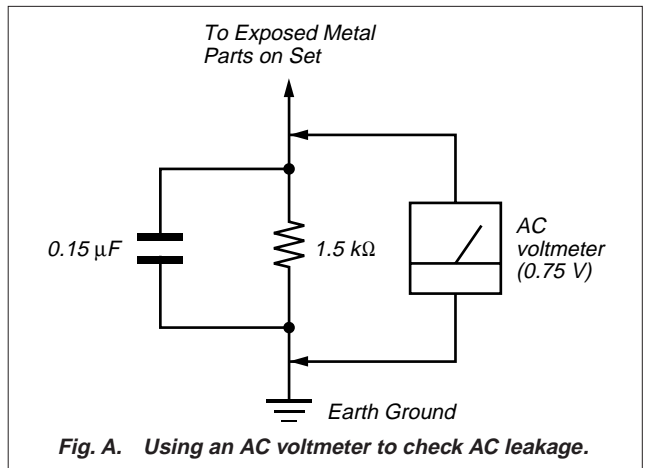
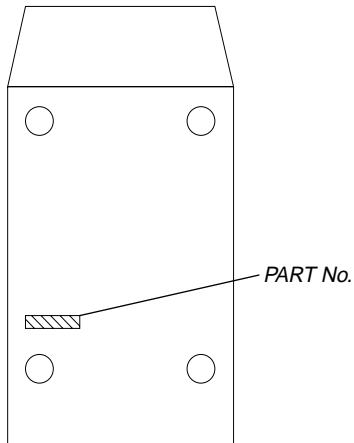


Fig. A. Using an AC voltmeter to check AC leakage.

MODEL IDENTIFICATION

— Bottom view —

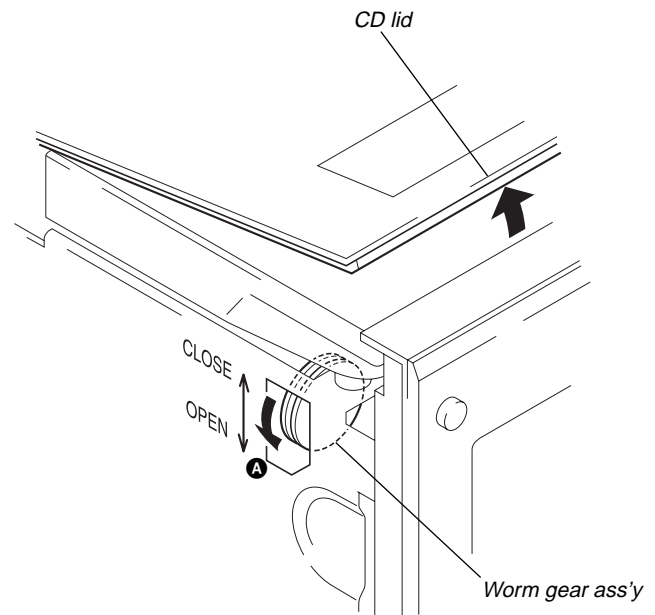


Front Panel

MODEL	PART No.
AEP and UK models	4-212-516-0□
Singapore and Hong Kong models	4-212-516-1□
US and Canadian models	4-212-516-3□

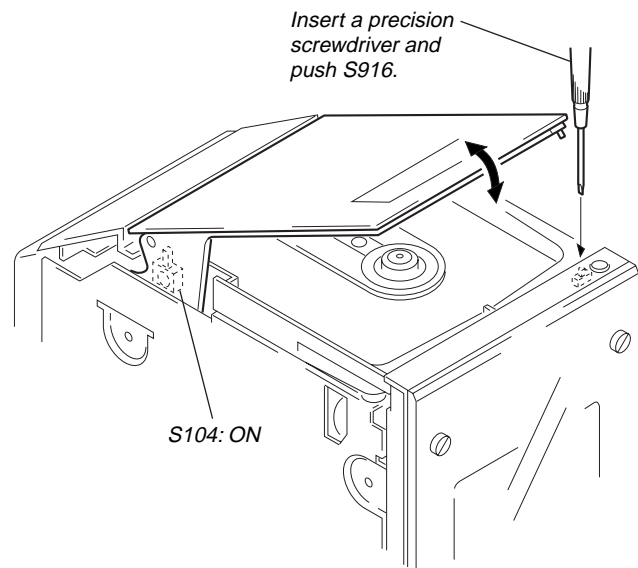
HOW TO OPEN THE CD LID

1. Remove Side panel (L), (R). (Refer to page 12)
2. Rotate the Worm gear ass'y to direction of the arrow **A**.



LASER DIODE AND FOCUS SEARCH OPERATION CHECK

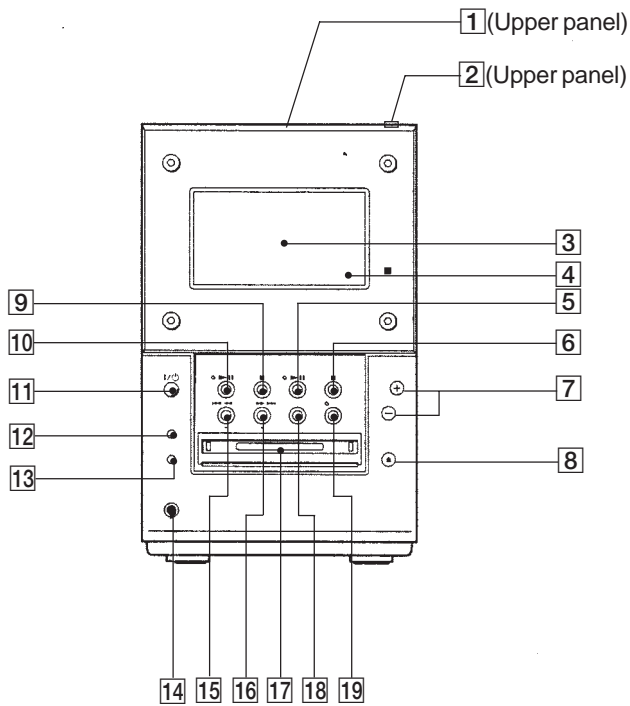
1. Open the CD lid.
2. Turn on S104 and S916 as following figure.
3. Confirm that the laser diode emission while observing the objecting lens. When there is no emission, Auto Power Control circuit or Optical Pick-up is broken. Objective lens moves up and down once for the focus search.



SECTION 2 GENERAL

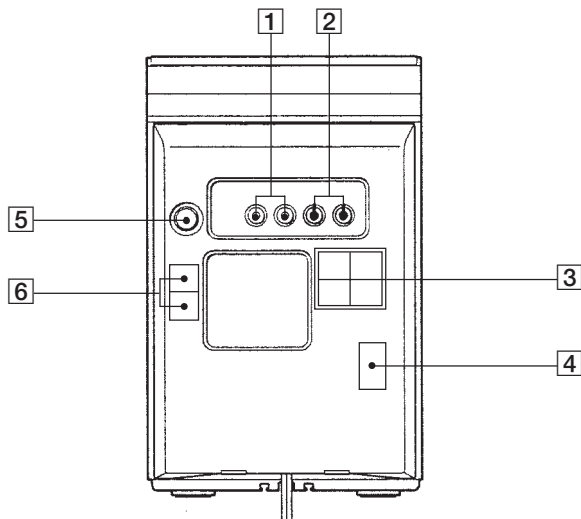
LOCATION OF CONTROLS

• Front view



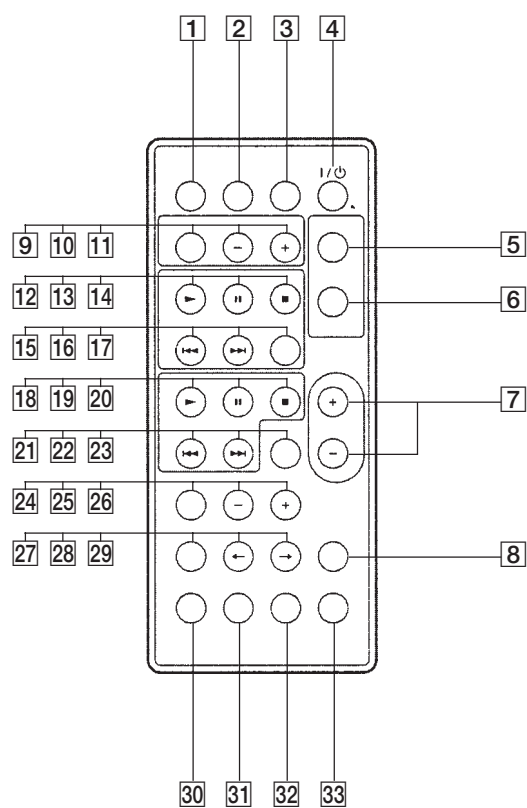
- 1 CD lid
- 2 ▲ (CD) button
- 3 Display window
- 4 Remote sensor
- 5 MD ►|| button and indicator
- 6 MD ■ button
- 7 VOLUME +/- buttons
- 8 ▲ (MD) button
- 9 CD ■ button
- 10 CD ►|| button and indicator
- 11 I/⏻ button
- 12 FUNCTION button
- 13 TUNER/BAND button
- 14 PHONES jack
- 15 ◀◀◀ button
- 16 ▶▶▶▶ button
- 17 MD disc slot
- 18 CD-MD SYNC button
- 19 REC button and indicator

• Rear view



- 1 TAPE OUT jacks
- 2 TAPE IN jacks
- 3 SPEAKER terminals
- 4 VOLTAGE SELECTOR switch
(Singapore and Hong Kong models)
- 5 FM ANTENNA terminal
- 6 AM ANTENNA terminals

• REMOTE CONTROLLER



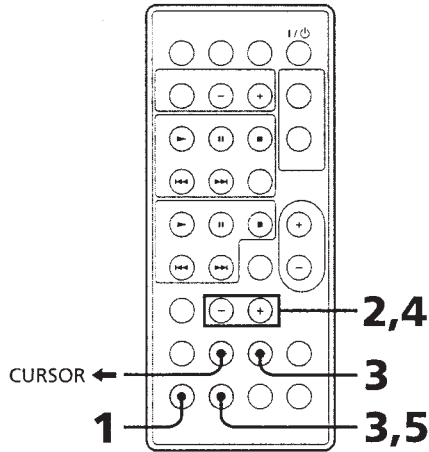
- 1** FUNCTION button
- 2** SLEEP button
- 3** CD, OPEN/CLOSE button
- 4** I/⏻ button
- 5** MODE, PLAY/TUNING button
- 6** REPEAT, STEREO/MONO button
- 7** VOL +/- buttons
- 8** DBFB button
- 9** BAND, TUNER button
- 10** -, PRESET button
- 11** +, PRESET button
- 12** MD ► button
- 13** MD ■■ button
- 14** MD ■ button
- 15** MD ◀◀ button
- 16** MD ►► button
- 17** MD SCROLL button
- 18** CD ► button
- 19** CD ■■ button
- 20** CD ■ button
- 21** CD ◀◀ button
- 22** CD ►► button
- 23** DISPLAY, CHARACTER button
- 24** EDIT button
- 25** - button
- 26** + button
- 27** SELECT, CLOCK/TIMER button
- 28** ←, CURSOR button
- 29** →, CURSOR button
- 30** SET, CLOCK/TIMER button
- 31** YES, ENTER button
- 32** NO, CANCEL button
- 33** MUSIC MENU button

Step 2: Setting the time

You must set the time before you use the timer functions.

The clock is on a 24-hour system for the European model, and a 12-hour system for other models.

The European model is used for illustration purpose.



1 Press CLOCK/TIMER SET while the power is off.
The clock appears and the hour indication flashes.

2 Press +/- to set the hour.



3 Press ENTER/YES or CURSOR →.
The minute indication flashes.



4 Press +/- to set the minute.

5 Press ENTER/YES.
The clock starts.

If you have made a mistake

Press CURSOR ← or → repeatedly so that the incorrect item flashes, then set it again.

To change the preset time

You can change the preset time while the power is on.

- 1 Press CLOCK/TIMER SET.
- 2 Press +/- repeatedly until "CLOCK SET ?" appears.
- 3 Press ENTER/YES.
- 4 Repeat steps 2 through 5.

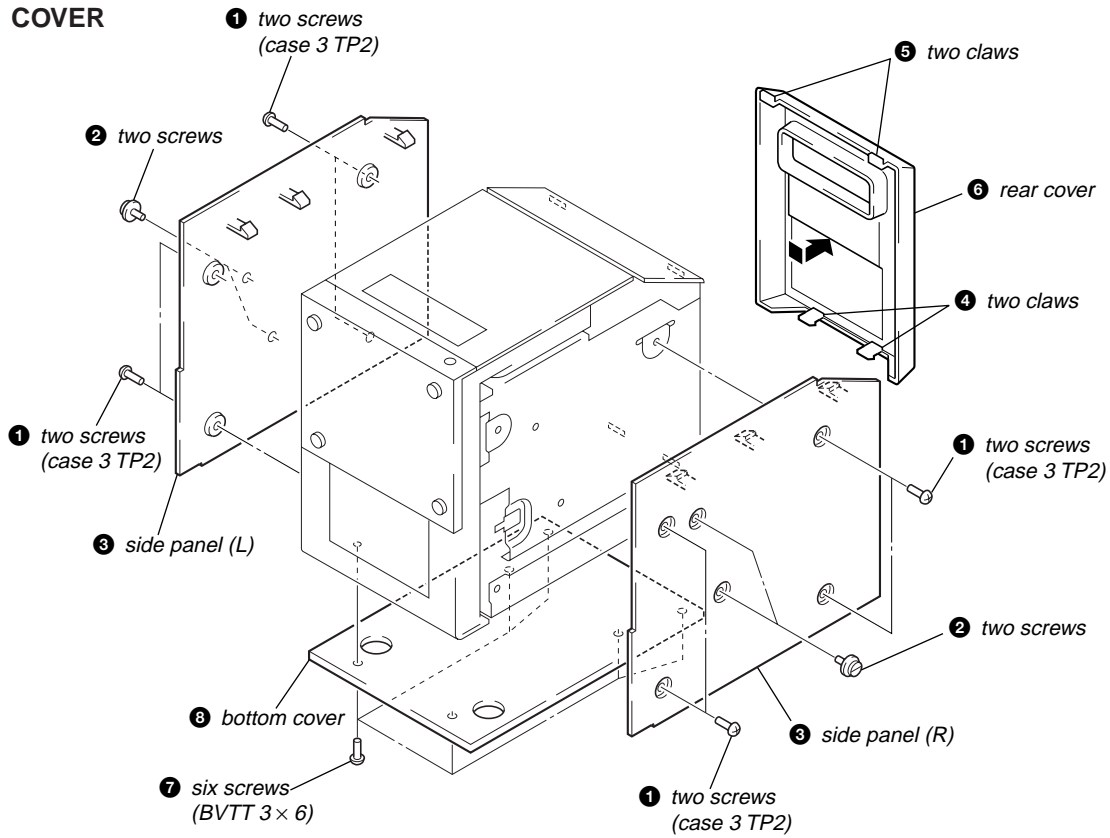
Tips

- The built-in clock shows the time in the display while the power is off.
- The upper dot flashes for the first half of a minute (0 to 29 seconds), and the lower dot flashes for the last half of a minute (30 to 59 seconds).

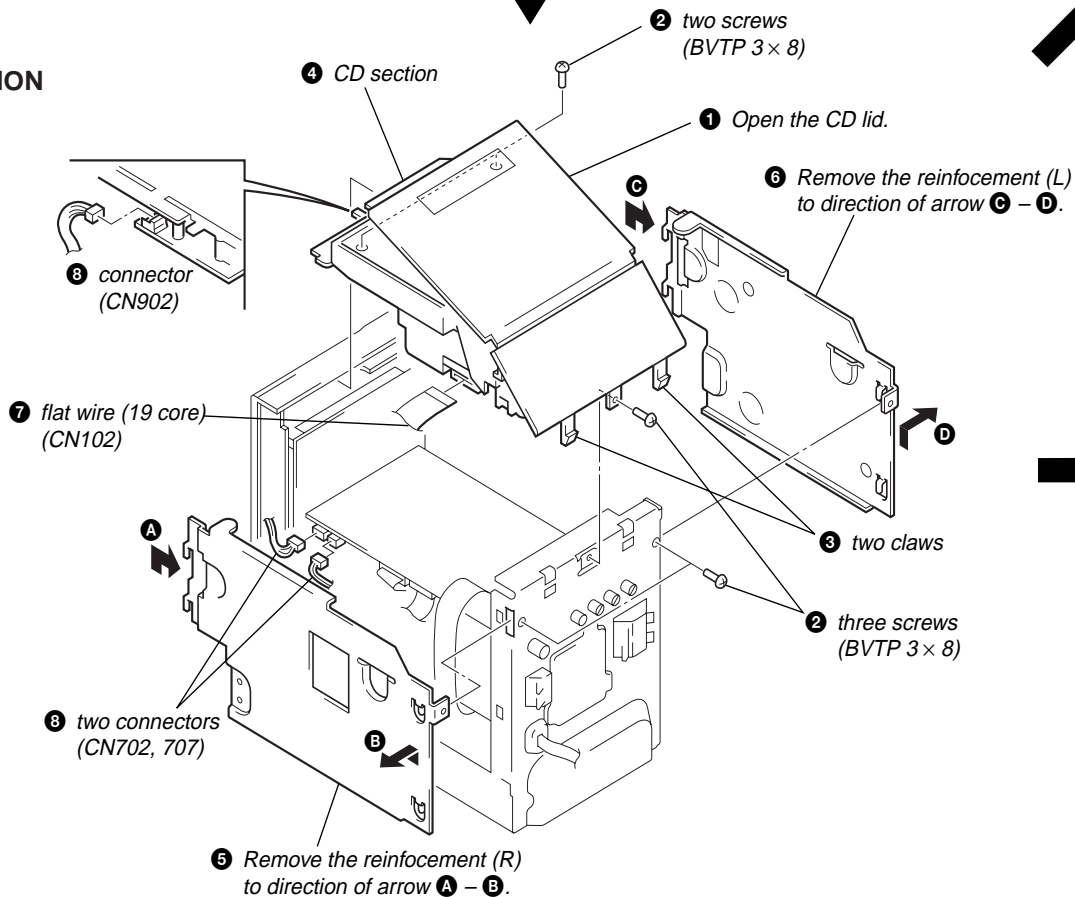
SECTION 3 DISASSEMBLY

Note: Follow the disassembly procedure in the numerical order given.

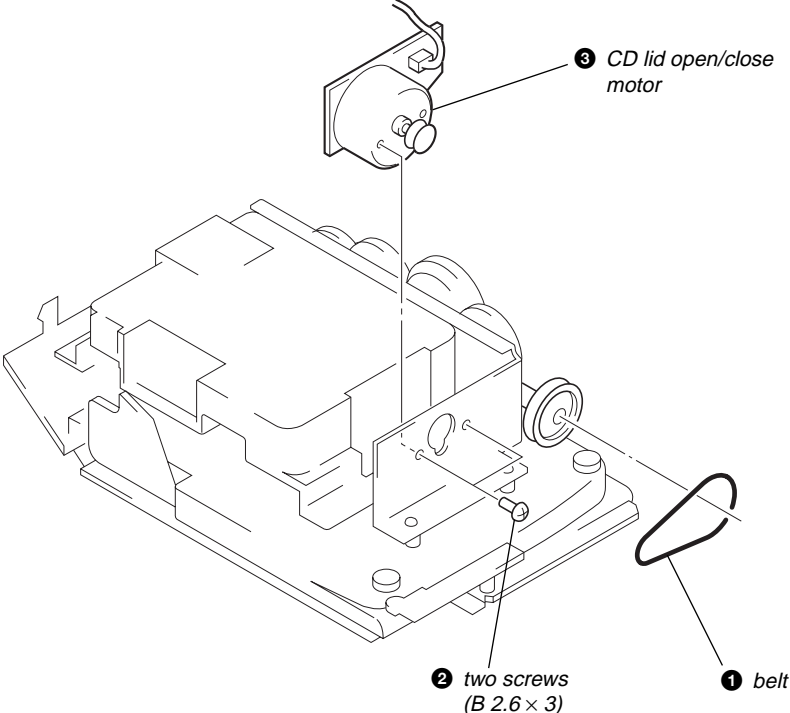
PANEL, COVER



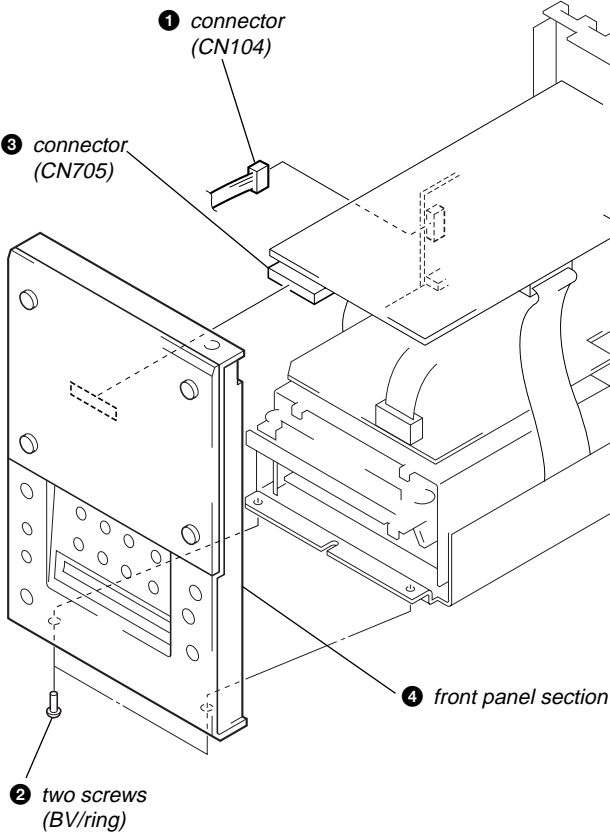
CD SECTION



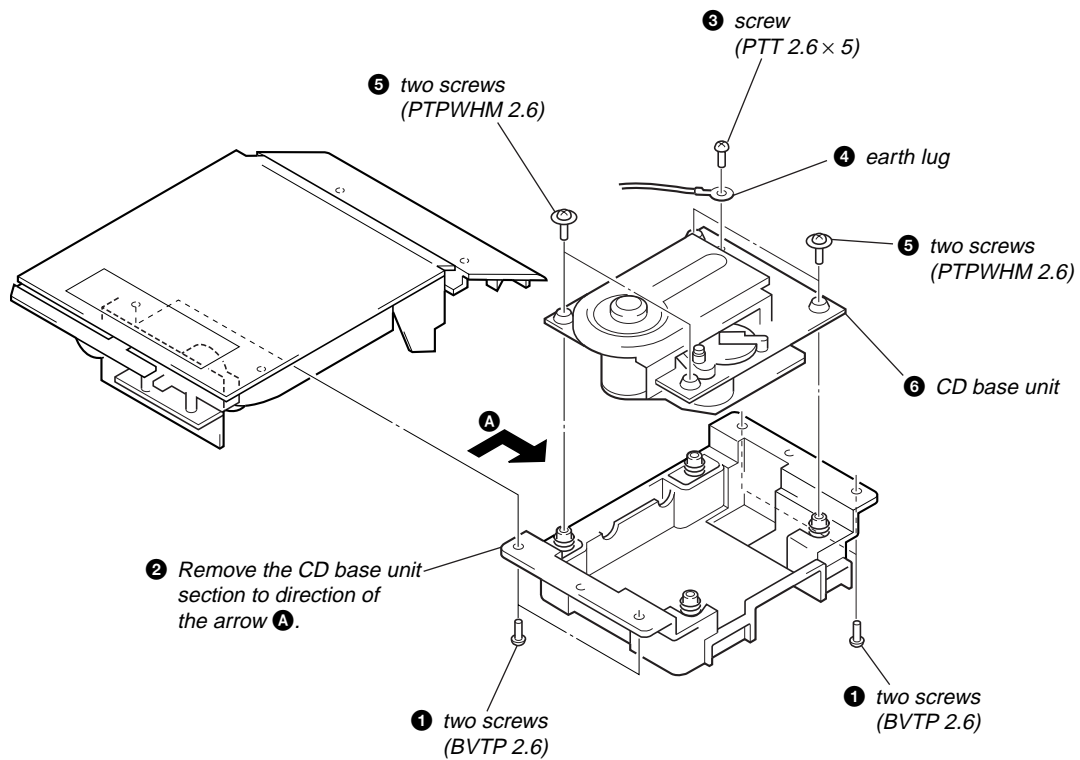
CD LID OPEN/CLOSE MOTOR



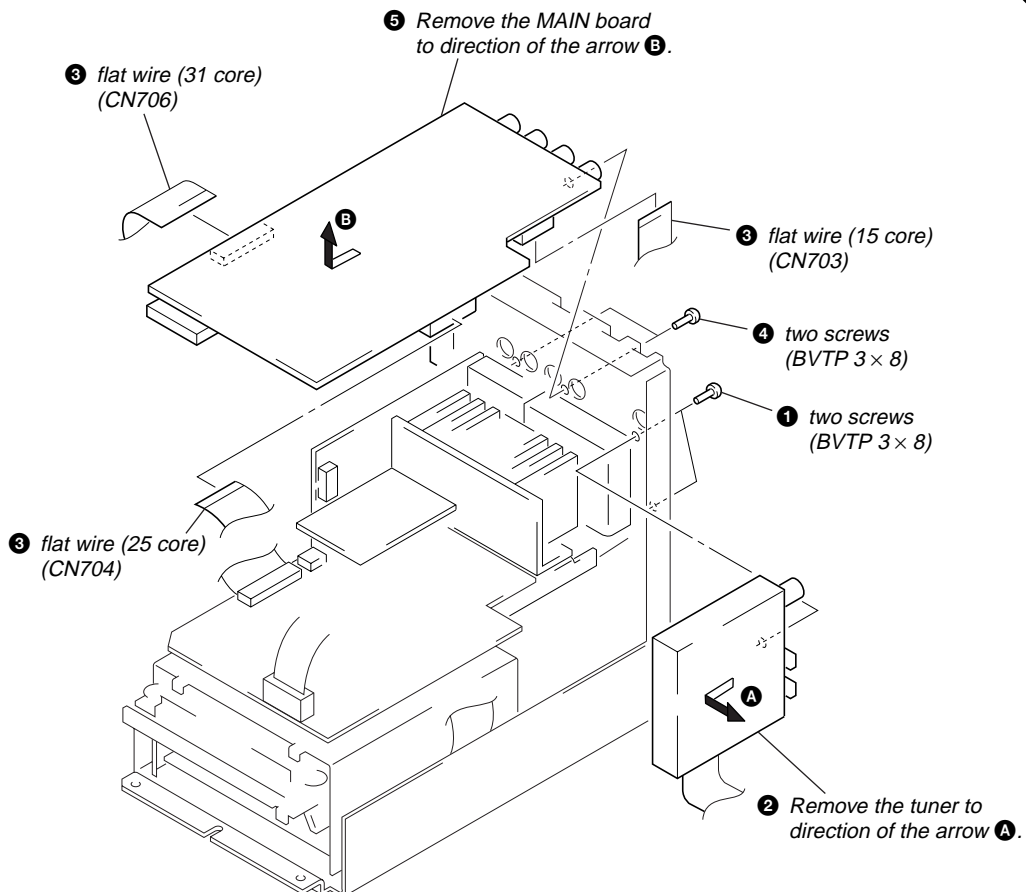
FRONT PANEL SECTION



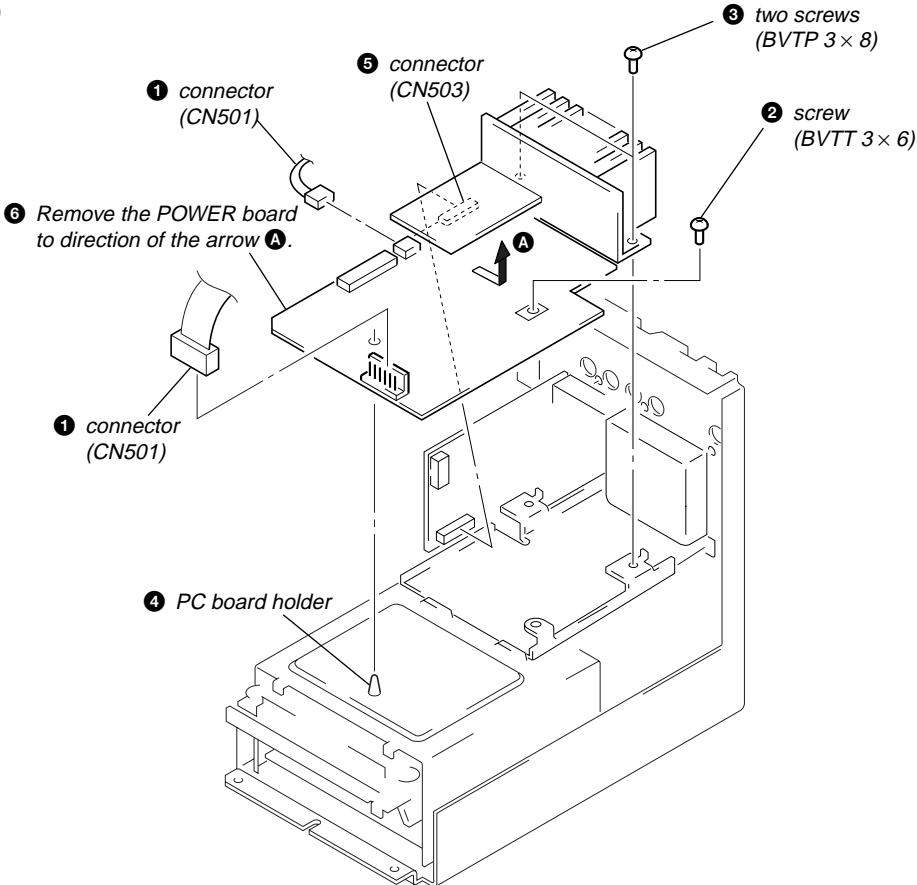
CD BASE UNIT



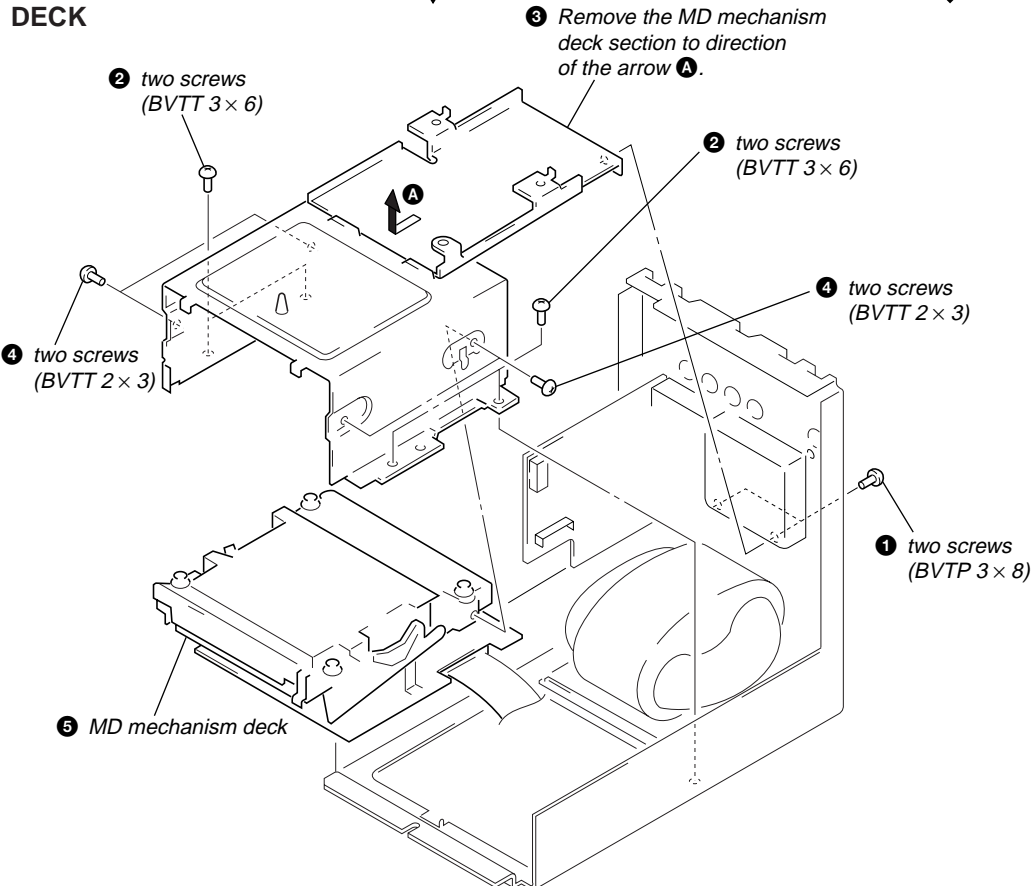
TUNER, MAIN BOARD



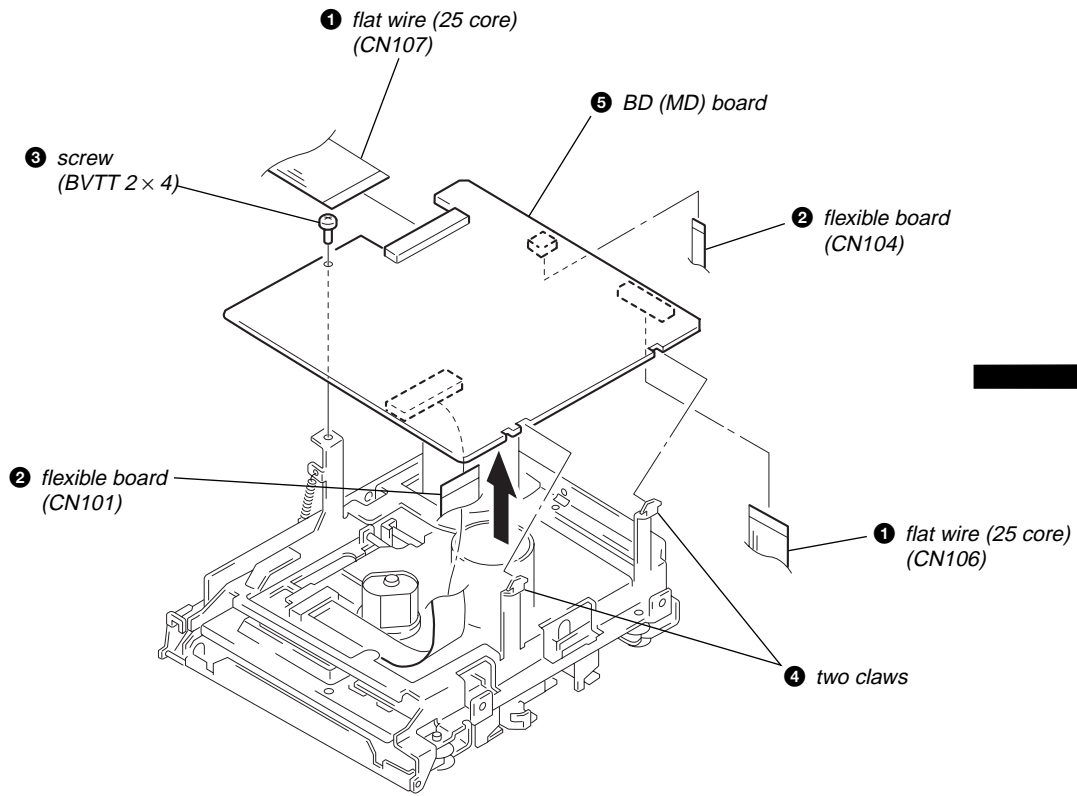
POWER BOARD



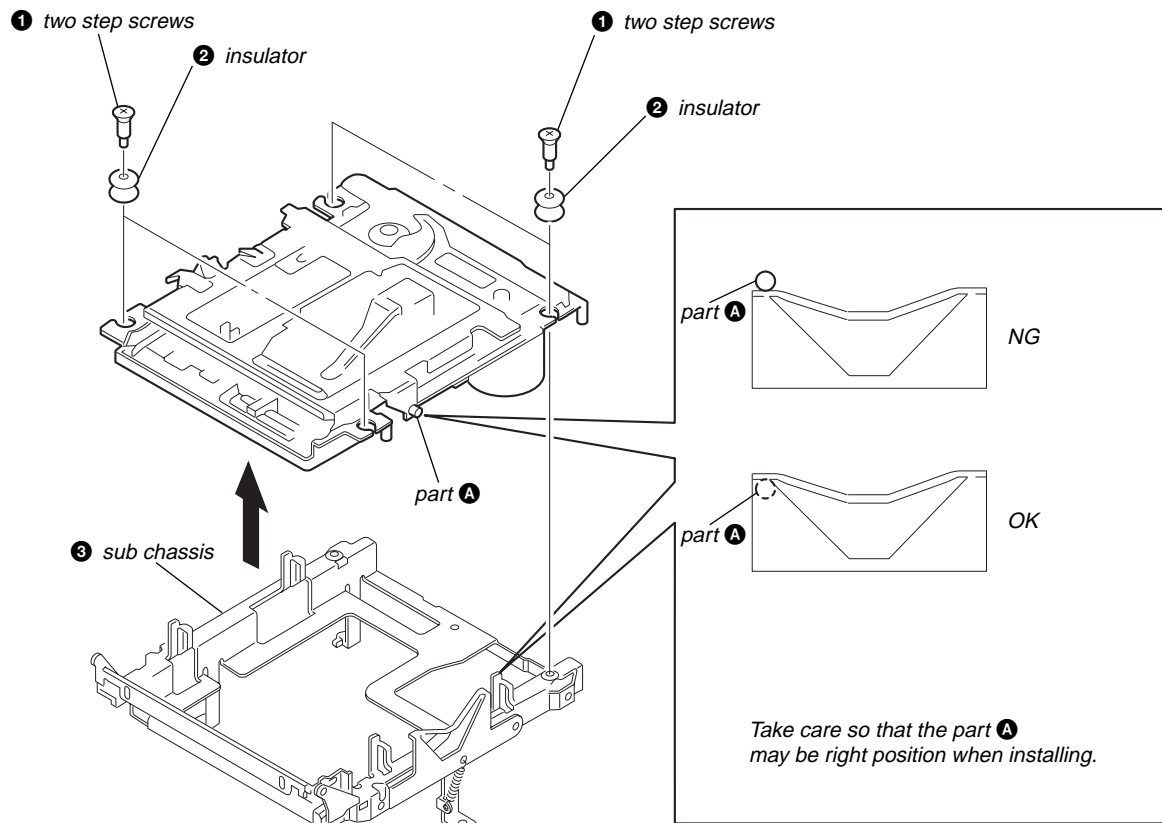
MD MECHANISM DECK



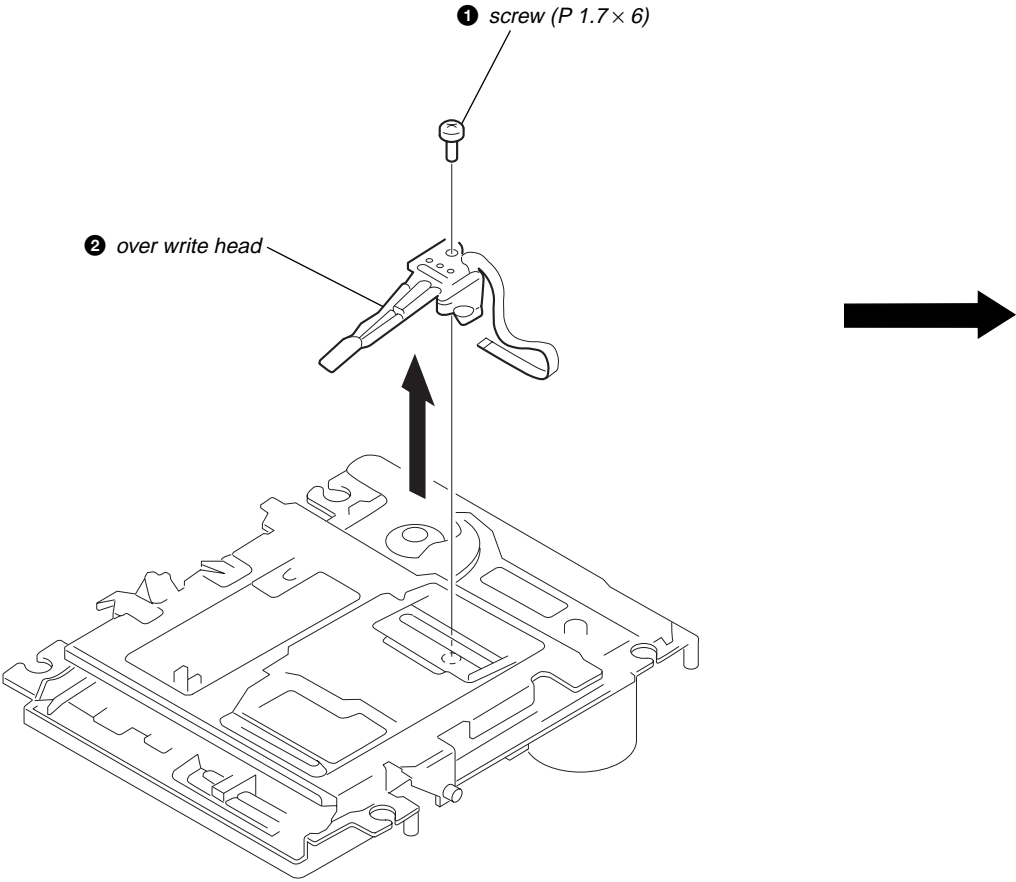
BD BOARD



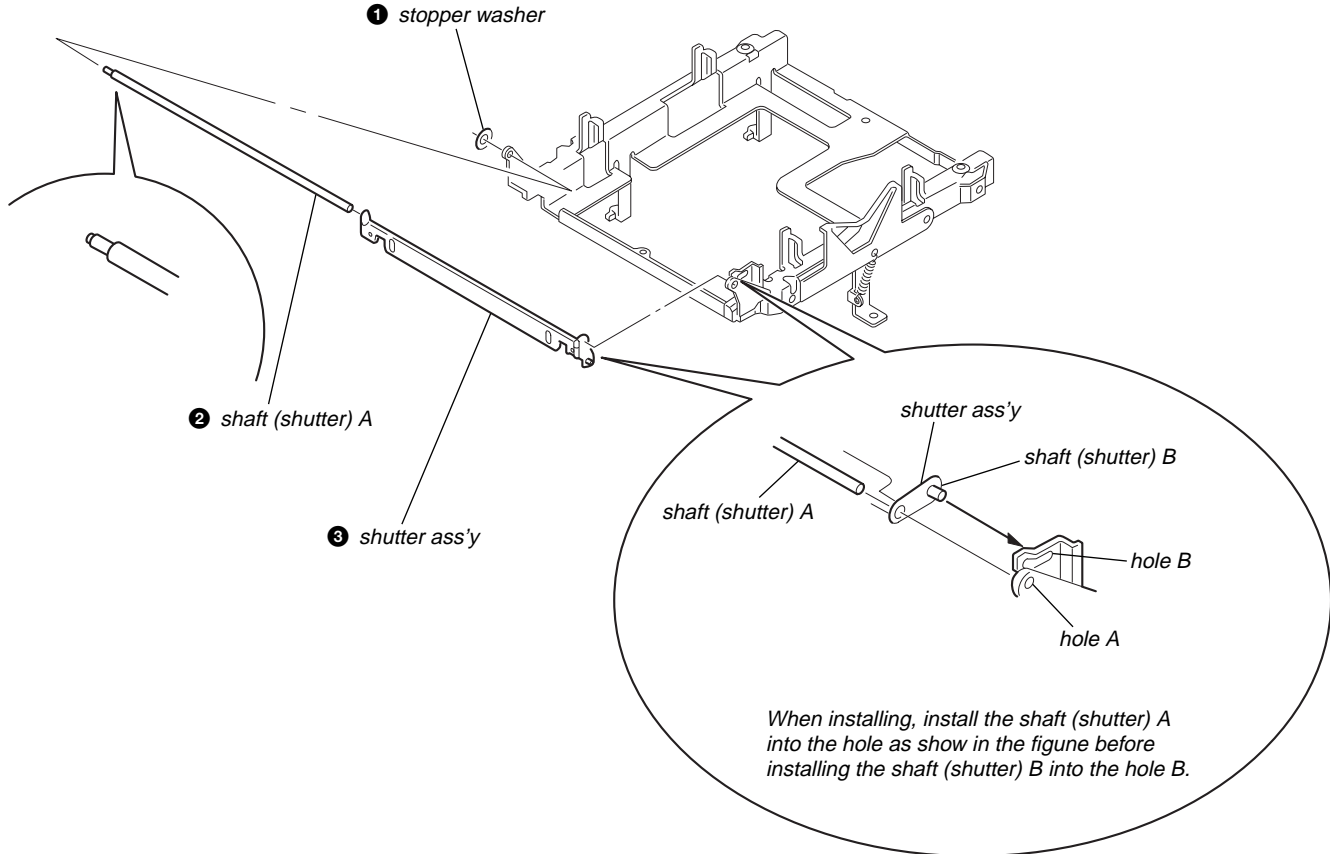
SUB CHASSIS



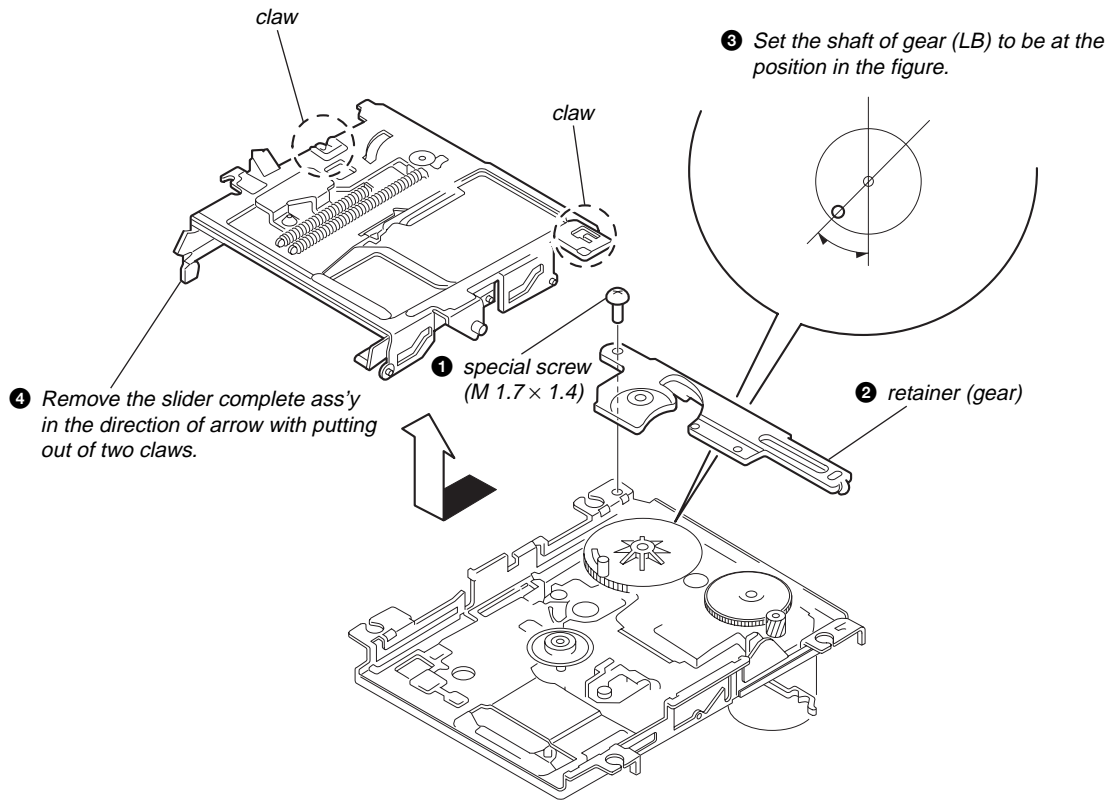
OVER WRITE HEAD



SHUTTER ASS'Y

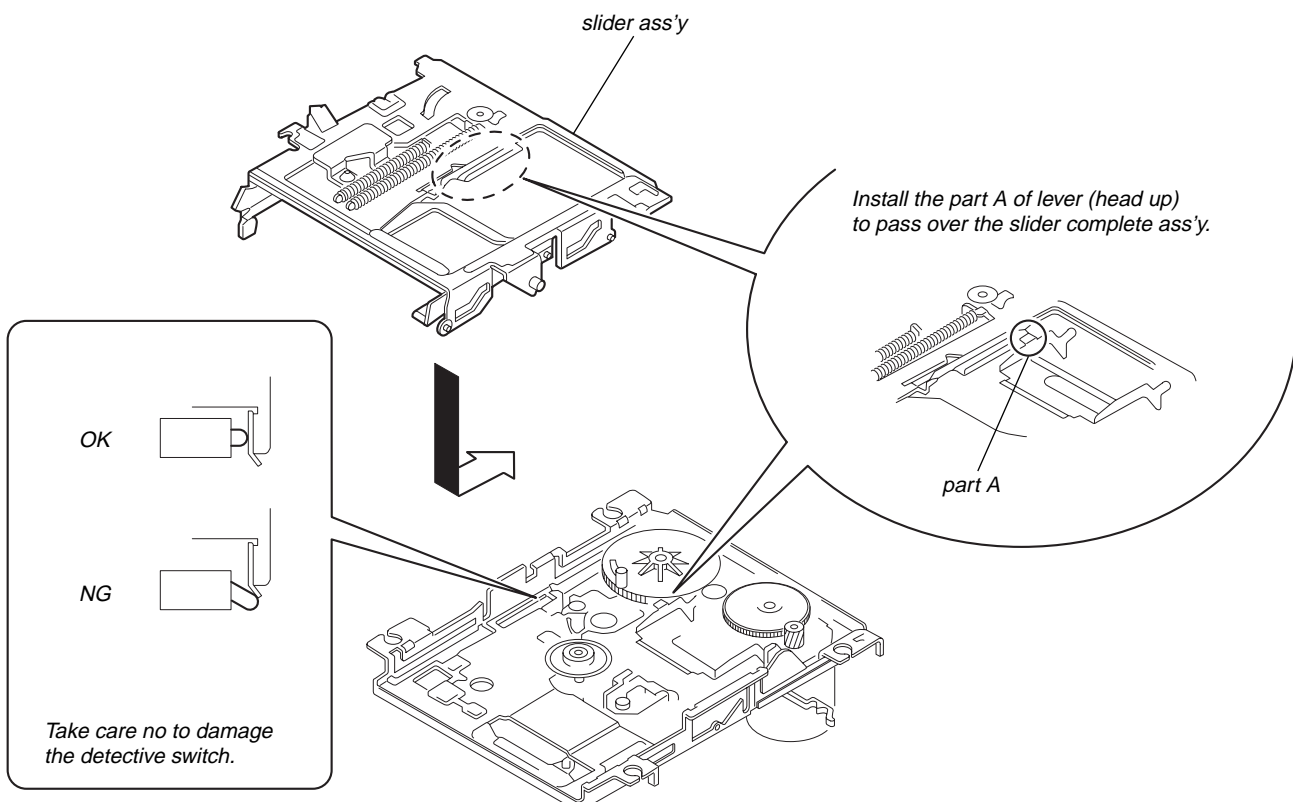


SLIDER COMPLETE ASS'Y



NOTE FOR INSTALLATION

- SLIDER COMPLETE ASS'Y



SECTION 4 SERVICE MODE

Change-over of AM (MW) Tuner Step between 9 kHz and 10 kHz

- A step of AM (MW) channels can be changed over between 9 kHz and 10 kHz.

Procedure:

1. Press **I/⏻** button to turn the set ON.
2. Select the function "TUNER", and press **TUNER/BAND** button to select the BAND "AM (MW)".
3. Press **I/⏻** button to turn the set OFF.
4. Press **FUNCTION** and **I/⏻** buttons simultaneously, and the display of fluorescent indicator tube changes to "AM (MW) 9 kHz STEP" or "AM (MW) 10 kHz STEP", and thus the channel step is changed over.

Change-over of LW Tuner Step between 1 kHz and 3 kHz

- A step of LW channels can be changed over between 1 kHz and 3 kHz.

Procedure:

1. Press **I/⏻** button to turn the set ON.
2. Select the function "TUNER", and press **TUNER/BAND** button to select the BAND "LW".
3. Press **I/⏻** button to turn the set OFF.
4. Press **FUNCTION** and **I/⏻** buttons simultaneously, and the display of fluorescent indicator tube changes to "LW 1 kHz STEP" or "LW 3 kHz STEP", and thus the channel step is changed over.

ATT Change-over of TAPE input

Procedure:

1. Press **I/⏻** button to turn the set ON.
2. Select the function "TAPE".
3. Press **I/⏻** button to turn the set OFF.
4. Press **I/⏻** button while pressing **FUNCTION** button. The power is turned on and the display of fluorescent indicator tube changes to "Attenuator ON" or "Attenuator OFF", then ATT change-over of TAPE input is completed.

CD tracking balance display

Procedure:

1. Press **I/⏻** button to turn the set ON.
2. Select the function "CD".
3. Press **TUNER/BAND** button while pressing **■ (CD)** button.
4. The display of fluorescent indicator tube shows you the following message.
CD TR. BAL. □□

LED and Fluorescent Indicator Tube All Lit, Key Check Mode

Procedure:

1. Press two buttons **VOLUME-** and **TUNER/BAND** simultaneously.
2. LEDs and fluorescent indicator tube are all turned on.
3. When the **FUNCTION** button is pressed, the fluorescent indicator tube lights up in the order of; partial lighting 1 → partial lighting 2 → all lit → partial lighting 1 →.
When the **VOLUME+/-** button is pressed, the LED lighting pattern changes.
To end without switching to the key check mode, press the **I/⏻** button to turn off the power.
4. Press **■ (CD)** button, and the key check mode is activated.
5. In the key check mode, the fluorescent indicator tube displays "KEY=0 JOG=0". Each time a button is pressed, "KEY=" value increases. However, once a button is pressed, it is no longer taken into account.
"JOG=" Value increases like 1, 2, 3 ... if press **VOLUME+** button, or it decreases like 99, 98, 97 ... if press **VOLUME-** button.
6. To exit from this mode, press order all buttons (13 buttons), and press any button, or disconnect the power cord.

SUB CLOCK CHECK

Procedure:

1. Connect an oscilloscope to IC707 pin ⑨ and ground of the MAIN board.
2. Press two buttons **VOLUME-** and **REC** simultaneously, and the fluorescent indicator tube displays "32.768 kHz (91)".
3. To check the signal on oscilloscope becomes 32 kHz square wave.
4. Press **I/⏻** button to exit.

SECTION 5 TEST MODE

5-1. PRECAUTIONS FOR USE OF TEST MODE


Recording Laser Emission Mode

- Continuous recording mode (CREC MODE)
- Traverse adjustment mode (EFBAL ADJUST)
- Laser power adjustment mode (LDPWR ADJUST)
- Laser power check mode (LDPWR CHECK)
- Traverse (MO) check (EF MO CHECK)
- Traverse (MO) adjustment (EF MO ADJUST)




5-2. SETTING THE TEST MODE



With the power off, press the  button while pressing the  button.

5-3. EXITING THE TEST MODE

Press the  button while pressing the  button. The STANDBY state will be set and the test mode will be cleared.

5-4. BASIC OPERATIONS OF THE TEST MODE

All operations are performed using the  button,  button, and  button. The functions of these buttons are as follows.

Function name	Function
VOLUME +/- button	Changes parameters and modes
 (CD) button	Proceeds onto the next step. Finalizes input.
 (CD) button	Returns to previous step. Stops operations.

5-5. SELECTING THE TEST MODE

There are altogether 26 test modes, shown in the following table. Press the **[VOLUME+]** button to the mode below the current mode in the table while press the **[VOLUME-]** button to the mode above. Each time the **[▶|| (CD)]** button is pressed, the display changes in the following order;

“TEMP CHECK” → “TEMP ADJUST” → “SLED MOVE” → “CPLAY 2 MODE” → “TEMP CHECK”...

Display	Contents	Mark
TEMP CHECK	Temperature compensation offset check	
LDPWR CHECK	Laser power check	
EF MO CHECK	Traverse (MO) check	
EF CD CHECK	Traverse (CD) check	
FBIAS CHECK	Focus bias check	
CPLAY MODE	Continuous playback mode	
CREC MODE	Continuous recording mode	
Scurve CHECK	S curve check	(X)
VERIFY MODE	Non-volatile memory check	(X)
DETRK CHECK	Detrack check	(X)
TEMP ADJUST	Temperature compensation offset adjustment	
LDPWR ADJUST	Laser power adjustment	
EF MO ADJUST	Traverse (MO) adjustment	
EF CD ADJUST	Traverse (CD) adjustment	
FBIAS ADJUST	Focus bias adjustment	
EEP MODE	Nonvolatile memory control	(X) (!)
MANUAL CMD	Command transfer	(X)
SVDATA READ	Status display	(X)
ERR DP MODE	Error history display, clear	
SLED MOVE	Sled check	(X)
ACCESS MODE	Access check	(X)
0920 CHECK	Outermost circumference check	(X)
WRITE sure?	Non-volatile memory Initialize	(X) (!)
HEAD ADJUST	Head position check	(X)
CPLAY2 MODE	Continuous playback mode	(X)
CREC2 MODE	Continuous recording mode	(X)

- For details of each adjustment mode, refer to the items in “6. Electrical Adjustments”. For details of “ERR DP MODE”, refer to the self-diagnosis function on page 2.
- If other modes are set accidentally, press the **[▶|| (CD)]** button to exit that mode.
- As items marked (X) in the “Mark” column are not used during servicing, they are not described here. If these modes are set accidentally, press the **[▶|| (CD)]** button to exit the mode. Be especially careful with items marked (!) as they will overwrite the non-volatile memory, and as a result, the unit will not operate normally.

5-5-1. Operating the Continuous Playback Mode

1. Entering the continuous playback mode

- ① Set the disc in the unit. (Recordable discs or discs for playback only.)
- ② Press the **[VOLUME+/-]** button and display “CPLAY MODE”.
- ③ Press the **[▶|| (CD)]** button to change the display to “CPLAY MID”.
- ④ When access completes, the display changes to “C = [] AD = []”.

Note: The numbers “[]” displayed indicate the error rates and “ADER”.

2. Changing the part to be played back

- ① When the **[▶|| (CD)]** button is pressed during continuous playback, the display changes as below, and the played back part can be changed.

“CPLAY MID” → “CPLAY OUT” → “CPLAY IN”

- ② When access completes, the display changes to “C = [] AD = []”.

Note: The numbers “[]” displayed indicate the error rate and “ADER”.

3. Ending the continuous playback mode

- ① Press the **▶|| (CD)** button. The display changes to “CPLAY MODE”.
- ② Press the **▲ (MD)** button to remove the disc.

Note: The playback start addresses for IN, MID, and OUT are as follows. To display the playback position address on the display, press the **I/⏻** button to display “CPLAY (#####)”.

IN: 40h cluster
 MID: 300h cluster
 OUT: 700h cluster

5-5-2. Operating the Continuous Recording Mode

1. Entering the continuous recording mode

- ① Set a recordable disc in the unit. (Refer to Note 3.)
- ② Press the **VOLUME+/-** button and display “CREC MODE”.
- ③ Press the **■ (CD)** button to change the display to “CREC MID”.
- ④ When access completes, the display changes to “CREC (#####)” and the **REC** display lights up.

Note: The numbers “#” displayed indicate the recording position address.

2. Changing the part to be recorded

- ① When the **■ (CD)** button is pressed during continuous recording, the display changes as below and the recorded part can be changed. The **REC** display is off while changing.



- ② When access completes, the display changes to “CREC (#####)” and the **REC** display lights up.

Note: The numbers “#” displayed indicate the recording position address.

3. Ending the continuous recording mode

- ① Press the **▶|| (CD)** button. The display changes to “CREC MODE”, and the **REC** goes off.
- ② Press the **▲ (MD)** button to remove the disc.

Note 1: The recording start addresses for IN, MID, and OUT are as follows.

IN: 40h cluster
 MID: 300h cluster
 OUT: 700h cluster

Note 2: The **▶|| (CD)** button can be used to stop recording anytime.

Note 3: Do not perform continuous recording for long periods of time above 5 minutes.

Note 4: During continuous recording, be careful not to apply vibration.

5-5-3. Non-Volatile Memory Mode (EEP MODE)


This mode reads and writes the contents of the non-volatile memory.

It is not used in servicing. If set accidentally, press the **▶|| (CD)** button immediately to exit it.

5-6. FUNCTIONS OF OTHER BUTTONS

Function	Contents
▶ (MD)	Sets continuous playback when pressed in the STOP state. Turns ON/OFF the tracking servo when pressed during continuous playback.
■ (MD)	Stops the continuous playback and recording.
▶▶▶▶	Moves the sled to the external circumference only while the button is pressed.
◀◀◀◀	Moves the sled to the internal circumference only while the button is pressed.
CD-MD SYNC	Switches between pit and groove when pressed.
I/⏻	Switches the displayed contents when pressed.
▲ (MD)	Ejects the disc.

5-7. DISPLAYS DURING TEST MODE

The display changes according to the following sequence each time the  button is pressed.

1. Mode display

“TEMP ADJUST” and “CPLAYMODE” are displayed.

2. Error rate display

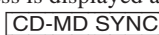
The error rate is displayed as follows.

C = □□□□ AD = □□

C = :Indicates the C1 error.

AD = :Indicates ADER.

3. Address display

The address is displayed as follows. (MO: Recordable disc, CD: Disc for palyback only)
When the  button is pressed, the display will switch between groove and pit.

h = □□□□ s = □□□□ (MO pit and CD)

h = □□□□ a = □□□□ (MO groove)

h = Indicates the header address.

s = Indicates the SUBQ address.

a = Indicates the ADIP address.

Note: Displayed as “-” when servo is operated.

4. Auto gain display (Not used in servicing)

The auto gain is displayed as follows.

AG = □□ / □□ [□□]

5. Detrack check display (Not used in servicing)

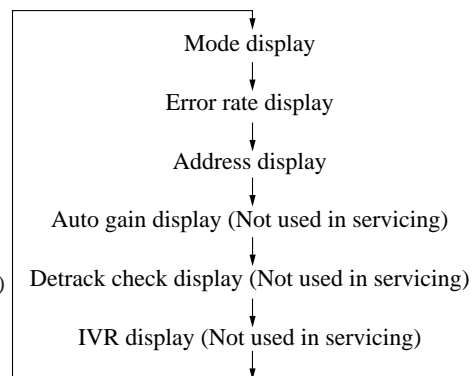
The detrack is displayed as follows.

ADR = □□□□□□

6. IVR display (Not used in servicing)

IVR is displayed as follows.

[□□][□□][□□]



Meanings of other displays

Display	Contents	
	When Lit	When Off
REC	Recording mode ON	Recording mode OFF
ATT	ABCD adjustment completed	
SHUFFLE	Focus auto gain OK	
TRACK	Pit	Groove
DISC	High reflection rate	Low reflection
LEVEL-SYNC	CLV-S	CLV-A
SYNC	CLV LOCK	CLV UNLOCK

5-8. AGING MODE

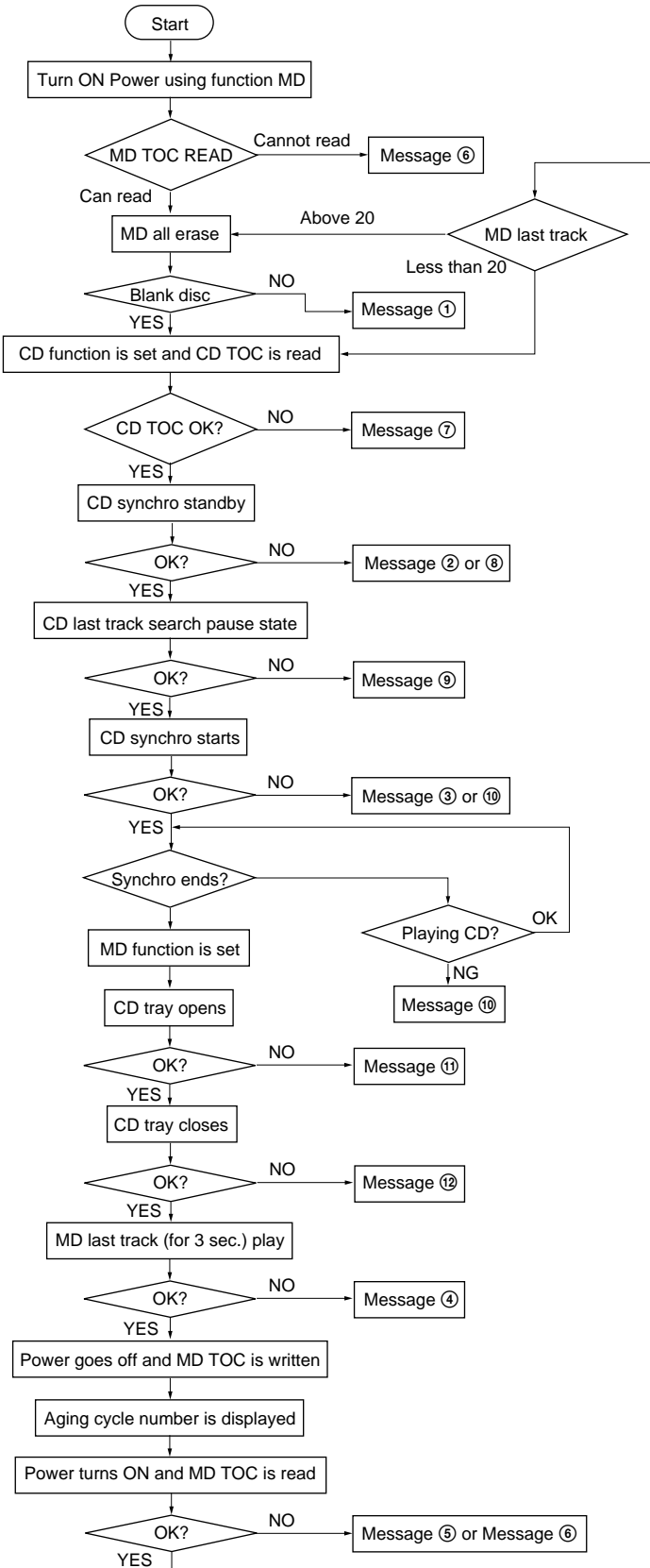
This unit is provided with an aging mode.

In this mode, MD and CD operations are performed alternately according to the following sequence.

Aging will be carried out continuously unless an error occurs.

If an error occurs, the status and number of cycles are displayed alternately, and operations stop. (Refer to Table 1.)

Aging Mode Sequence



Procedure:

1. Load a recordable disc (MD) and CD test disc (YEDS-18). (*Note 1)
2. While pressing the [VOLUME-] button, press the [▶▶▶▶▶] button.
3. Aging is executed in the above sequence.
4. To end, press the [■ (CD or MD)] button.

*Note 1: Any CD can be used, but one with a short last track is recommended. The time of one aging cycle will be longer if the last track is long. Also use a CD in which the length of the last track x 20 does not exceed the recording time of the recording MD.

Table 1. Messages and Main Causes When Aging Stops

No.	Error Messages	Details of Error	Main Causes
①	MD A Erase NG	Cannot MD all erase.	A disc for playback only was used. The rec-proof tab is set to protect. Disc error, etc.
②	MD R-Pause NG	Cannot set MD Rec Pause.	Disc is full, etc.
③	MD D-input NG	Cannot lock MD digital in.	
④	MD Play NG	Cannot play last track.	Access error, etc.
⑤	MD TOC NG	MD TOC are different.	No. of total tracks does not match logic value.
⑥	MD No Disc NG	Cannot read MD TOC.	Disc error, etc.
⑦	CD No Disc NG	Cannot read CD TOC.	Optical defect, spindle defect (including motor), cannot read Q data, disc defect (scratches, etc.), bad focus, bad GFS, etc.
⑧	CD Pause NG	Cannot set CD pause in CD synchro mode.	Disc defect (scratches, etc.), cannot read Q data, etc.
⑨	CD Search NG	Cannot search last track on CD.	Optical defect, sled, tracking defect (including motor), cannot read Q data, disc defect (scratches, etc.).
⑩	CD Play NG	Cannot play last track on CD.	Optical defect, cannot read Q data, disc defect (scratches, etc.), etc.
⑪	CD Open NG	Cannot open CD tray.	LOAD OUT SW defect
⑫	CD Close NG	Cannot close CD tray.	LOAD IN SW defect

SECTION 6 ELECTRICAL ADJUSTMENTS

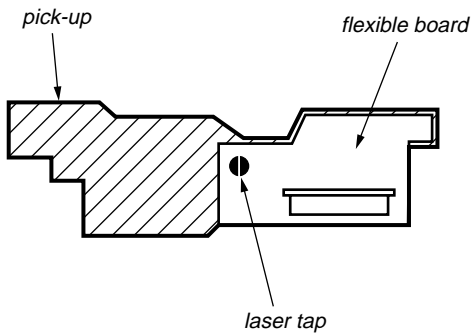
MD SECTION

6-1. PRECAUTIONS FOR CHECKING LASER DIODE EMISSION

When checking the emission of the laser diode during adjustments, never view directly from the top as this may cause blindness.

6-2. PRECAUTIONS FOR USE OF OPTICAL PICK-UP (KMS-260A)

As the laser diode in the optical pick-up is easily damaged by static electricity, solder the laser tap of the flexible board when using it. Before disconnecting the connector, solder first. Before connecting the connector, be careful not to remove the solder. Also take adequate measures to prevent damage by static electricity. Handle the flexible board with care as it breaks easily.



Optical pick-up flexible board

6-3. PRECAUTIONS FOR ADJUSTMENTS

1) When replacing the following parts, perform adjustments and checks marked ○ in the order shown in the following table.

	Optical Pick-up	BD (MD) Board		
		IC171	D101	IC101, IC121, IC192
1. Temperature compensation offset adjustment	×	○	○	○
2. Laser power adjustment	○	○	×	○
3. Traverse adjustment	○	○	×	○
4. Focus bias adjustment	○	○	×	○
5. Error rate check	○	○	×	○

- 2) Perform the adjustment in the test mode.
After completing the adjustments, exit the test mode.
- 3) Perform the adjustments in the order shown.
- 4) Use the following tools and measuring devices.
 - Check disc (MD) TDYS-1 (Parts No. 4-963-646-01)
 - Laser power meter LPM-8001 (Parts No. J-2501-046-A) or MD Laser power meter 8010S (Parts No. J-2501-145-A)
 - Oscilloscope (Measure after calibration of the probe).
 - Digital voltmeter
 - Thermometer
- 5) When observing several signals on the oscilloscope, etc., make sure that VC and ground do not connect inside the oscilloscope. (The VC and ground will short-circuit.)

Note: When performing laser power checks and adjustment (electrical adjustment), use of the new MD laser power meter 8010S (J-2501-145-A) instead of the conventional laser power meter is convenient. It sharply reduces the time and trouble to set the laser power meter sensor onto the objective lens of the pick-up.

6-4. CREATING THE CONTINUOUSLY RECORDED DISC

- The disc is used for the focus bias adjustment and error rate check. The following describes how to create a continuously recorded disc.
 1. Insert a disc (blank disc) commercially available.
 2. Press the **VOLUME+/-** button to display “CREC MODE”.
 3. Press the **■ (CD)** button to display “CREC MID”. “CREC (0300)” will be momentarily displayed and recording started.
 4. Complete recording within 5 minutes.
 5. Press the **▶|| (CD)** button and stop recording.
 6. Press the **▲ (MD)** button and remove the disc.

Create the continuous recorded disc for adjusting the focus bias and checking the error rate as described above.

Note:

- Be careful not to apply vibrations during continuous recording.

6-5. TEMPERATURE COMPENSATION OFFSET ADJUSTMENT

Save the current temperature data in the non-volatile memory as the 25 °C standard data.

Notes:

1. Normally, this adjustment should not be performed.
2. Set the surrounding temperature to 22 to 28 °C when performing this adjustment.
Also perform this adjustment immediately after the power is turned on when the internal temperature of the unit is the same as the surrounding temperature (22 to 28 °C).
3. After replacing D101, perform this adjustment after the temperature of parts reach the surrounding temperature.

Adjusting Procedure:

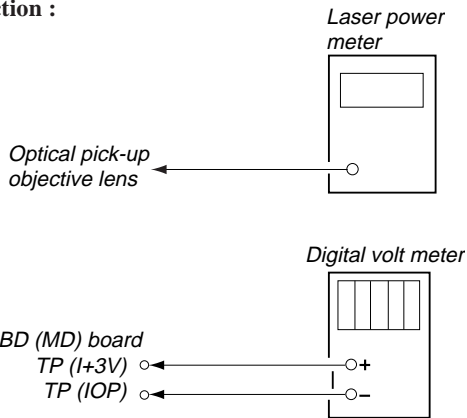
1. Press the **VOLUME+/-** button, to display “TEMP ADJUST”.
2. Press the **■ (CD)** button and select the “TEMP ADJUST” mode.
3. “TEMP= [] ” and the current temperature data are displayed.
4. To save the data: Press the **■ (CD)** button.
If not saving the data: Press the **▶|| (CD)** button.
5. When the **■ (CD)** button is pressed, “TEMP= [] SAVE” is displayed, and then “TEMP ADJUST” is displayed again. “TEMP ADJUST” is displayed again immediately after the **▶|| (CD)** button is pressed.

Specifications:

TEMP= [] should be E0 to EF. F0 to FF, 00 to 0F, 10 to 1F and 20 to 2F.

6-6. LASER POWER ADJUSTMENT

Connection :



Adjusting Procedure:

1. Set the laser power meter on the objective lens of the optical pick-up from the disc slot. (If it cannot be set properly, press the **◀◀◀◀** or **▶▶▶▶** button to move the optical pick-up.) Connect the digital voltmeter to TP (I+3V) and TP (IOP) of the BD (MD) board.
2. Press the **VOLUME+/-** button to display "LDPWR ADJUST". (Laser power: For adjustment)
3. Press the **■ (CD)** button once to display "LD 0.9 mW \$ $\square\square\square$ ".
4. Press the **VOLUME+/-** button so that the laser power meter reads 0.86 to 0.92 mW. Set the range knob of the laser power meter to 10 mW, press the **■ (CD)** button, and save the adjustment results in the non-volatile memory. ("LD SAVE \$ $\square\square\square$ " is displayed momentarily.)
5. "LD 7.0 mW \$ $\square\square\square$ " is next displayed.
6. Press the **VOLUME+/-** button so that the laser power meter reads 6.9 to 7.1 mW, press the **■ (CD)** button, and save the adjustment results in the non-volatile memory. ("LD SAVE \$ $\square\square\square$ " is displayed momentarily.)

Note: Do not emit 7.0 mW continuously for more than 15 seconds.

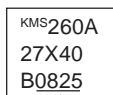
7. Press the **VOLUME+/-** button to display "LDPWR CHECK".
8. Press the **■ (CD)** button once to display "LD 0.9 mW \$ $\square\square\square$ ". Check that the laser power meter reading is 0.85 to 0.91 mW.
9. Press the **■ (CD)** button another time to display "LD 7.0 mW \$ $\square\square\square$ ".
Check that the readings of the laser power meter and digital voltmeter become the specified value.

Specified Value :

Laser power meter reading : 7.0 ± 0.1 mW

Digital voltmeter reading : Value displayed on optical pick-up label $\pm 10\%$

(Optical pick-up label)

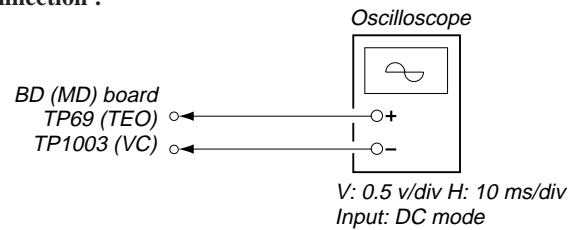


$I_{op} = 82.5$ mA in this case
 $I_{op} \text{ (mA)} = \text{Digital voltmeter reading (mV)} / 1 \text{ } (\Omega)$

10. Press the **▶▶ (CD)** button to display "LDPWR CHECK" and stop the laser emission.
(The **▶▶ (CD)** button is effective at all times to stop the laser emission.)

6-7. TRAVERSE ADJUSTMENT

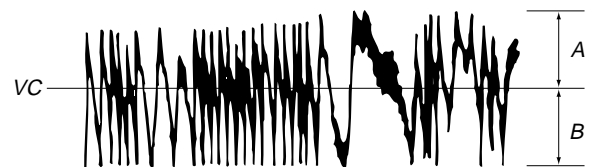
Connection :



Adjusting Procedure:

1. Connect an oscilloscope to TP69 (TEO) and TP1003 (VC) of the BD (MD) board.
2. Load a recordable disc (any available on the market). (Refer to Note 1.)
3. Press the **◀◀◀◀** or **▶▶▶▶** button to move the optical pick-up outside the pit.
4. Press the **VOLUME+/-** button to display "EFBAL ADJUST".
5. Press the **■ (CD)** button to display "EFB = $\square\square\square$ MO-R". (Laser power READ power/Focus servo ON/tracking servo OFF/spindle (S) servo ON)
6. Press the **VOLUME+/-** button so that the oscilloscope waveform becomes the specified value. (Press the **VOLUME+/-** button changes the "EFB = $\square\square\square$ " value and the waveform.) The waveform changes by about 2% everytime when adjusted. Adjust as close as possible to the specified value. (Read power traverse adjustment)

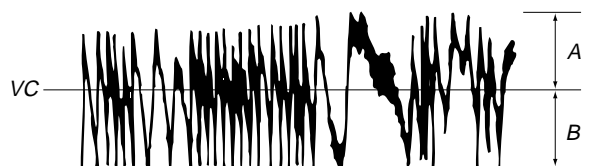
(Traverse Waveform)



Specified value : $A = B$

7. Press the **■ (CD)** button and save the adjustment results in the non-volatile memory (displayed as "EFB = $\square\square\square$ SAVE" momentarily and then displayed as "EFB = $\square\square\square$ MO-W").
8. Press the **VOLUME+/-** button so that the oscilloscope waveform becomes the specified value. (Pressing the **VOLUME+/-** button changes the "EFB = $\square\square\square$ " value and the waveform.) The waveform changes by about 2% everytime when adjusted. Adjust as close as possible to the specified value. (Write Power Traverse Adjustment)

(Traverse Waveform)

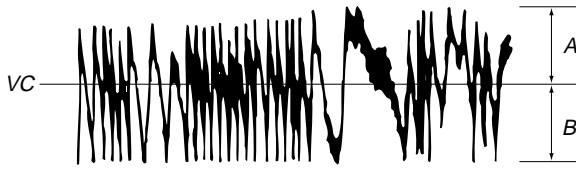


Specified value : $A = B$

9. Press the **■ (CD)** button to save the adjustment results in the non-volatile memory (displayed as "EFB = $\square\square\square$ SAVE" momentarily).

10. Next "EFB = MO-P" is displayed, the optical pick-up moves to the internal circumference of the pit and servo is imposed.
11. Press the **VOLUME+/-** button so that the oscilloscope waveform becomes the specified value.
The waveform changes by about 2% everytime when adjusted. Adjust as close as possible to the specified value.

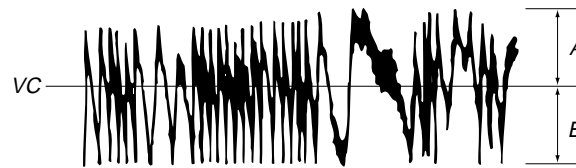
(Traverse Waveform)



Specified value : $A = B$

12. Press the **(CD)** button and save the adjustment results in the non-volatile memory (displayed as "EFB = SAVE" momentarily).
"EFBAL: CD" is next displayed and the disc stops rotating automatically.
13. Press the **(MD)** button and remove the disc.
14. Load the check disc (MD) TDYS-1.
15. Press the **(CD)** button to display "EFB = CD". The servo is imposed automatically.
16. Press the **VOLUME+/-** button so that the oscilloscope waveform becomes the specified value.
The waveform changes by about 2% everytime when adjusted. Adjust as close as possible to the specified value.

(Traverse Waveform)

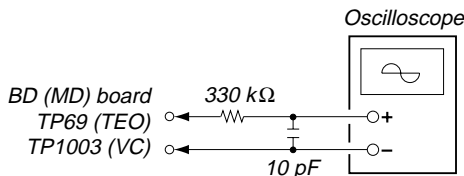


Specified value : $A = B$

17. Press the **(CD)** button and save the adjustment results in the non-volatile memory after "EFB = SAVE" is momentarily displayed.
"EFBAL ADJUST" is next displayed.
18. Press the **(MD)** button and remove the check disc (MD) TDYS-1.

Note 1: The data will be overwritten on the MO and erased when a recorded disc is used in this adjustment.

Note 2: If the traverse waveform is not clear, connect the oscilloscope as shown in the following figure so that it can be seen more clearly.



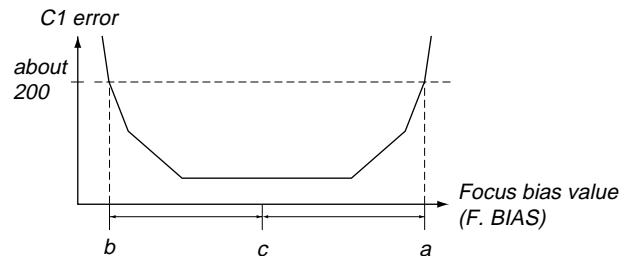
6-8. FOCUS BIAS ADJUSTMENT

Adjusting Procedure :

1. Load a continuously recorded disc (Refer to 6-4. Creating the Continuously Recorded Disc).
2. Press the **VOLUME+/-** button and display "CPLAY MODE".
3. Press the **(CD)** button to display "CPLAY MID".
4. When "C = AD = " is displayed, press the **(CD)** button.
5. Press the **VOLUME+/-** button to display "FBIAS ADJUST".
6. Press the **(CD)** button to display " a = ".
The first four digits indicate the C1 error rate, the two digits after the "/" indicate ADER and the two digits after "a =" indicate the focus bias value.
7. Press the **VOLUME+/-** button, and look for the focus bias value at which the C1 error rate becomes approximately about 200. (Refer to Note 2).
8. Press the **(CD)** button to display " b = ".
9. Press the **VOLUME+/-** button, and look for the focus bias value at which the C1 error rate becomes about 200.
The C1 error rate at this time should be almost same as the value set in step 7.
10. Press the **(CD)** button to display " c = ".
11. Check that the C1 error rate is below 50 and that ADER is 00, and press the **(CD)** button.
12. If the value of " " in the " - - " displayed is above 20, press the **(CD)** button.
If below, press the **(CD)** button and start from step 2 again.
13. Press the **(MD)** button and remove the continuously recorded disc.

Note 1: The following figure shows the relation between the C1 error and focus bias value. Look for points a and b in the following figure by the adjustment above. The focus position (point c) is automatically calculated from points a and b.

Note 2: As the C1 error rate changes, use the average value in the adjustment.



6-9. ERROR RATE CHECK

6-9-1. CD Error Rate Check

Checking Procedure :

1. Load a check disc (MD) TDYS-1.
2. Press the [VOLUME+/-] button to display "CPLAY MODE".
3. Press the [■ (CD)] button to display "CPLAY MID".
4. "C = 0000 AD = 00" is displayed.
5. Check that the C1 error rate is below 20.
6. Press the [▶|| (CD)] button to stop playback. Then press the [▲ (MD)] button, and remove the check disc (MD).

6-9-2. MO Error Rate Checking

Checking Procedure :

1. Load a continuously recorded disc (Refer to 6-4. Creating the Continuously Recorded Disc").
2. Press the [VOLUME+/-] button to display "CPLAY MODE".
3. Press the [■ (CD)] button to display "CPLAY MID".
4. "C = 0000 AD = 00" is displayed.
5. Check that the C1 error rate is below 50 and ADER is 00.
6. Press the [▶|| (CD)] button to stop playback. Then press the [▲ (MD)] button, and remove the disc.

6-10. FOCUS BIAS CHECK

Change the focus bias value and check the focus tolerance amount.

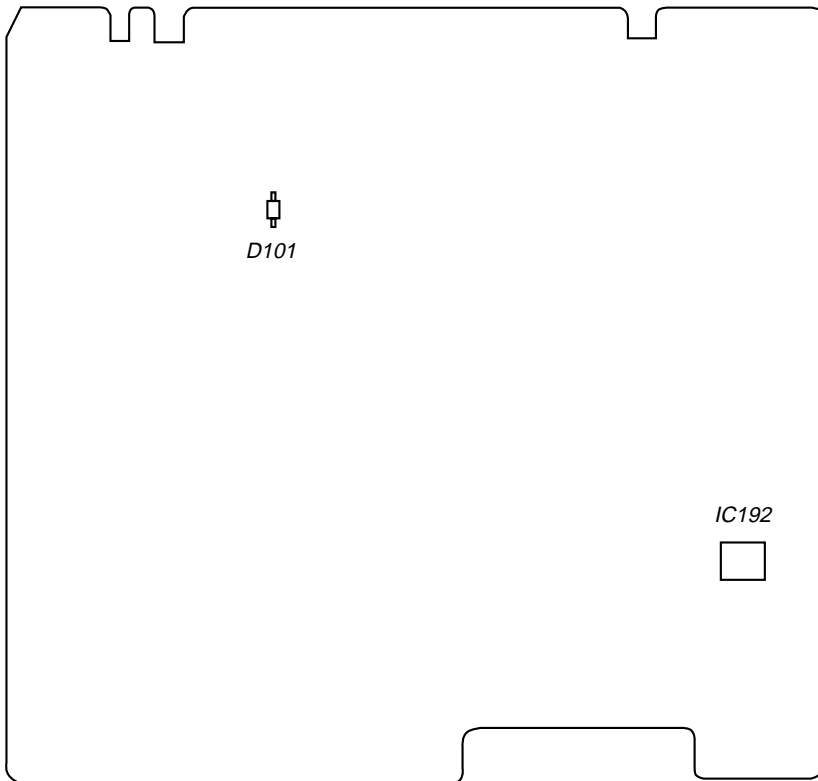
Checking Procedure :

1. Load a continuously recorded disc (Refer to 6-4. Creating the Continuously Recorded Disc").
2. Press the [VOLUME+/-] button to display "CPLAY MODE".
3. Press the [■ (CD)] button to display "CPLAY MID".
4. When "C = 0000 AD = 00" is displayed, press the [▶|| (CD)] button.
5. Press the [VOLUME+/-] button to display "FBIAS CHECK".
6. Press the [■ (CD)] button to display "0000/00 c = 00".
The first four digits indicate the C1 error, the two digits after the "/" indicate ADER and the two digits after "c =" indicate the focus bias value.
Check that the C1 error is below 50 and ADER is 00.
7. Press the [■ (CD)] button to change the display to "0000/00 b = 00".
Check that the C1 error does not drop below about 200 and ADER does not remain above 00.
8. Press the [■ (CD)] button to change the display to "0000/00 a = 00".
Check that the C1 error does not drop below about 200 and ADER does not remain above 00.
9. Press the [▶|| (CD)] button, press the [▲ (MD)] button next, and remove the continuously recorded disc.

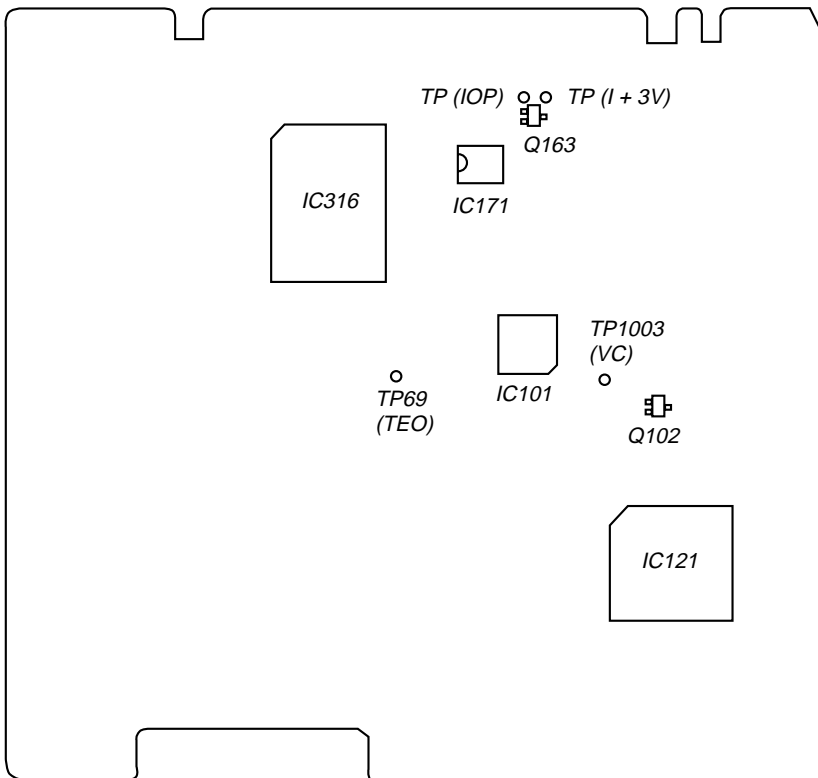
Note 1: If the C1 error is above about 200 or ADER is above 00 only for point a (step 8 above) and point b (step 7 above), the focus bias may not adjusted properly. In this case, adjust again.

6-11. ADJUSTING POINTS AND CONNECTING POINTS

[BD (MD) Board] (Side A)



[BD (MD) Board] (Side B)



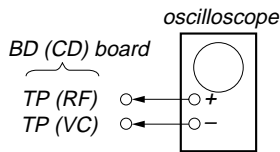
CD SECTION

Note:

1. CD Block is basically designed to operate without adjustment. Therefore, check each item in order given.
2. Use YEDS-18 disc (3-702-101-01) unless otherwise indicated.
3. Use an oscilloscope with more than 10 MΩ impedance.
4. Clean the object lens by an applicator with lens cleaning liquid when the signal level is low than specified value with the following checks.
5. Adjust the focus bias adjustment when optical block is replaced.

Focus Bias Adjustment

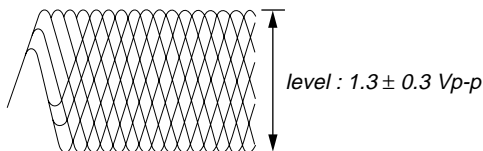
Perform this adjustment when the optical pick-up has been replaced or repaired.



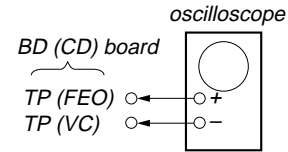
Procedure:

1. Connect oscilloscope to test point TP (RF).
2. Turn Power switch on.
3. Put disc (YEDS-18) in and playback.
4. Adjust RV101 so that the waveform is clear.
(Clear RF signal waveform means that the shape “◇” can be clearly distinguished at the center of the waveform.)
5. After adjustment, check the RF signal level.

- RF signal
VOLT/DIV: 200 mV
TIME/DIV: 500 nS



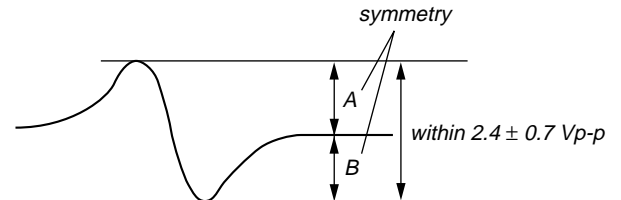
S Curve Check



Procedure :

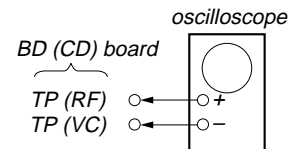
1. Connect oscilloscope to test point TP (FEO).
2. Connect between test point TP (FOK) and Ground by lead wire.
3. Turn Power switch on.
4. Put disc (YEDS-18) in and turned Power switch on again and actuate the focus search. (actuate the focus search when disc table is moving in and out.)
5. Check the oscilloscope waveform (S-curve) is symmetrical between A and B. And confirm peak to peak level within $2.4 \pm 0.7 \text{ Vp-p}$.

S-curve waveform



6. After check, remove the lead wire connected in step 2.
- Note:**
- Try to measure several times to make sure than the ratio of A : B or B : A is more than 10 : 7.
 - Take sweep time as long as possible and light up the brightness to obtain best waveform.

RF Level Check

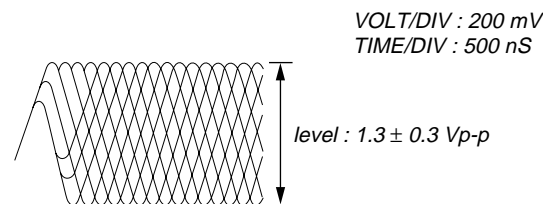


Procedure :

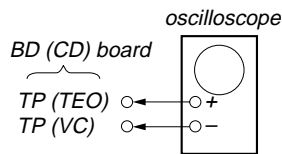
1. Connect oscilloscope to test point TP (RF) on BD (CD) board.
2. Turn Power switch on.
3. Put disc (YEDS-18) in and playback.
4. Confirm that oscilloscope waveform is clear and check RF signal level is correct or not.

Note: Clear RF signal waveform means that the shape “◇” can be clearly distinguished at the center of the waveform.

RF signal waveform



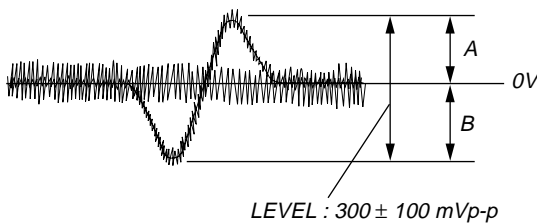
**E-F Balance (1 Track Jump) Check
(Without remote commander)**



Procedure :

1. Connect oscilloscope to test point TP (TEO) on BD (CD) board.
2. Turn Power switch on.
3. Put disc (YEDS-18) in to play the number five track.
4. Press the “▶|| (CD) (Pause)” button. (Becomes the 1 track jump mode)
5. Confirm that the oscilloscope waveform is symmetrical on the top and bottom in relation to 0Vdc, and check this level.

1 track jump waveform



Specified level: • $\frac{A - B}{2(A + B)} \times 100 = \text{less than } \pm 7\%$

• $A + B = 300 \pm 100 \text{ mVp-p}$

6. Remove the lead wire connected in step 1.

Focus/Tracking Gain Adjustment (RV102, RV103)

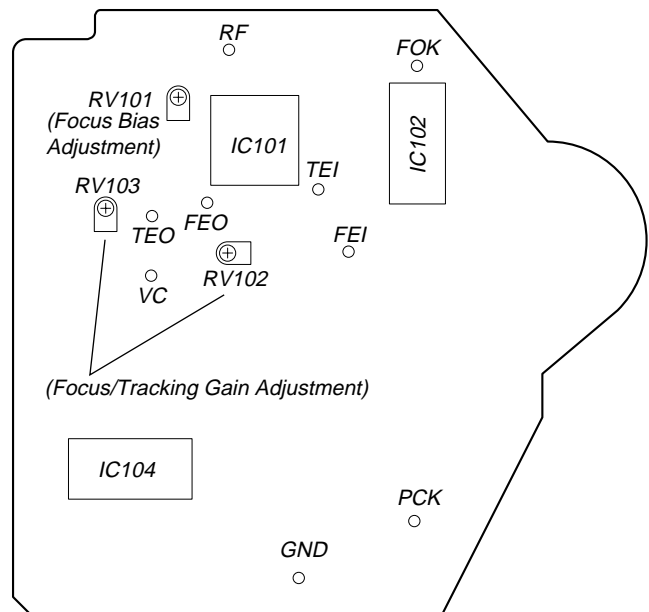
This gain has a margin, so even if it is slightly off. There is no problem.

Therefore, do not perform this adjustment.

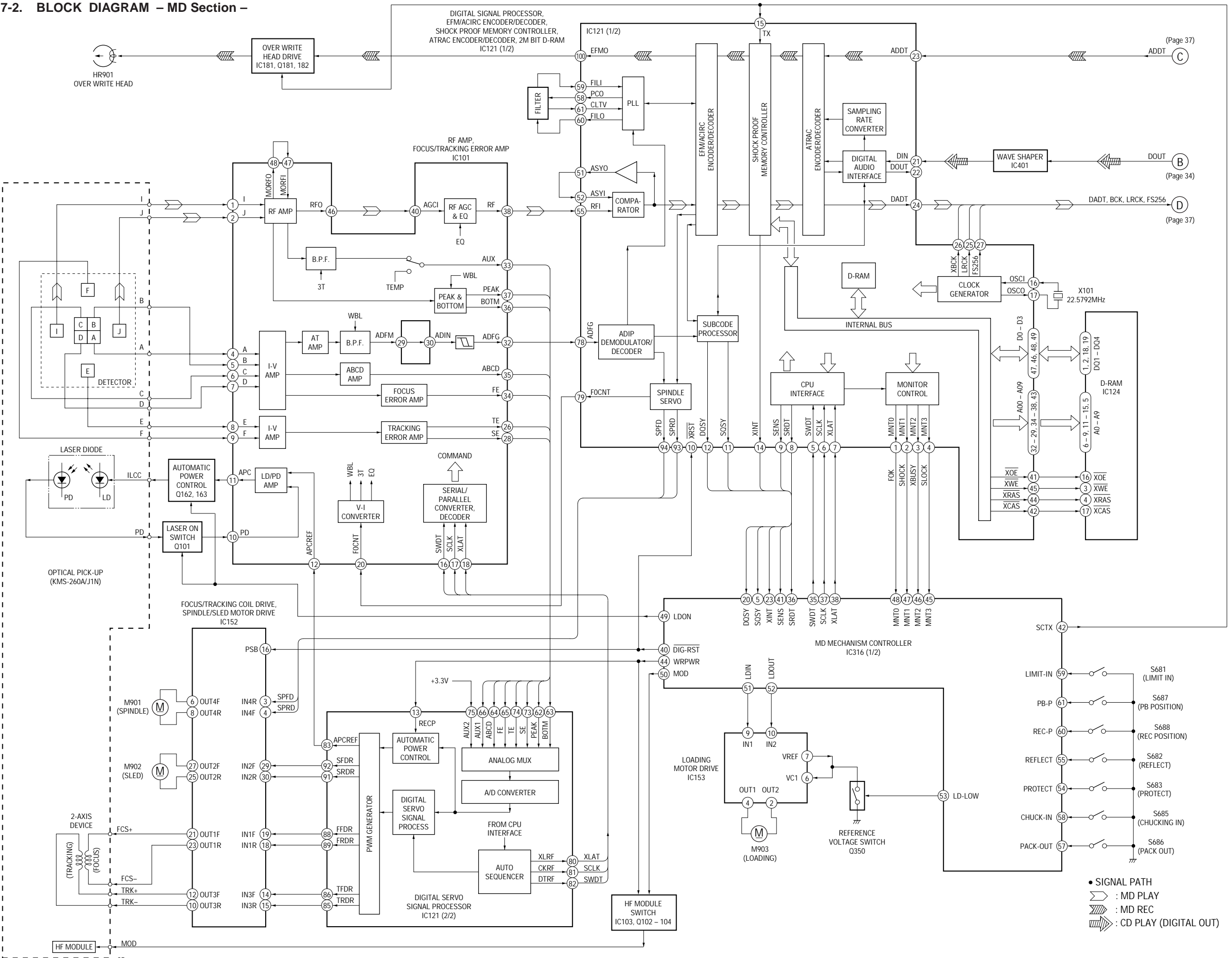
Please note that it should be fixed to mechanical center position when you moved and do not know original position.

Adjustment Location:

[BD (CD) Board] (Side B)



7-2. BLOCK DIAGRAM – MD Section –



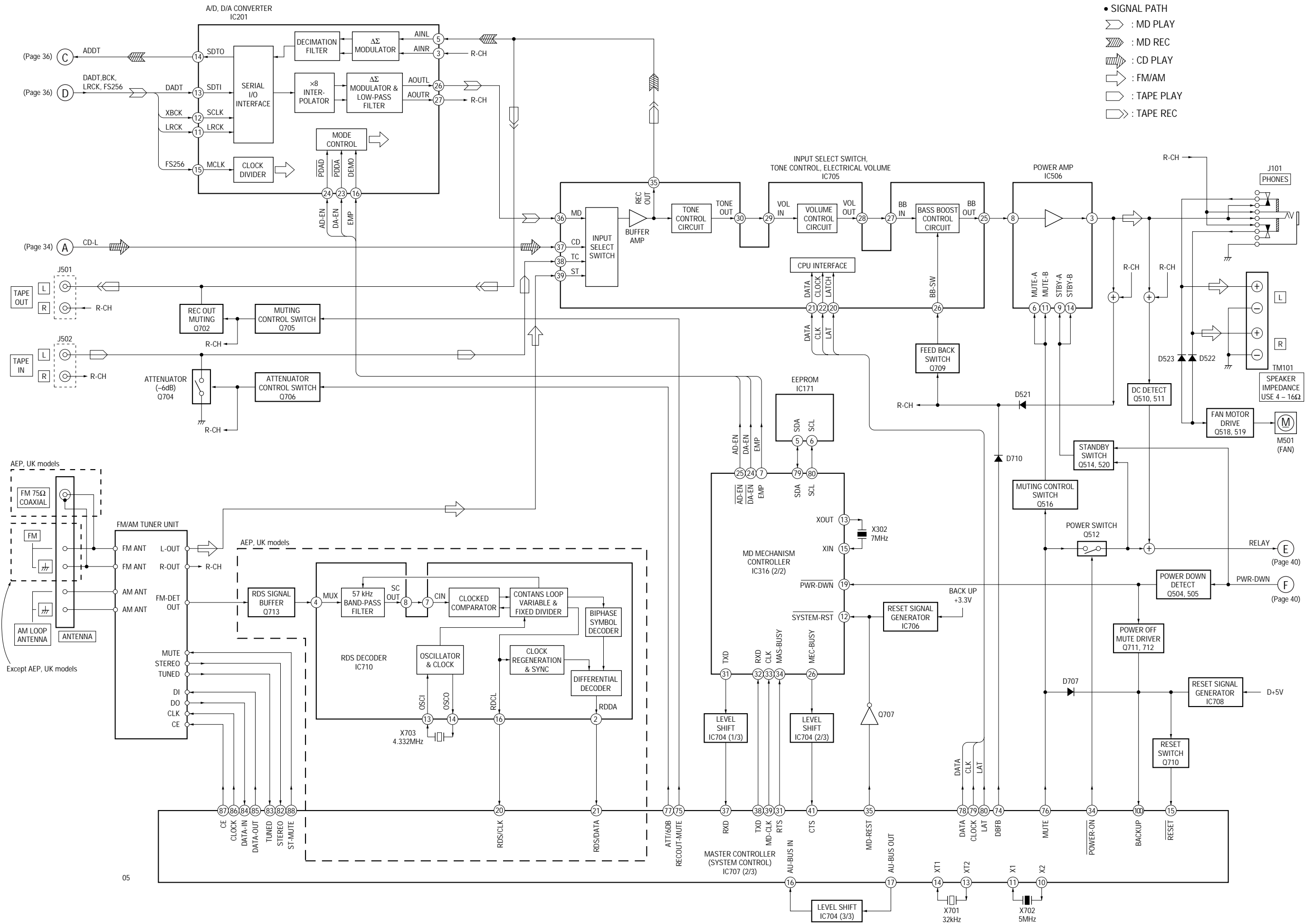
(Page 37)

(Page 34)

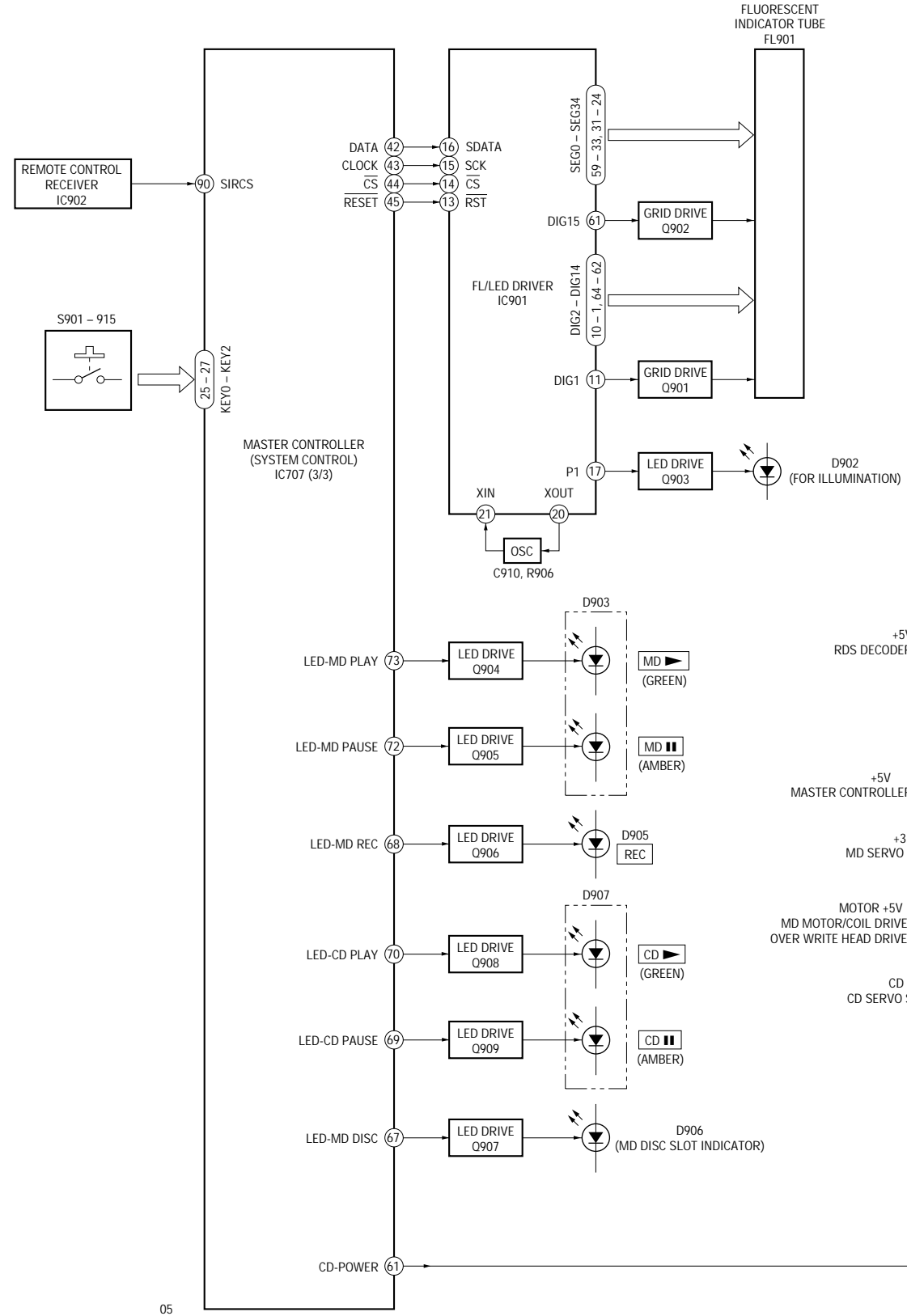
(Page 37)

• SIGNAL PATH
 ——— : MD PLAY
 ▨ : MD REC
 - - - : CD PLAY (DIGITAL OUT)

7-3. BLOCK DIAGRAM – MAIN Section –



7-4. BLOCK DIAGRAM – DISPLAY/POWER SUPPLY Section –



FLUORESCENT INDICATOR TUBE FL901

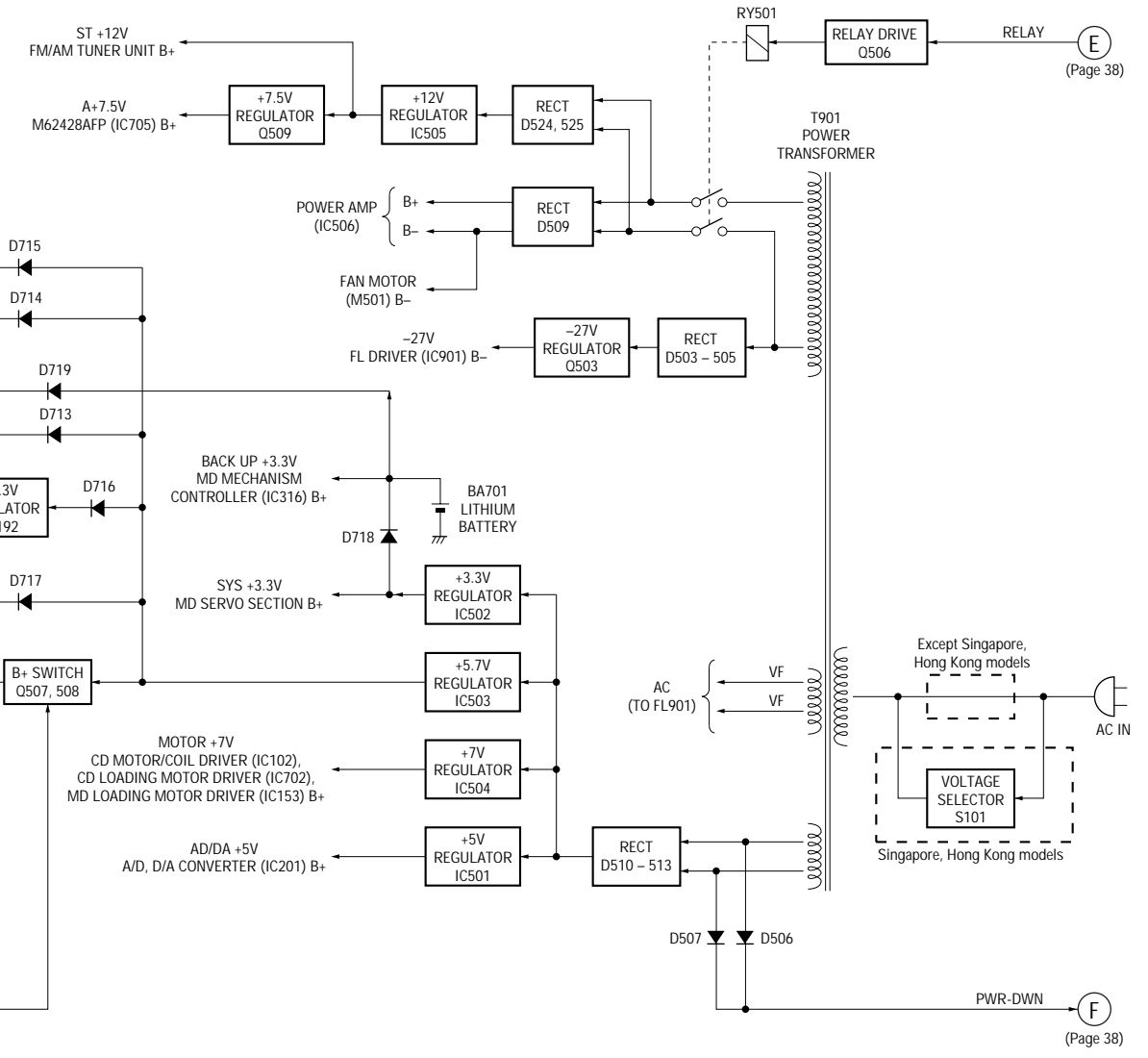
D902 (FOR ILLUMINATION)

D903
MD (GREEN)
MD (AMBER)

D905
REC

D907
CD (GREEN)
CD (AMBER)

D906
(MD DISC SLOT INDICATOR)

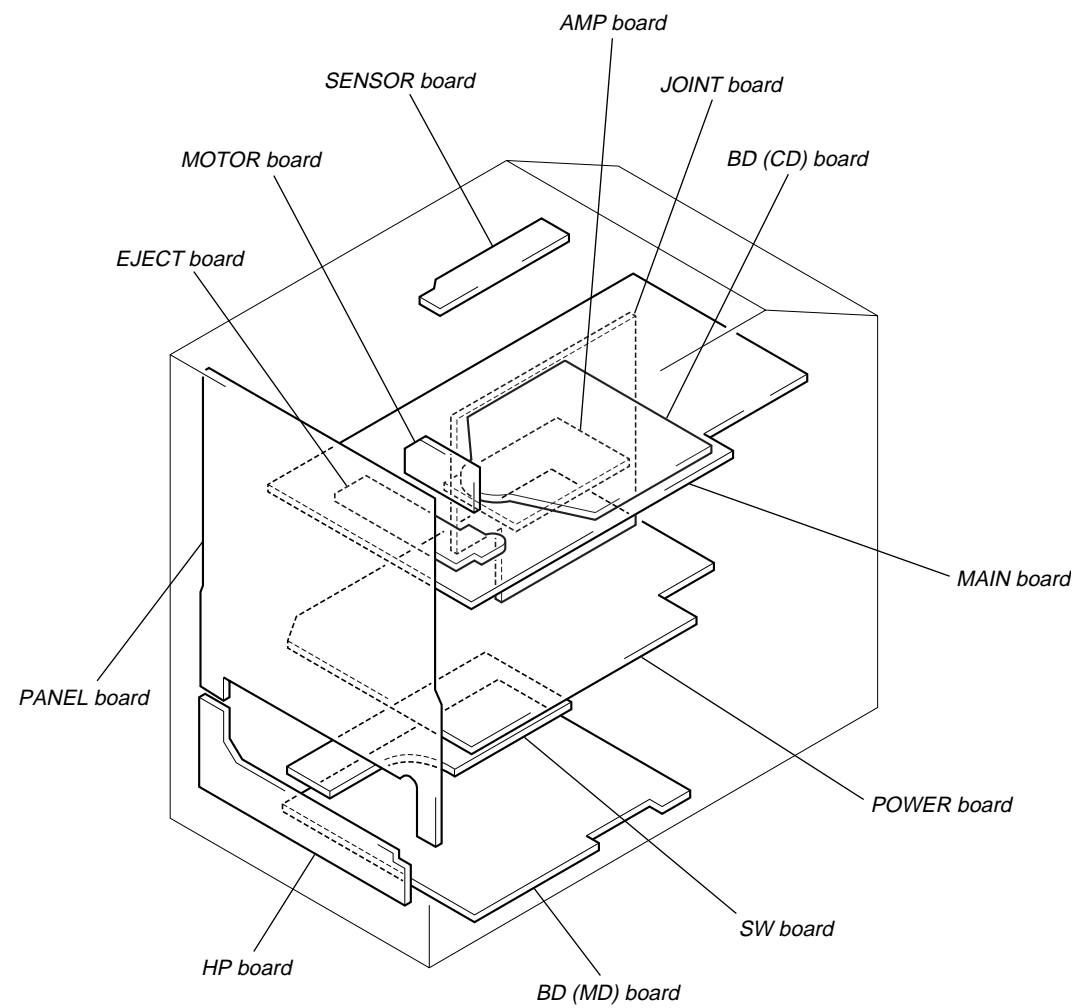


(Page 38)

(Page 38)



05

• Circuit Boards Location



7-5. NOTE FOR PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS

Note on Schematic Diagram:











- All capacitors are in μF unless otherwise noted. pF : μF 50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and $1/4\text{W}$ or less unless otherwise specified.
- \triangle : internal component.
-  : nonflammable resistor.
-  : panel designation.

Note:




The components identified by mark \triangle or dotted line with mark \triangle are critical for safety. Replace only with part number specified.

Note:

Les composants identifiés par une marque \triangle sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

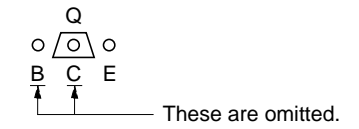
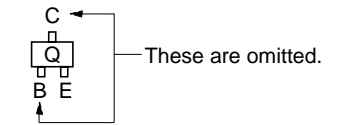
-  : B+ Line.
-  : B- Line.
-  : adjustment for repair.
- Voltages are taken with a VOM (Input impedance 10 M Ω). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with a oscilloscope. Voltage variations may be noted due to normal production tolerances.
- Circled numbers refer to waveforms.
- Signal path.
 -  : FM/AM
 -  : MD PLAY
 -  : MD REC
 -  : CD PLAY (ANALOG OUT)
 -  : CD PLAY (DEGITAL OUT)
 -  : TAPE PLAY
 -  : TAPE REC
- Abbreviation
 - CND : Canadian model.
 - HK : Hong Kong model.
 - SP : Singapore model.

Note on Printed Wiring Board:

-  : parts extracted from the component side.
-  : Through hole.
-  : Pattern from the side which enables seeing. (The other layers' patterns are not indicated.)

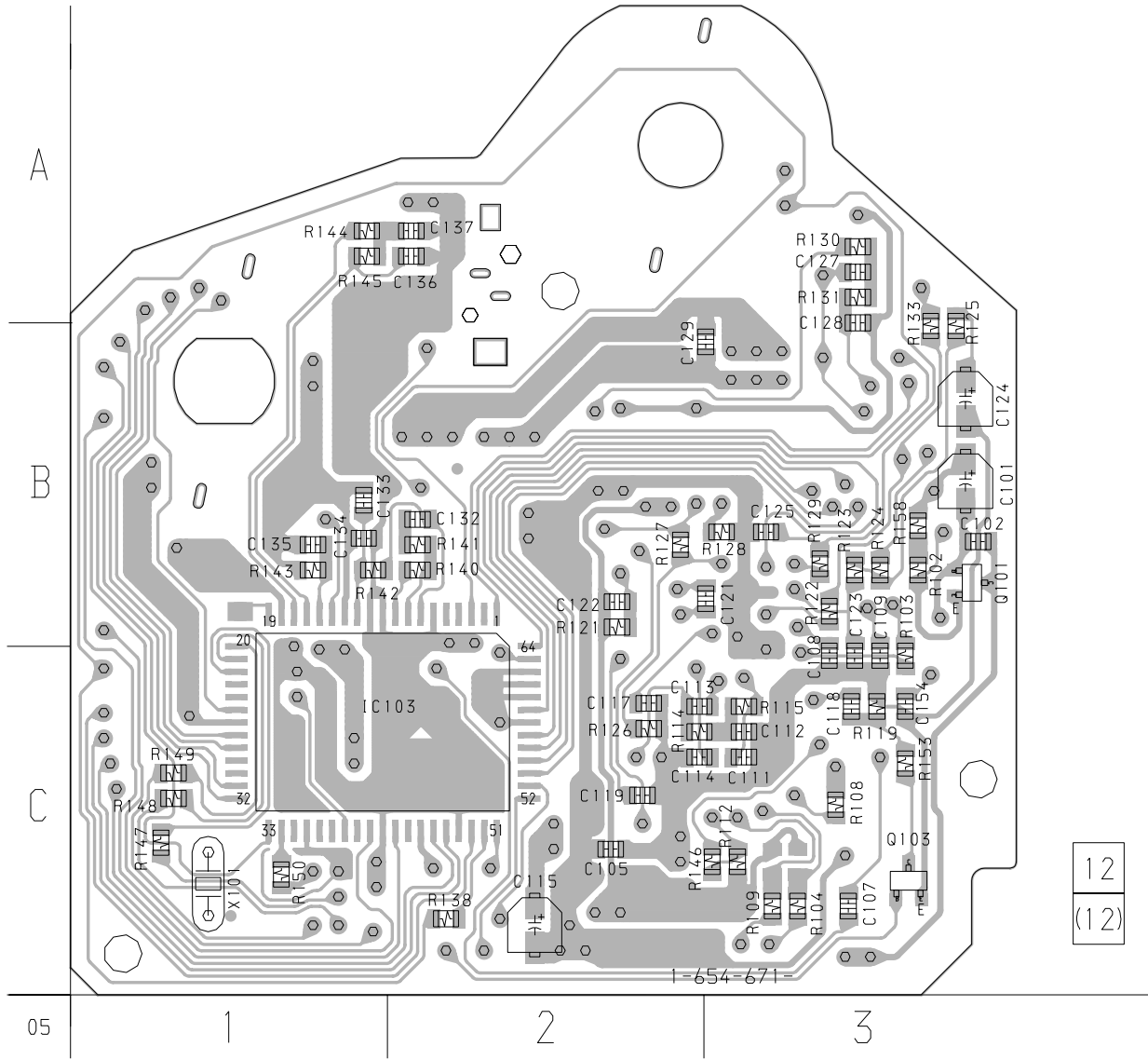
Caution:
 Pattern face side: Parts on the pattern face side seen from the pattern face are indicated. (Side B)
 Parts face side: Parts on the parts face side seen from the parts face are indicated. (Side A)

- Indication of transistor.



7-6. PRINTED WIRING BOARD – BD (CD) Section – • See page 41 Circuit Boards Location.

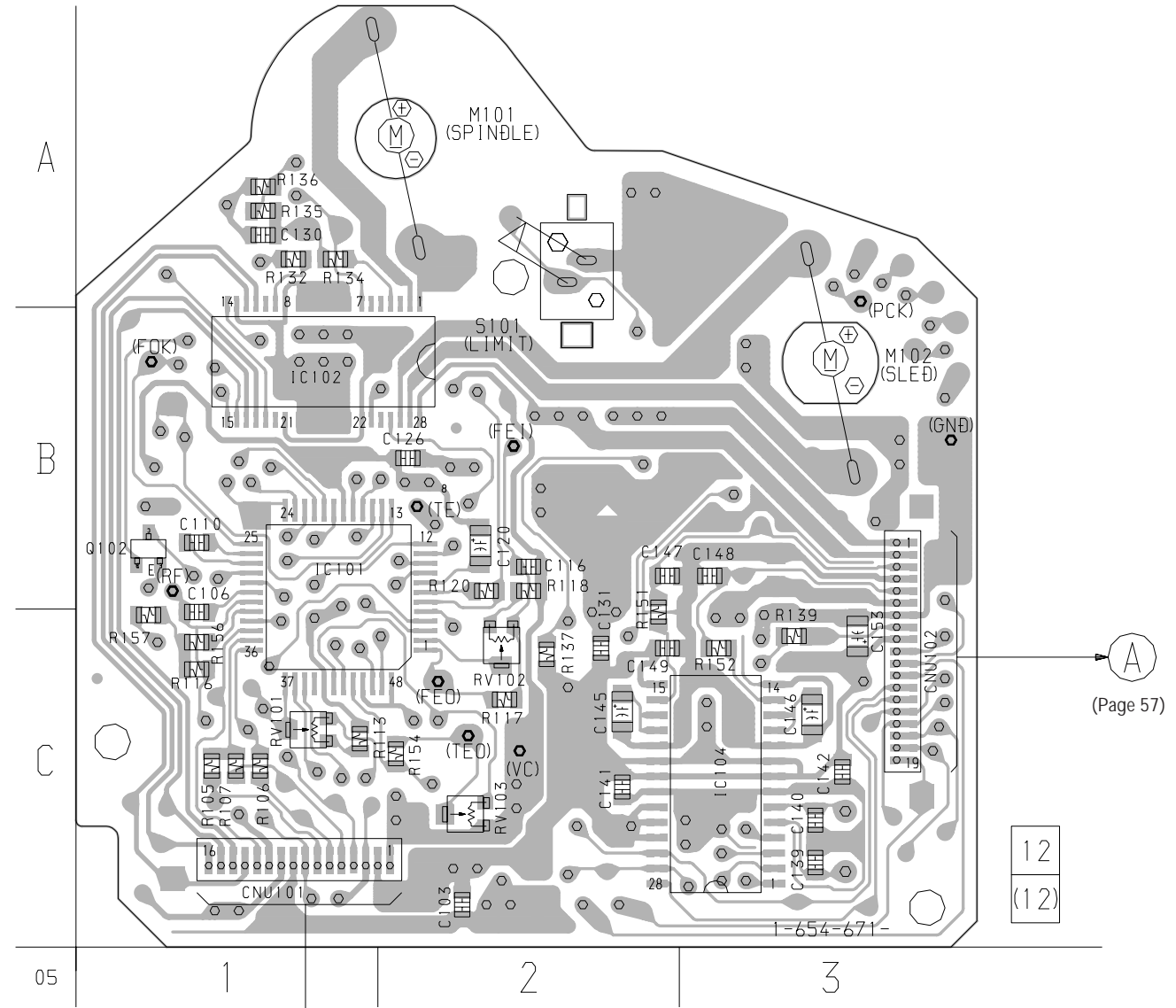
【BD (CD) BOARD】(SIDE A)



• Semiconductor Location

Ref. No.	Location
IC103	C-1
Q101	B-3
Q103	C-3

【BD (CD) BOARD】(SIDE B)



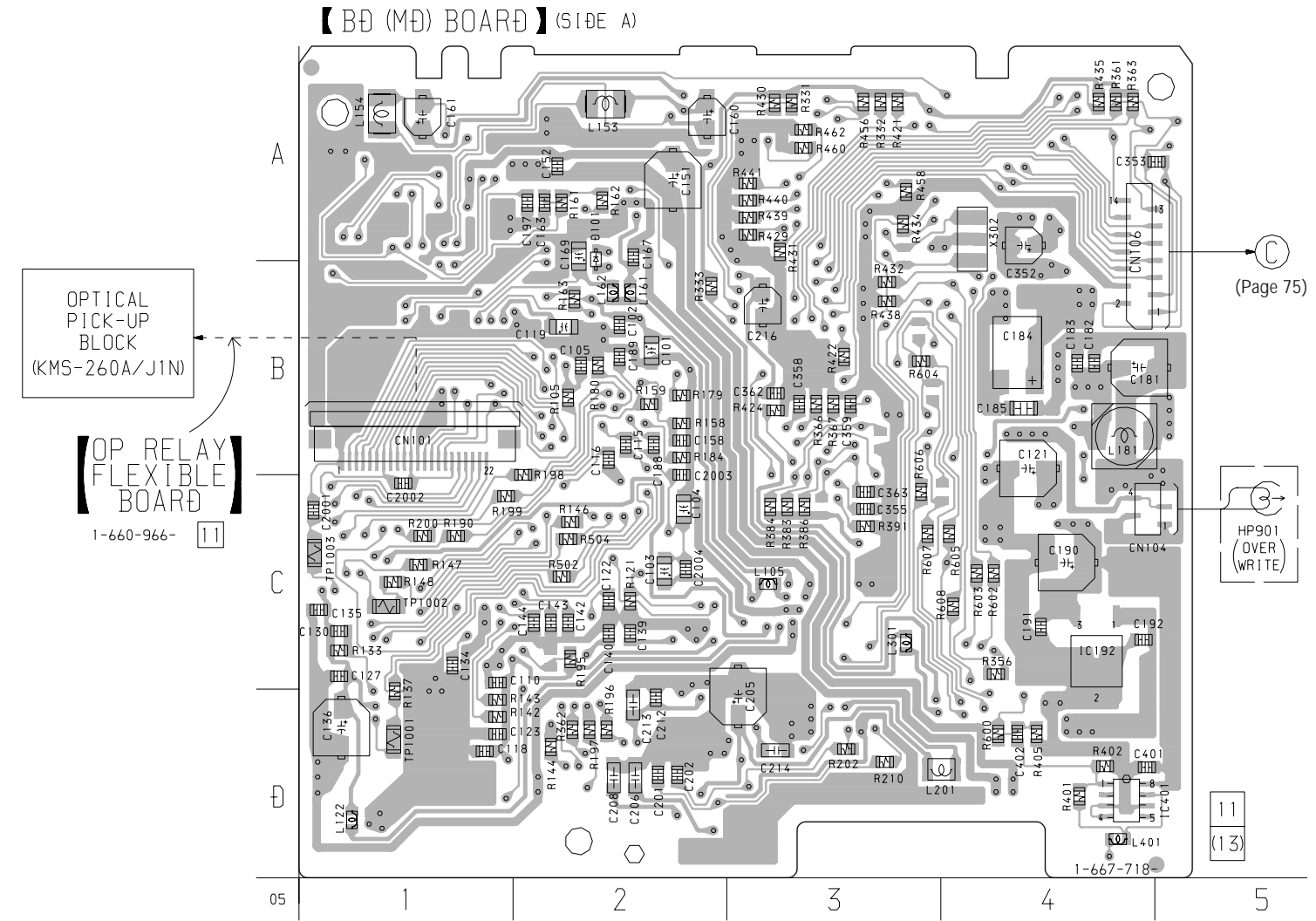
OPTICAL PICK-UP BLOCK
KSS-213B/K-N

• Semiconductor Location

Ref. No.	Location
IC101	B-1
IC102	B-1
IC104	C-3
Q102	B-1

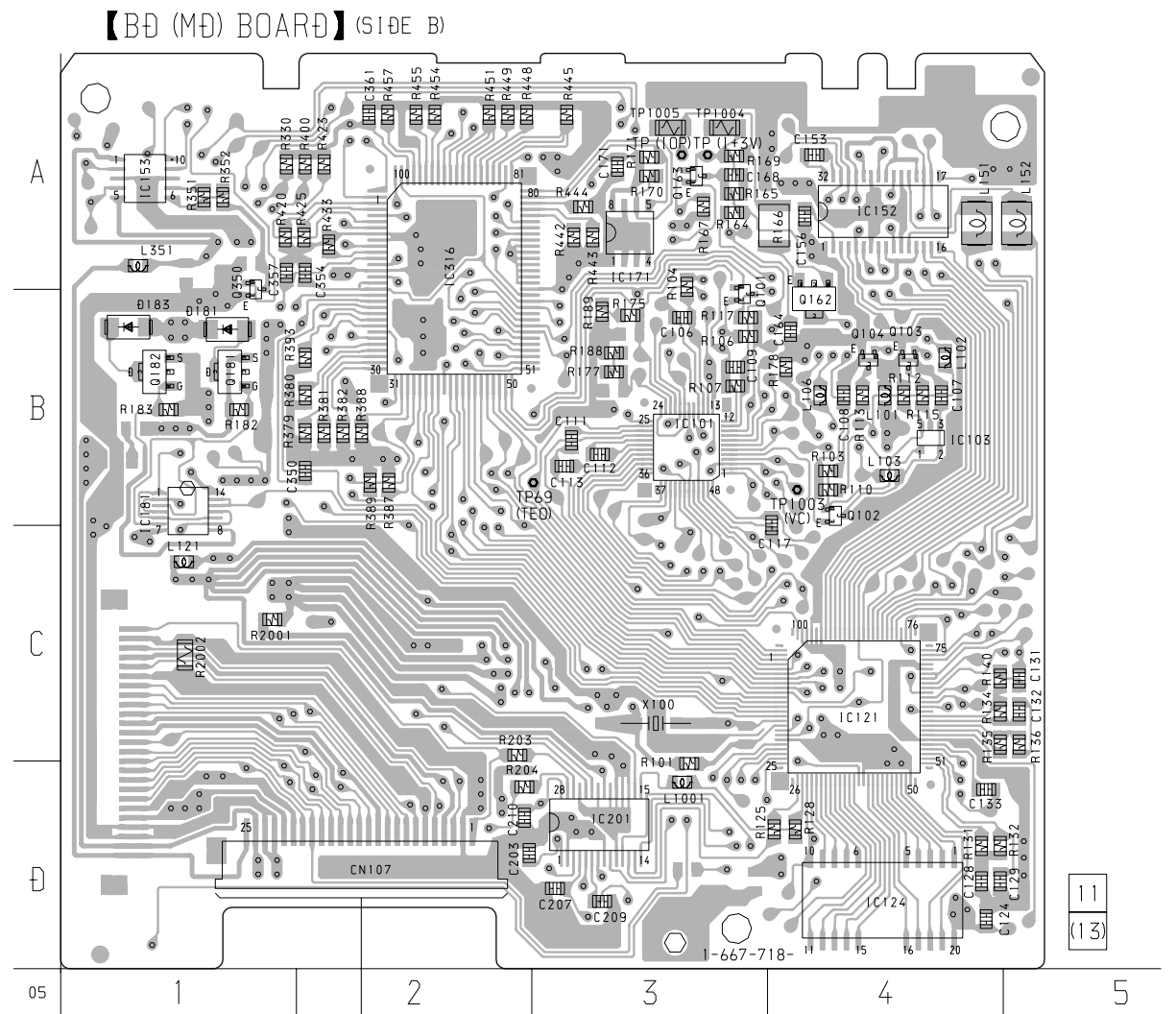
(Page 57)

7-8. PRINTED WIRING BOARD – BD (MD) Section – • See page 41 Circuit Boards Location.



• Semiconductor Location

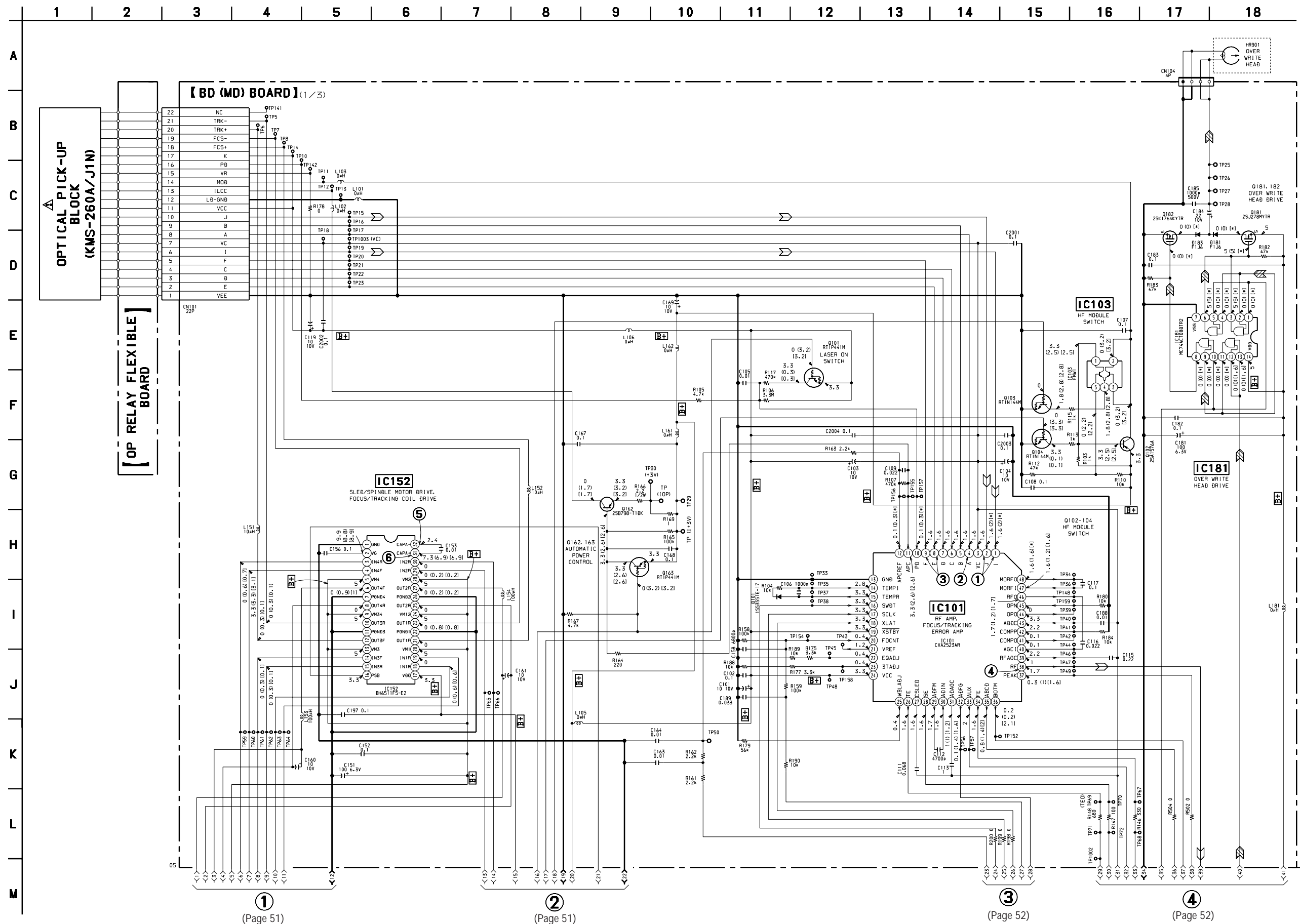
Ref. No.	Location
D101	B-2
IC192	C-4
IC401	D-4



• Semiconductor Location

Ref. No.	Location
D181	B-1
D183	B-1
IC101	B-3
IC103	B-4
IC121	C-4
IC124	D-4
IC152	A-4
IC153	A-1
IC171	A-3
IC181	B-1
IC201	D-3
IC316	A-2
Q101	B-3
Q102	B-4
Q103	B-4
Q104	B-4
Q162	B-4
Q163	A-3
Q181	B-1
Q182	B-1
Q350	A-1

7-9. SCHEMATIC DIAGRAM – BD (MD) Section (1/3) – • See page 77 for Waveforms. • See page 82 for IC Block Diagrams.



① (Page 51)

② (Page 51)

③ (Page 52)

④ (Page 52)

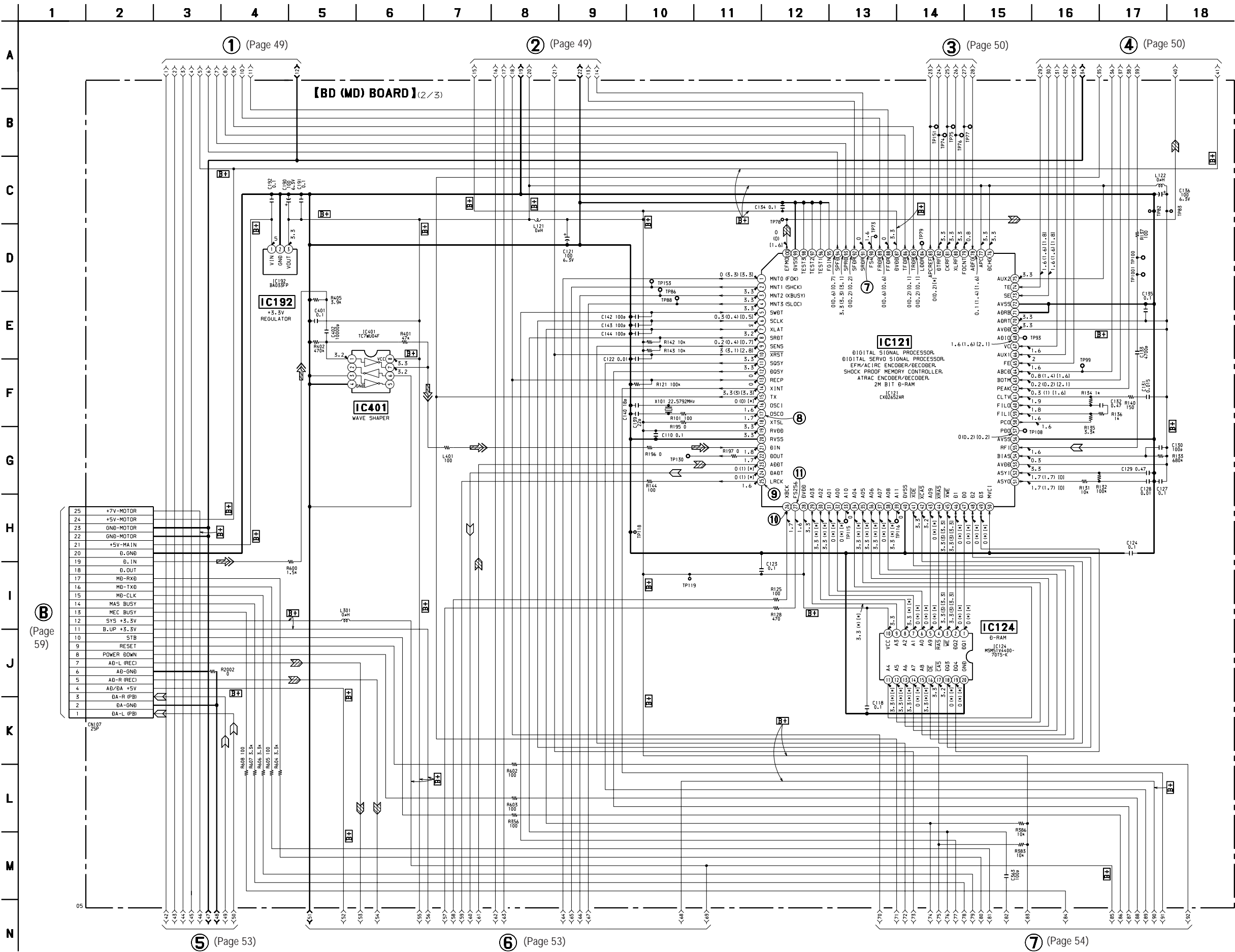
- Voltages and waveforms are dc with respect to ground under no-signal conditions.
- no mark : STOP
- () : MD PLAY
- [] : MD REC
- * : Impossible to measure

The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

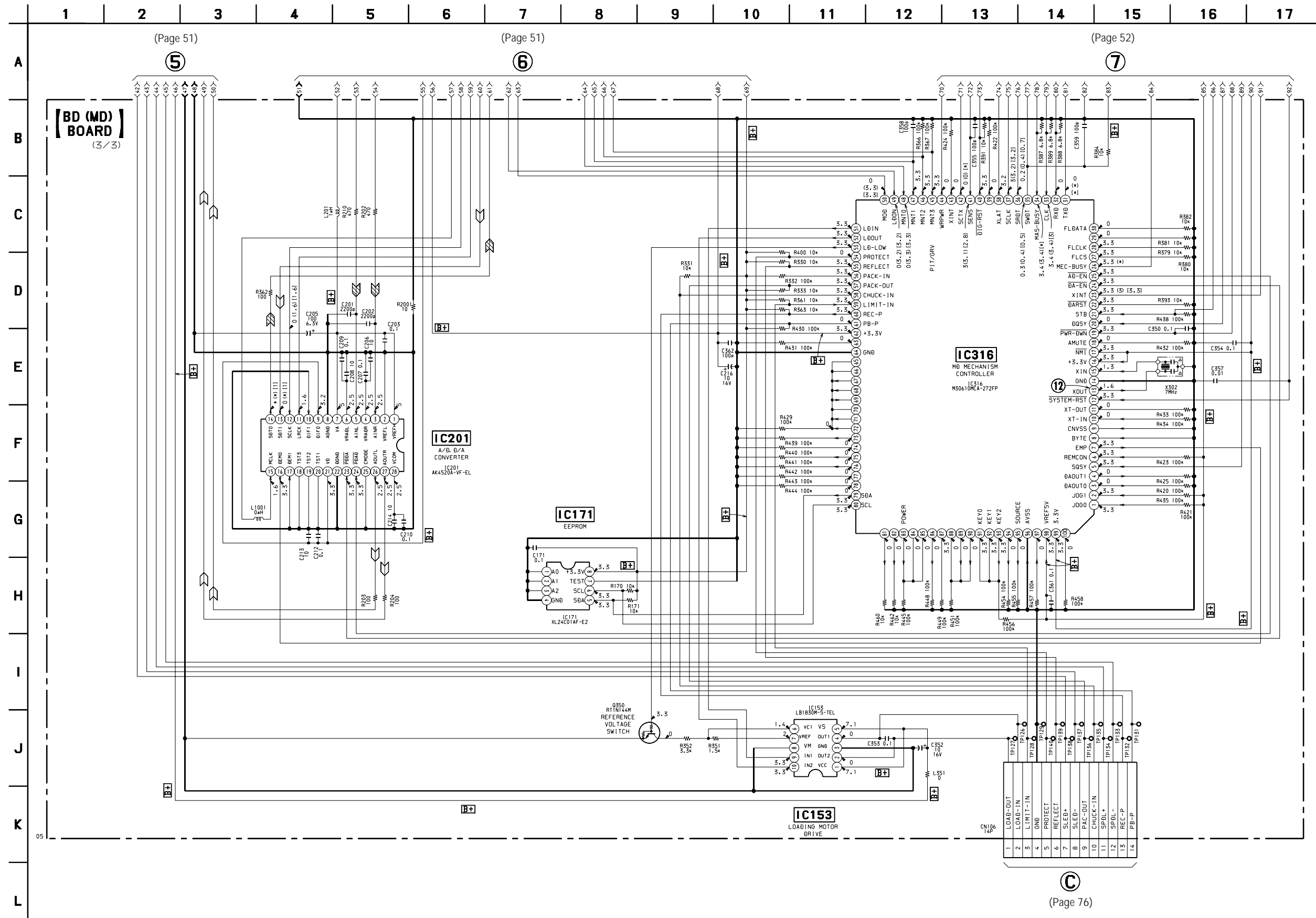
Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

- Voltages and waveforms are dc with respect to ground under no-signal conditions.
- no mark : STOP
- () : MD PLAY
- [] : MD REC
- * : Impossible to measure

7-10. SCHEMATIC DIAGRAM – BD (MD) Section (2/3) – • See page 77 for Waveforms. • See page 82 for IC Block Diagrams.

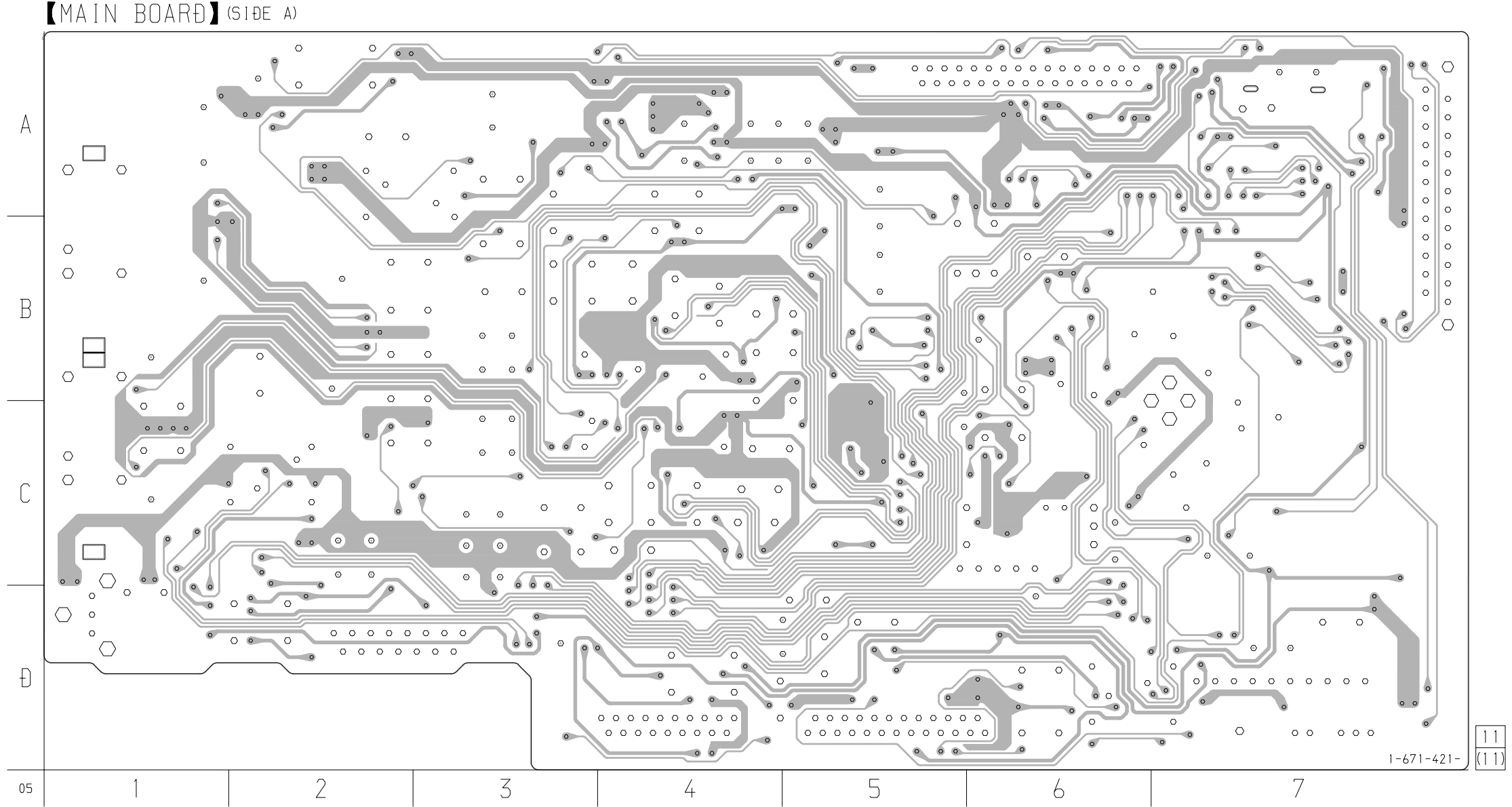


7-11. SCHEMATIC DIAGRAM – BD (MD) Section (3/3) – • See page 77 for Waveforms. • See page 82 for IC Block Diagrams.

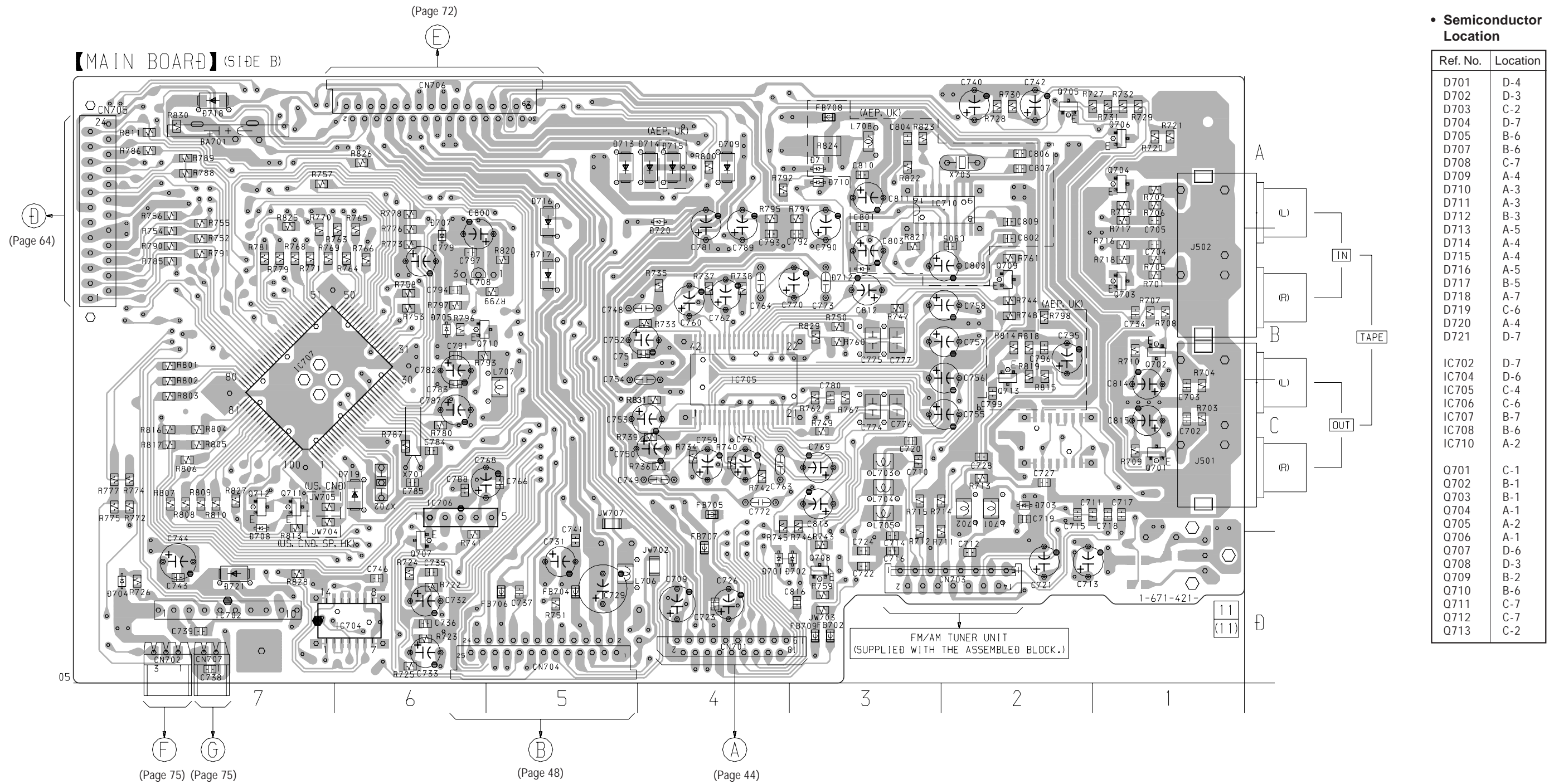


• Voltages and waveforms are dc with respect to ground under no-signal conditions.
 no mark : STOP
 () : MD PLAY
 [] : MD REC
 * : Impossible to measure

7-12. PRINTED WIRING BOARD – MAIN Board (side A) – • See page 41 Circuit Boards Location.



7-13. PRINTED WIRING BOARD – MAIN Board (side B) – • See page 41 Circuit Boards Location.

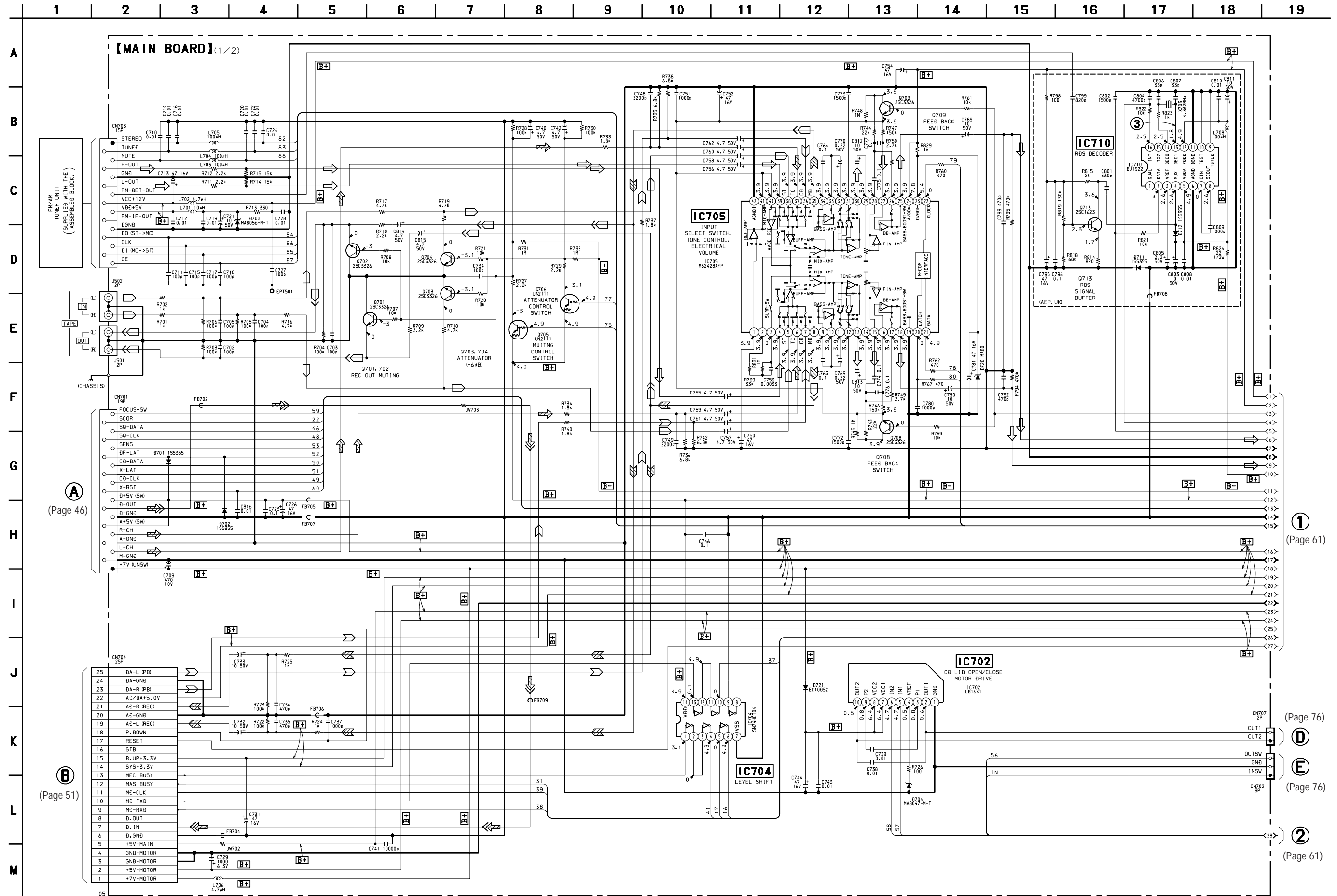


• Semiconductor Location

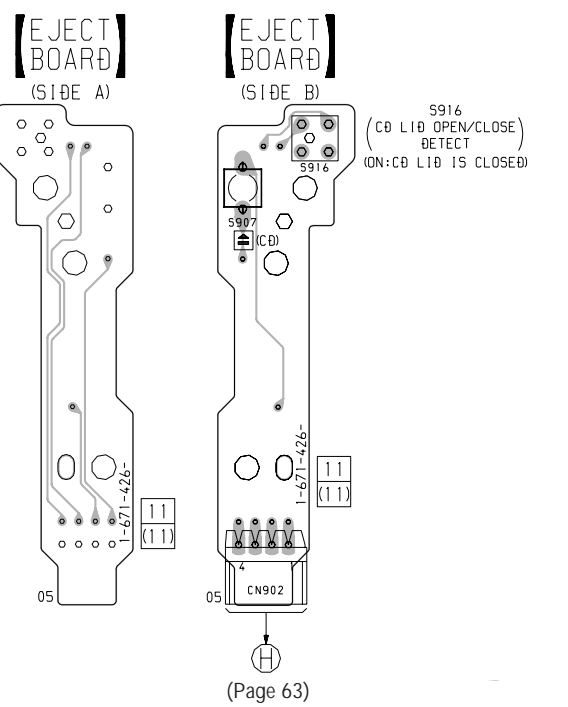
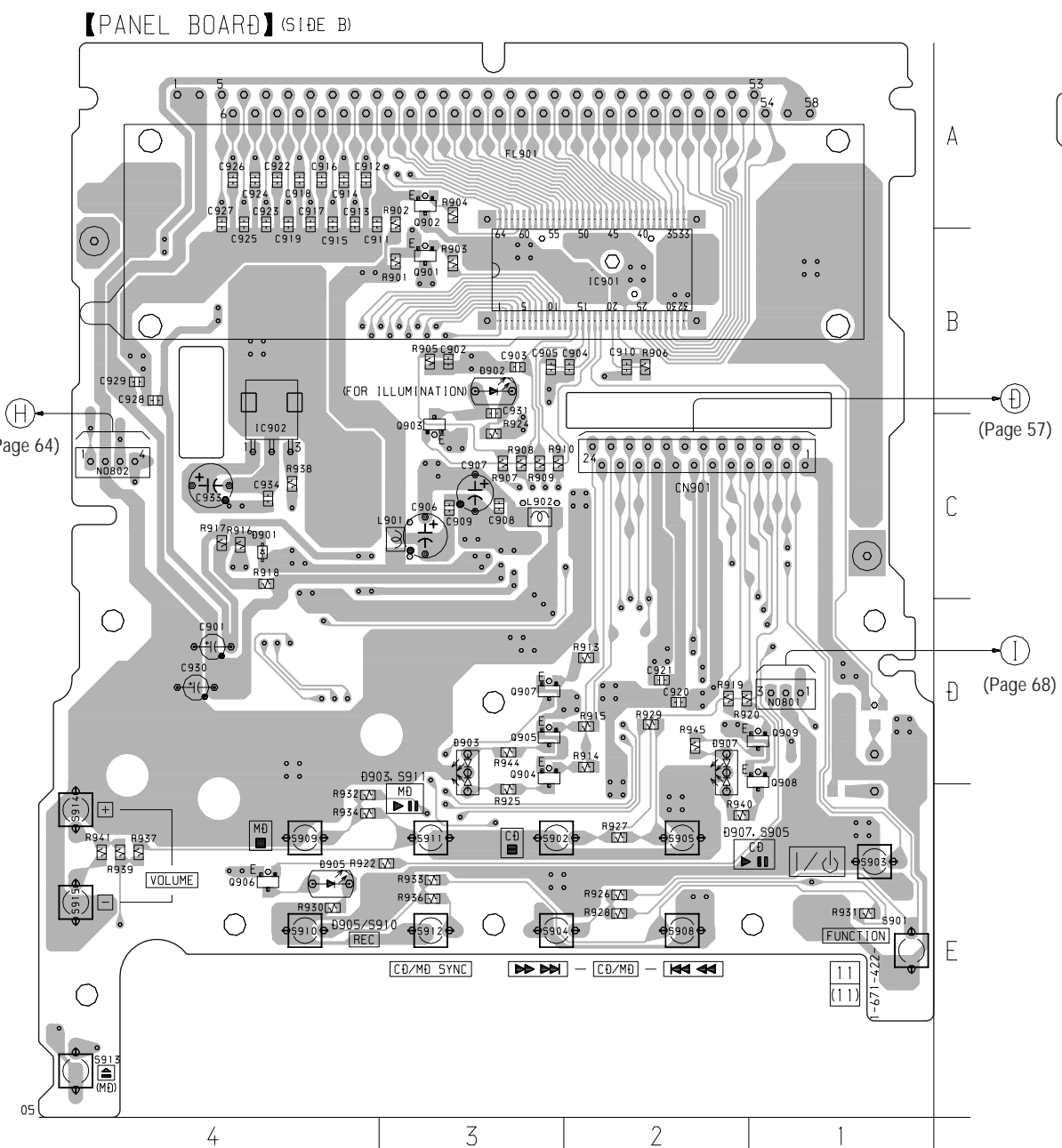
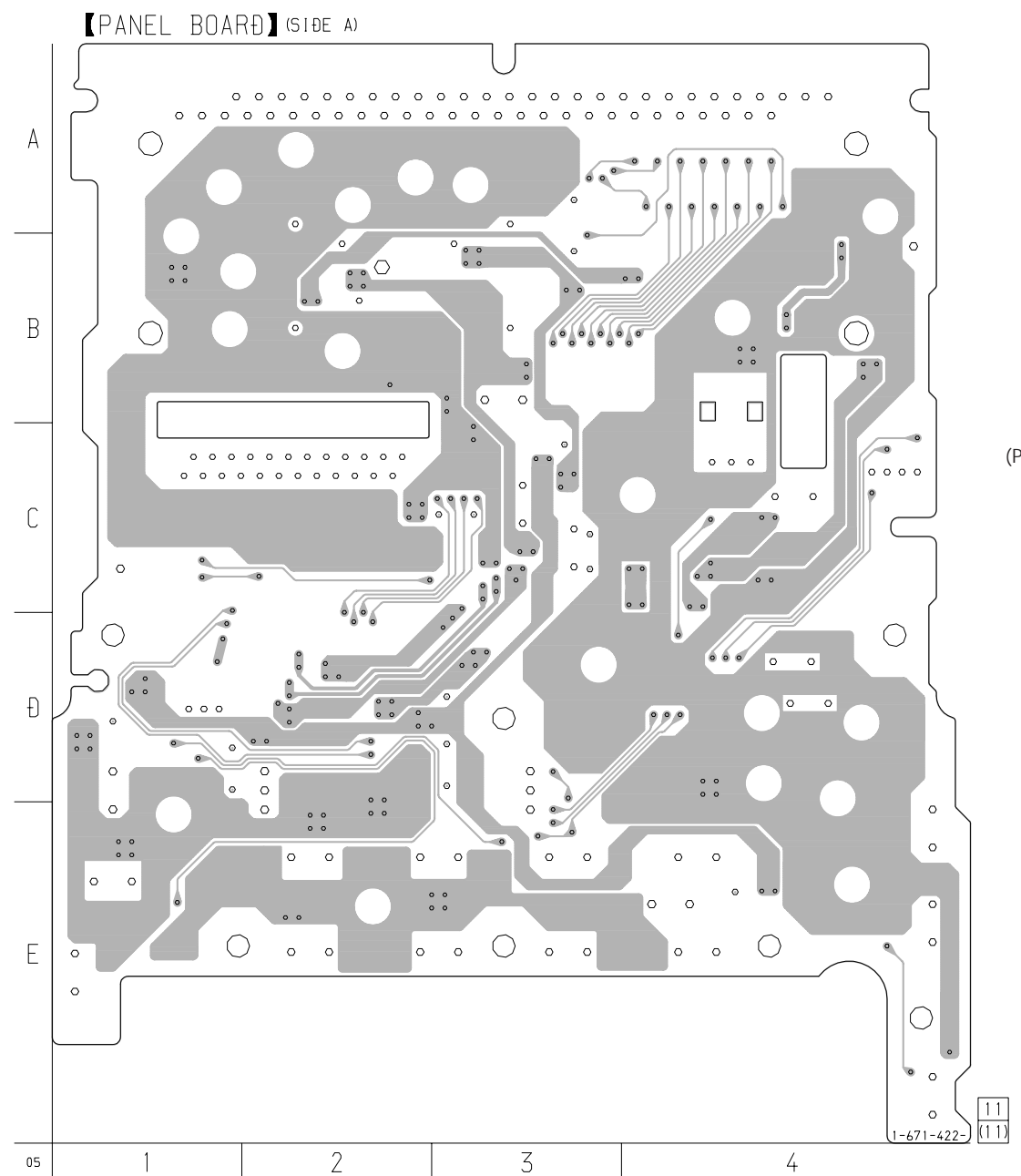
Ref. No.	Location
D701	D-4
D702	D-3
D703	C-2
D704	D-7
D705	B-6
D707	B-6
D708	C-7
D709	A-4
D710	A-3
D711	A-3
D712	B-3
D713	A-5
D714	A-4
D715	A-4
D716	A-5
D717	B-5
D718	A-7
D719	C-6
D720	A-4
D721	D-7
IC702	D-7
IC704	D-6
IC705	C-4
IC706	C-6
IC707	B-7
IC708	B-6
IC710	A-2
Q701	C-1
Q702	B-1
Q703	B-1
Q704	A-1
Q705	A-2
Q706	A-1
Q707	D-6
Q708	D-3
Q709	B-2
Q710	B-6
Q711	C-7
Q712	C-7
Q713	C-2

- Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions.
- no mark : FM
- * : Impossible to measure

7-14. SCHEMATIC DIAGRAM – MAIN Section (1/2) – • See page 78 for Waveforms. • See page 84 for IC Block Diagrams.



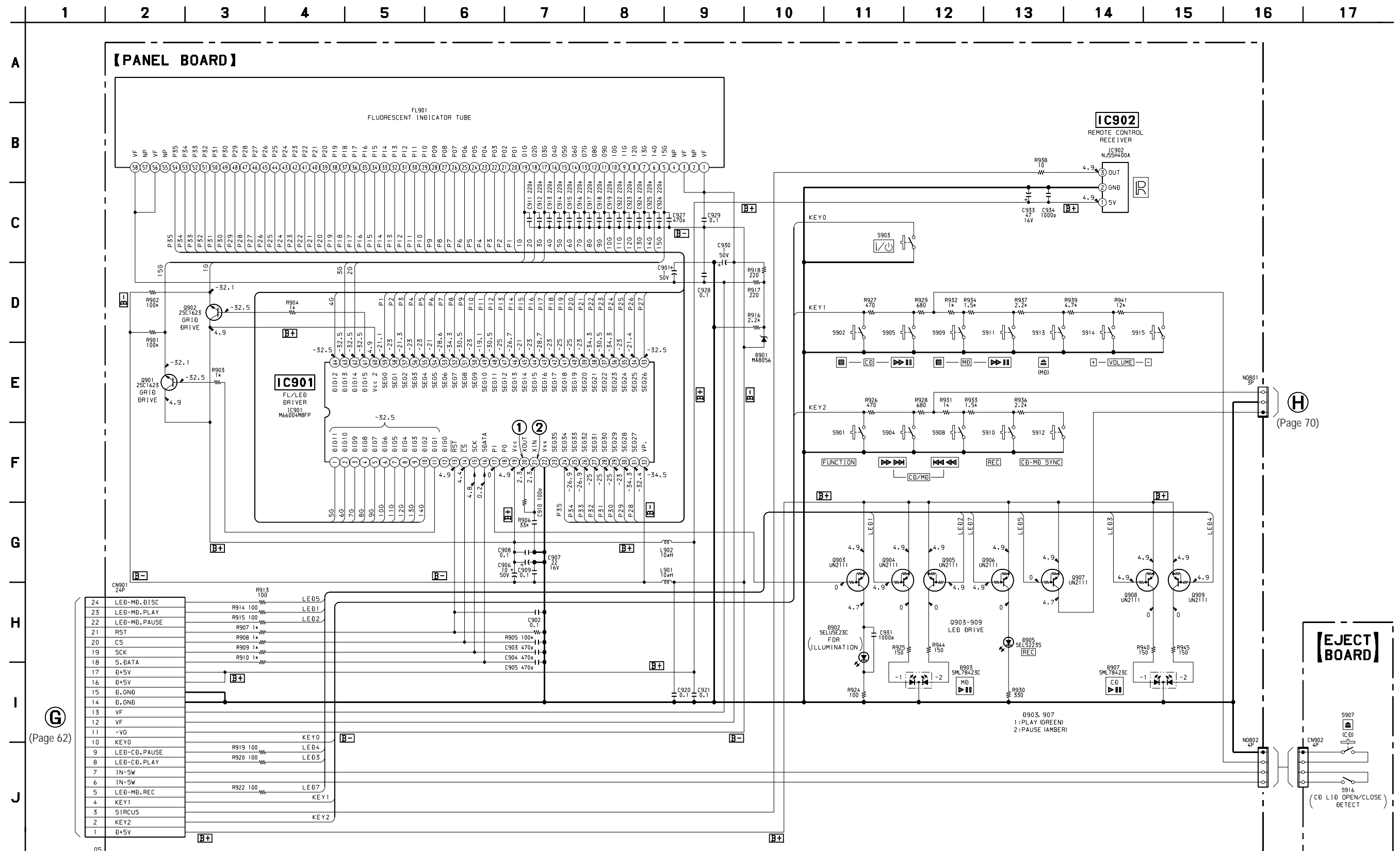
7-16. PRINTED WIRING BOARDS – PANEL Section – • See page 41 Circuit Boards Location.



• Semiconductor Location

Ref. No.	Location	Ref. No.	Location
D901	C-4	Q901	B-3
D902	B-3	Q902	A-3
D903	D-3	Q903	C-3
D905	E-4	Q904	D-3
D907	D-2	Q905	D-3
		Q906	E-4
IC901	B-2	Q907	D-3
IC902	C-4	Q908	D-1
		Q909	D-1

7-17. SCHEMATIC DIAGRAM – PANEL Section – • See page 85 for IC Block Diagrams.



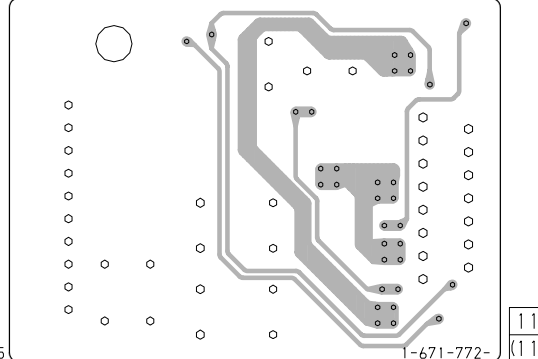
(Page 62)

(Page 70)

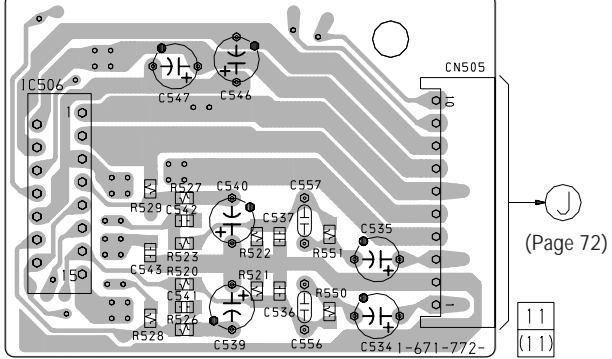
• Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions.
no mark : FM

7-18. PRINTED WIRING BOARDS – AMP/TRANSFORMER Section – • See page 41 Circuit Boards Location.

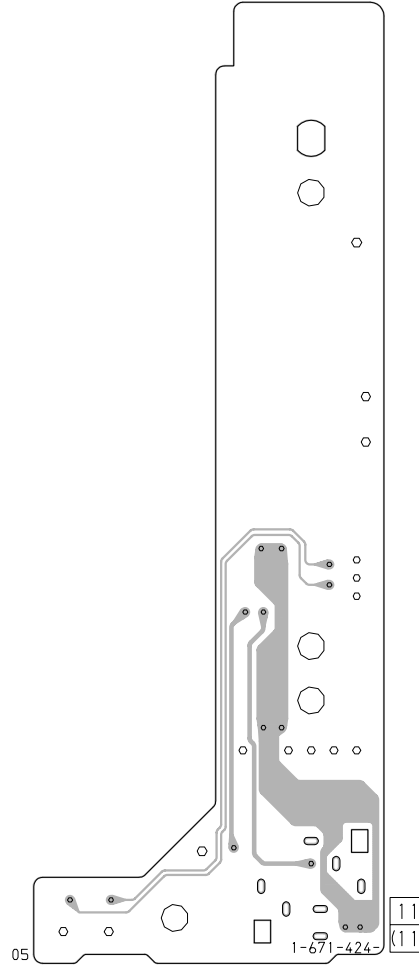
【AMP BOARD】(SIDE A)



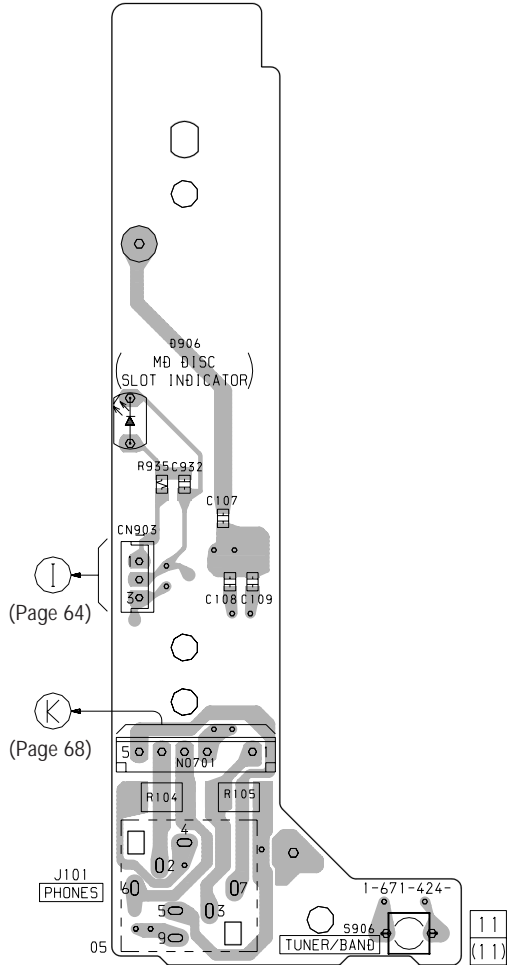
【AMP BOARD】(SIDE B)



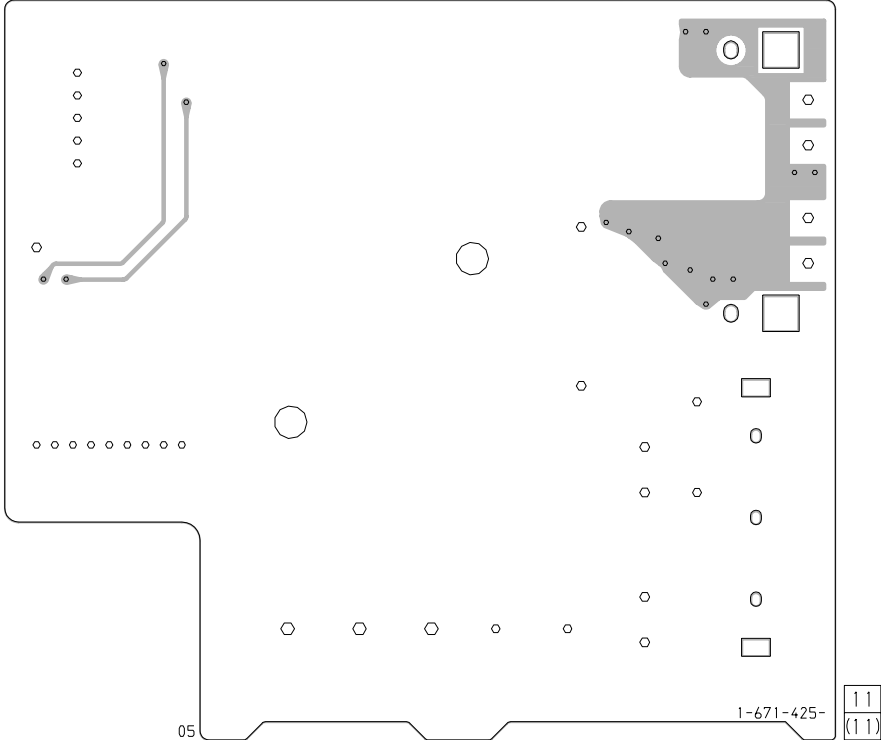
【HP BOARD】(SIDE A)



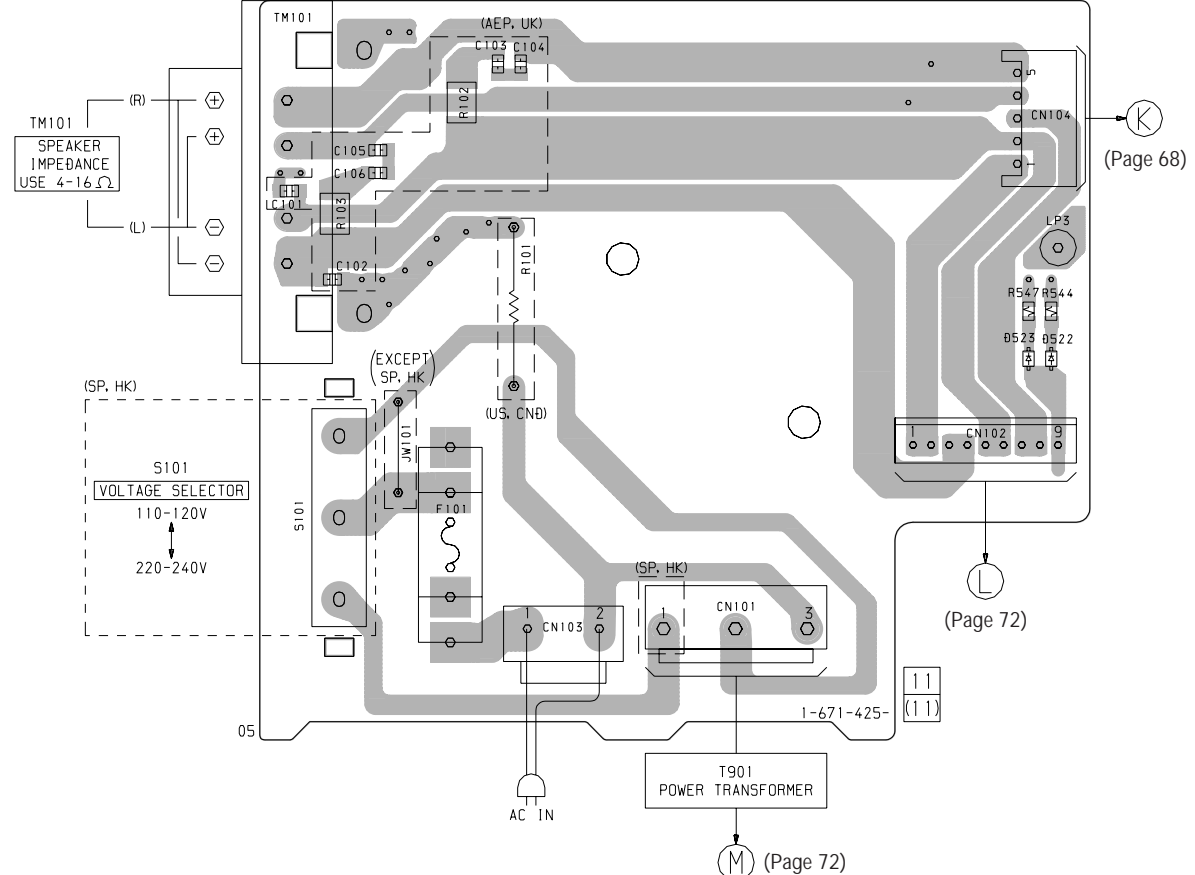
【HP BOARD】(SIDE B)



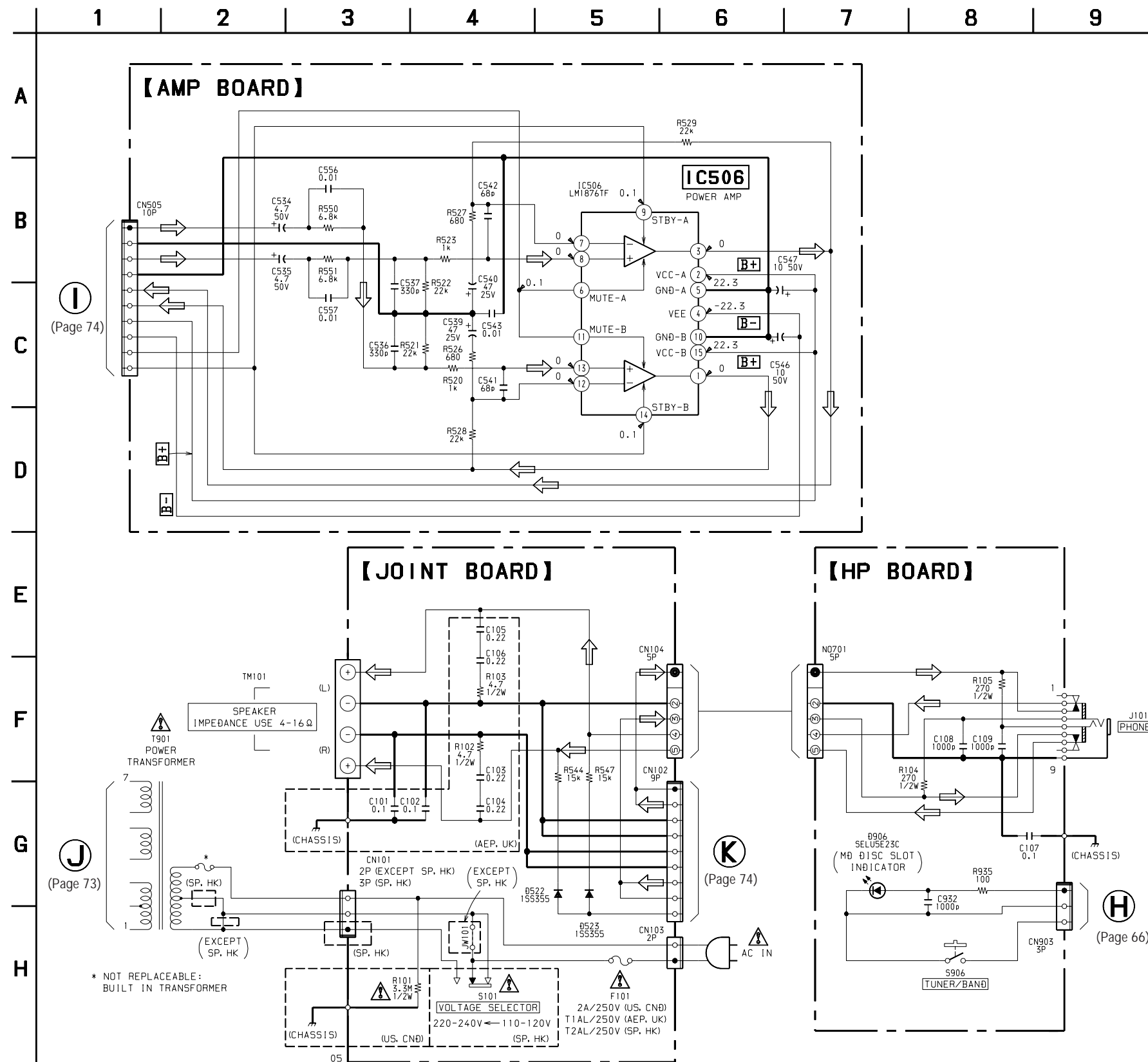
【JOINT BOARD】(SIDE A)



【JOINT BOARD】(SIDE B)



7-19. SCHEMATIC DIAGRAM – AMP/TRANSFORMER Section –

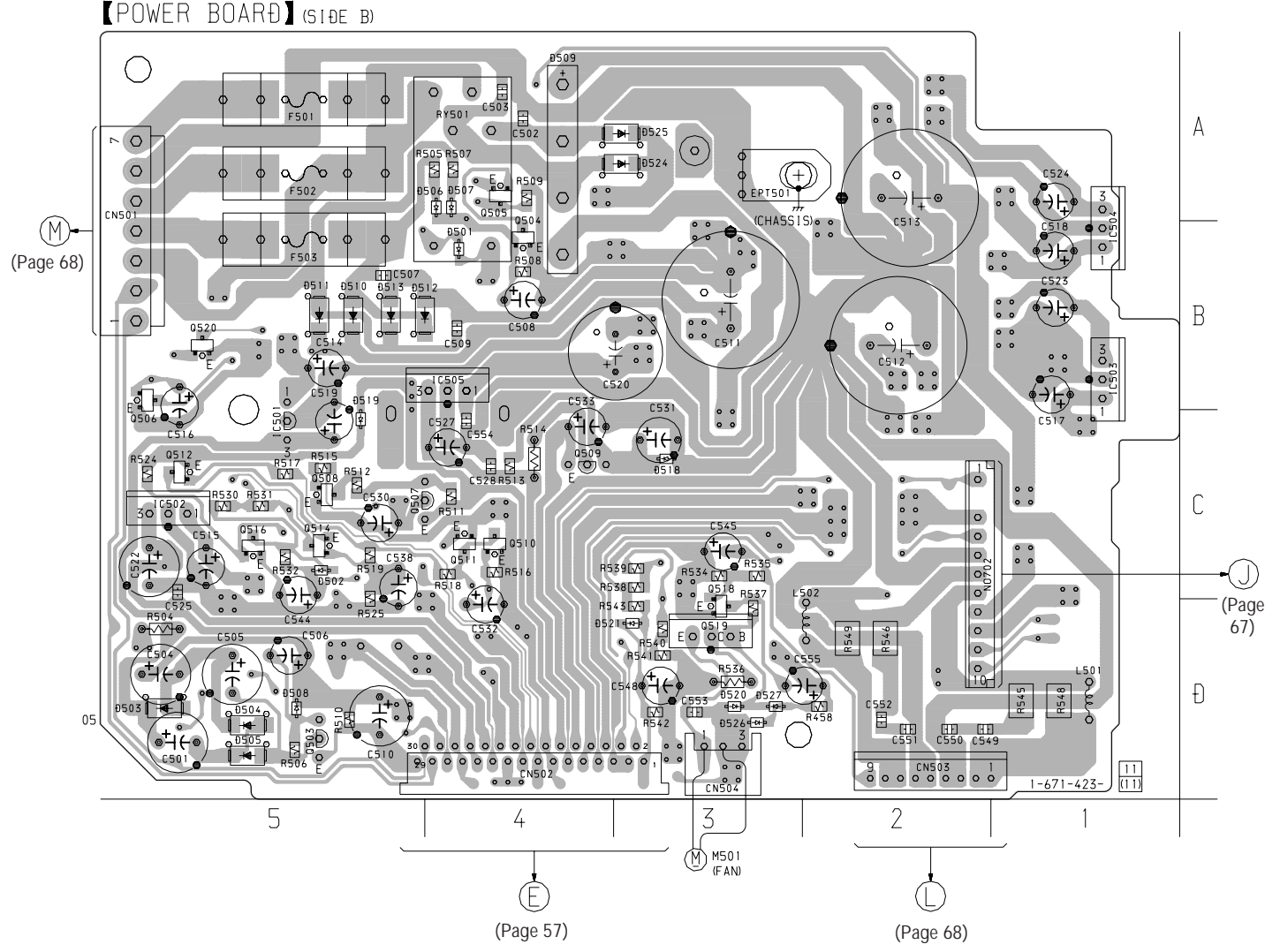
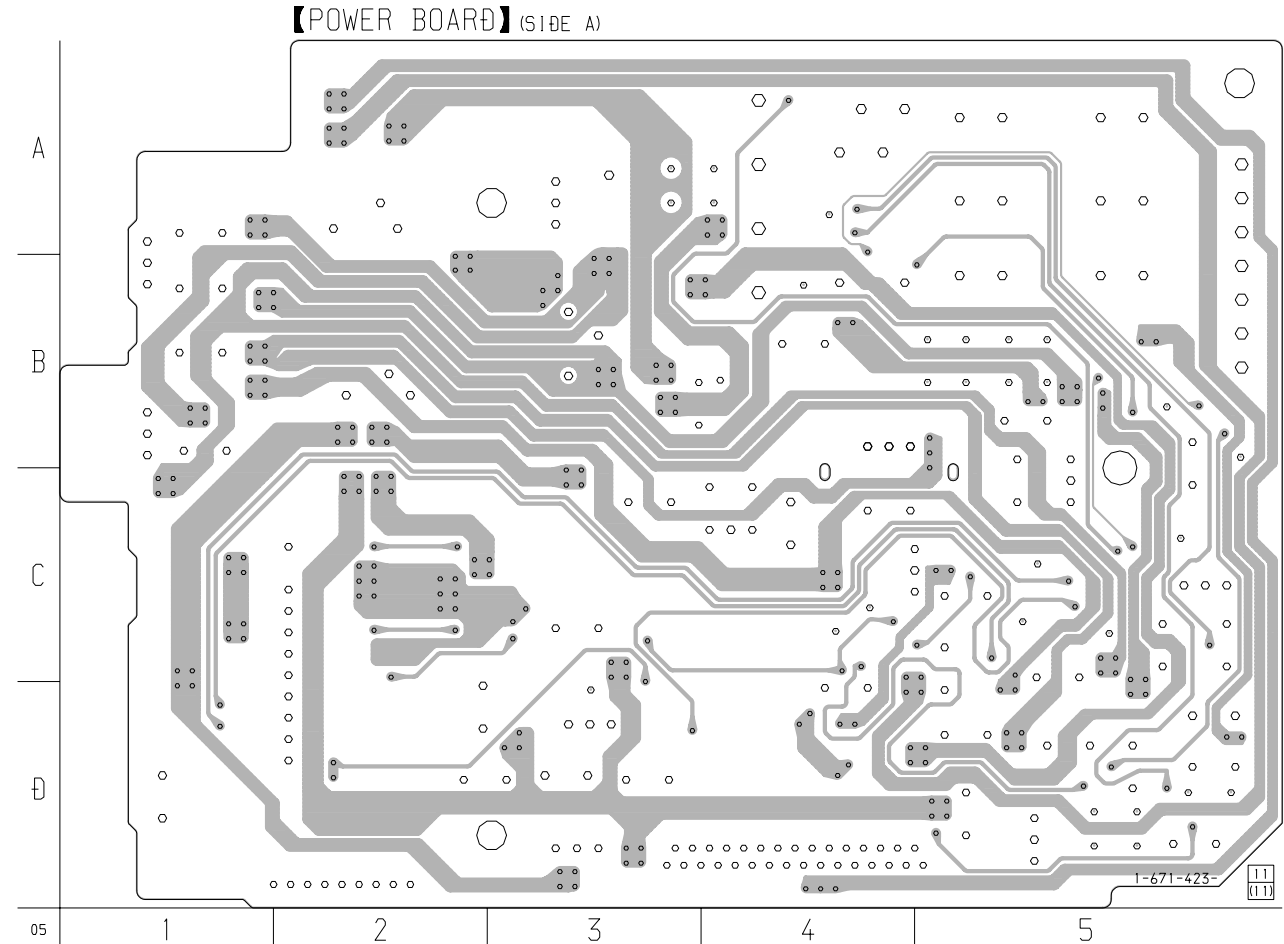


• Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions.
no mark : FM

The components identified by mark \triangle or dotted line with mark \triangle are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque \triangle sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

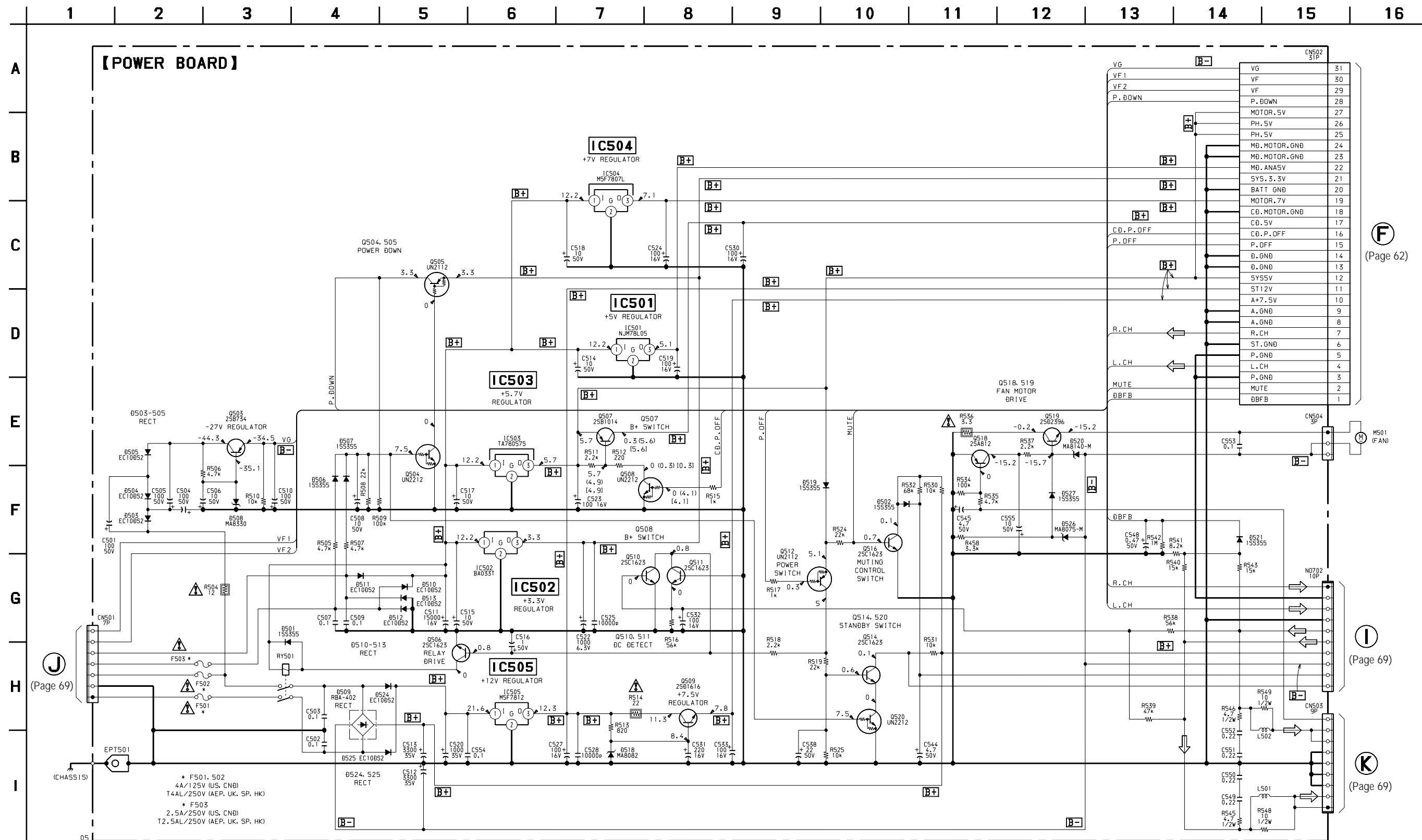
7-20. PRINTED WIRING BOARD – POWER Section – • See page 41 Circuit Boards Location.



• Semiconductor Location

Ref. No.	Location	Ref. No.	Location
D501	B-4	IC501	C-5
D502	C-5	IC502	C-5
D503	D-5	IC503	B-1
D504	D-5	IC504	B-1
D505	D-5	IC505	B-4
D506	A-4		
D507	A-4	Q503	D-5
D508	D-5	Q504	B-4
D509	A-4	Q505	A-4
D510	B-5	Q506	B-5
D511	B-5	Q507	C-5
D512	B-5	Q508	C-5
D513	B-5	Q509	C-4
D518	C-3	Q510	C-4
D519	C-5	Q511	C-4
D520	D-3	Q512	C-5
D521	D-3	Q514	C-5
D524	A-3	Q516	C-5
D525	A-3	Q518	D-3
D526	D-3	Q519	D-3
D527	D-3	Q520	B-5

7-21. SCHEMATIC DIAGRAM – POWER Section –



(Page 62)

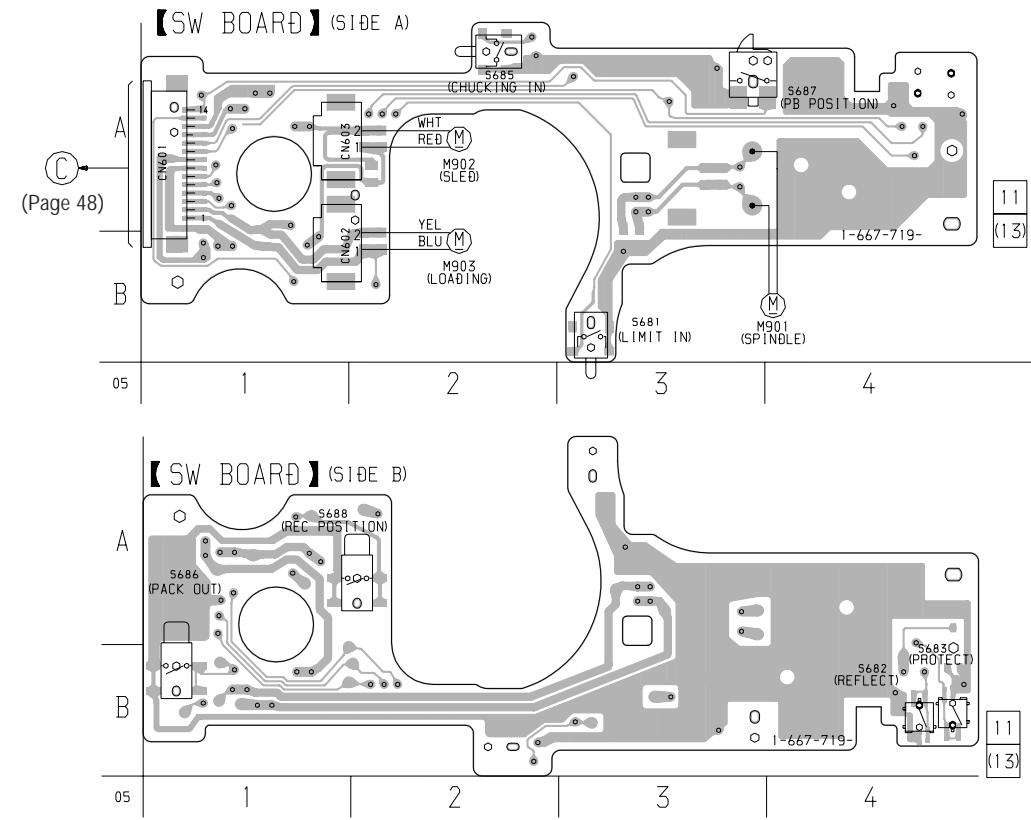
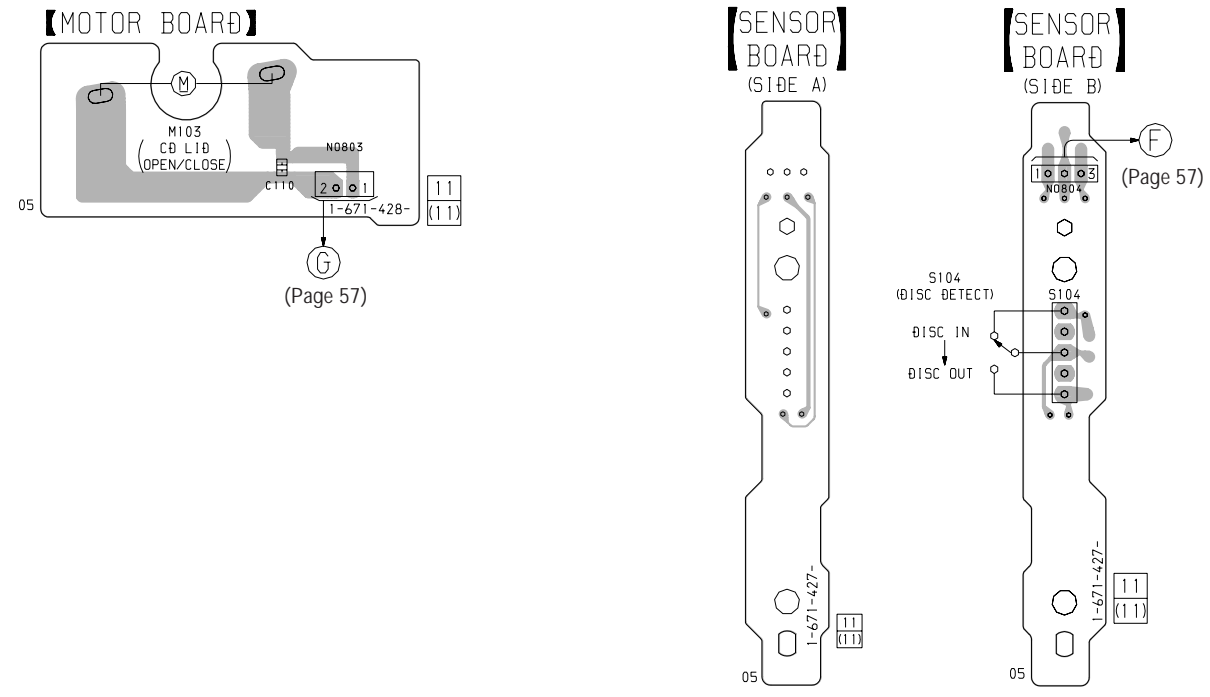
(Page 69)

(Page 69)

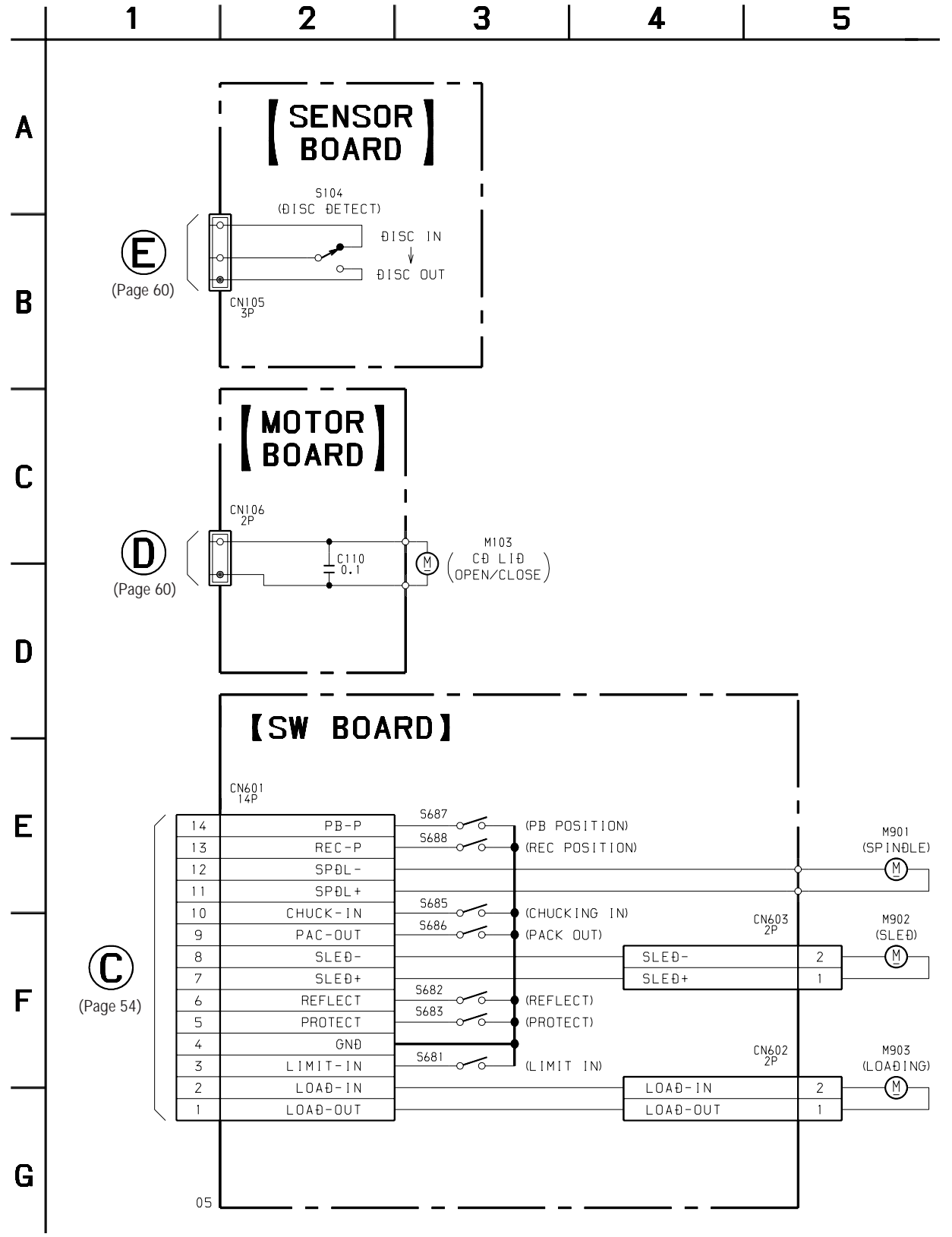
• Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions.
 no mark : FM
 [] : CD PLAY
 () : MD PLAY

The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.
 Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

7-22. PRINTED WIRING BOARDS – MOTOR/SW Section –



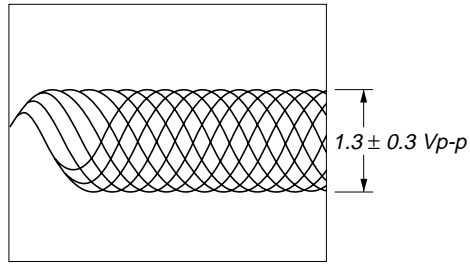
7-23. SCHEMATIC DIAGRAM – MOTOR/SW Section –



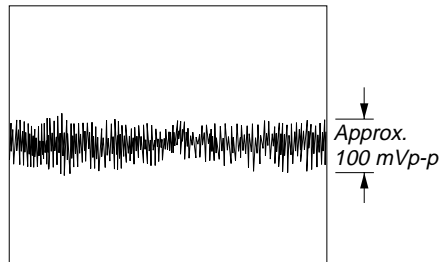
• Waveforms

– BD (CD) Board –

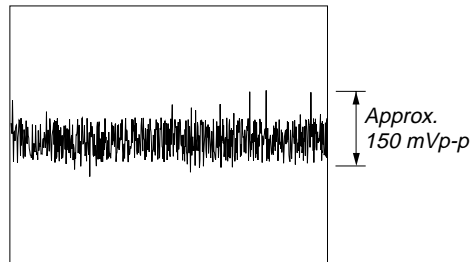
1 IC101 ⑳ (RFO) (CD Play Mode)
500 mV/DIV, 500 ns/DIV



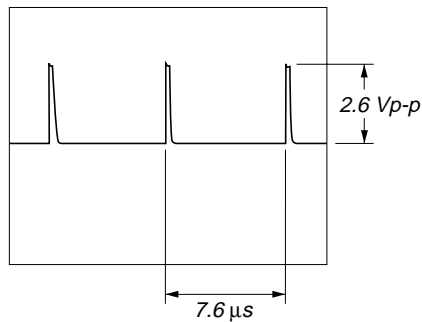
2 IC101 ㉔ (TEI) (CD Play Mode)
50 mV/DIV, 1 μs/DIV



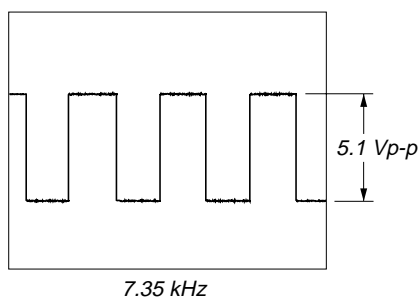
3 IC101 ㉒ (FEI) (CD Play Mode)
50 mV/DIV, 1 μs/DIV



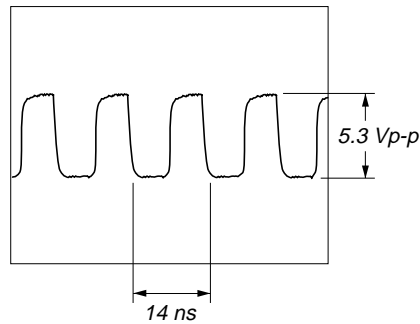
4 IC103 ③ (MDP) (CD Play Mode)



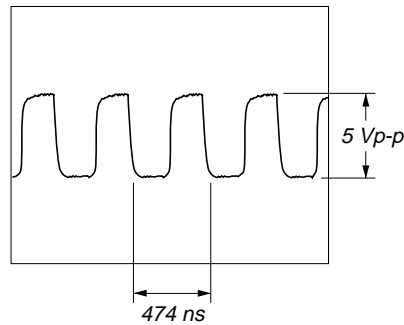
5 IC103 ㉞ (RFCK)



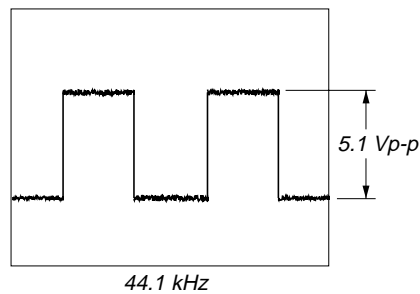
6 IC103 ㉞ (XPCK)



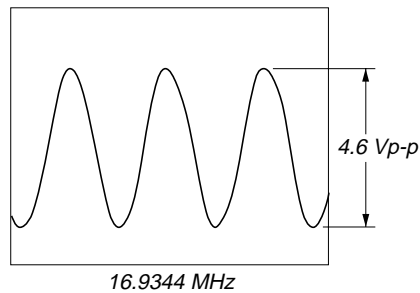
7 IC103 ㉒ (BCLK)



8 IC103 ㉒ (LRCK)

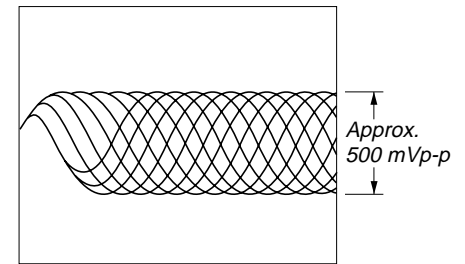


9 IC104 ⑥ (XTO)

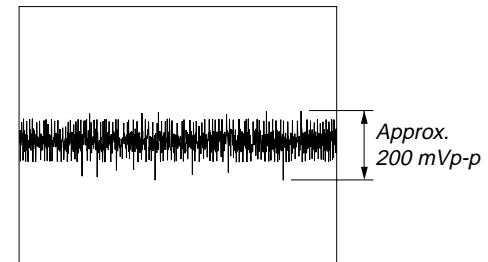


– BD (MD) Board –

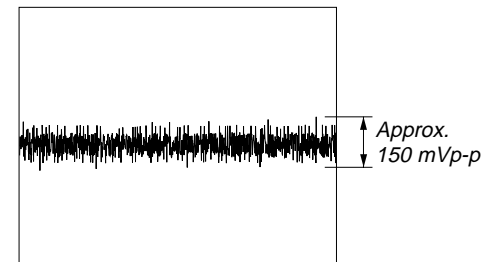
1 IC101 ①, ② (I, J) (MD Play Mode)



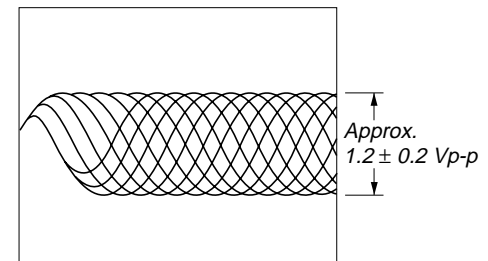
2 IC101 ④ (A) (MD Play Mode)



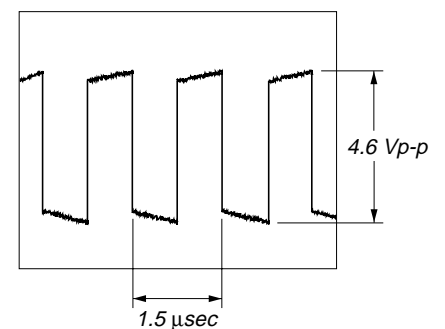
3 IC101 ⑧, ⑨ (E, F) (MD Play Mode)



4 IC101 ㉞ (RF) (MD Play Mode)

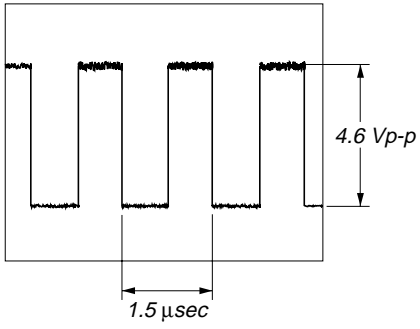


5 IC152 ㉞ (CAPA-) (MD Play Mode)

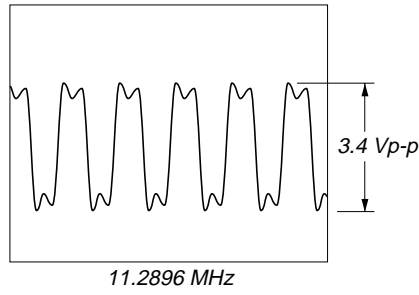


– MAIN Board –

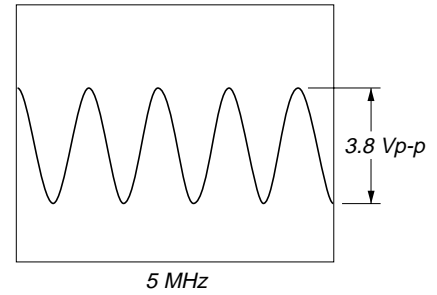
6 IC152 ⑳ (CAPA+) (MD Play Mode)



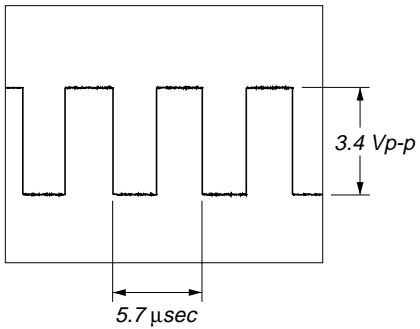
11 IC121 ㉗ (FS256)



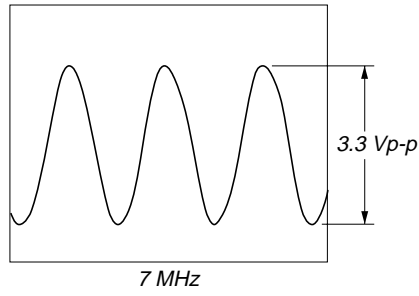
1 IC707 ① (X1)



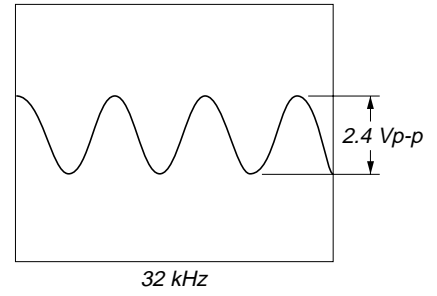
7 IC121 ㉗ (FS4)



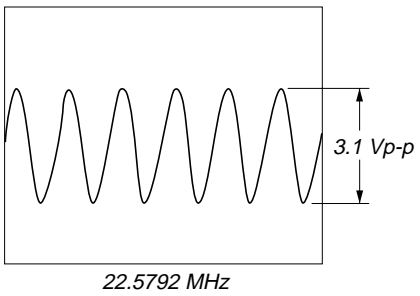
12 IC316 ⑬ (XOUT)



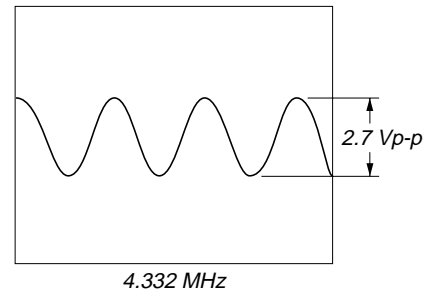
2 IC707 ② (XT1)



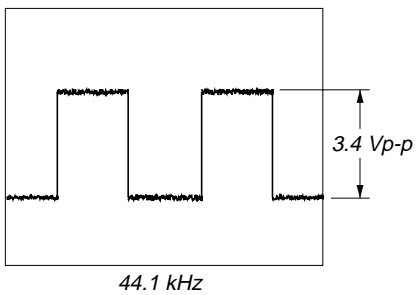
8 IC121 ⑰ (OSCO)



3 IC710 ⑬

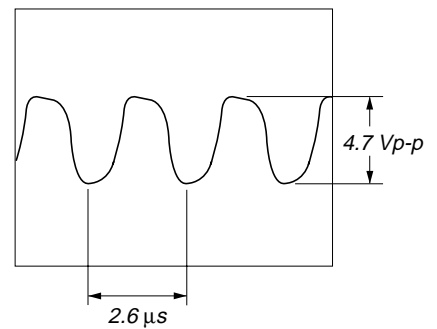


9 IC121 ㉕ (LRCK)

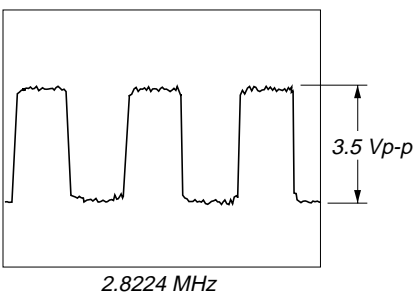


– PANEL Board –

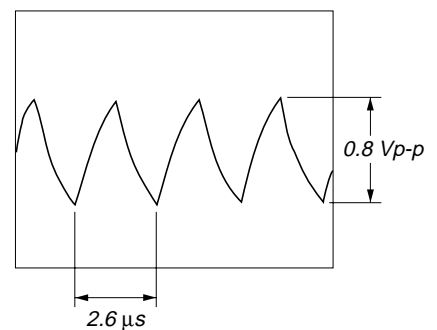
1 IC901 ㉔ (XOUT)



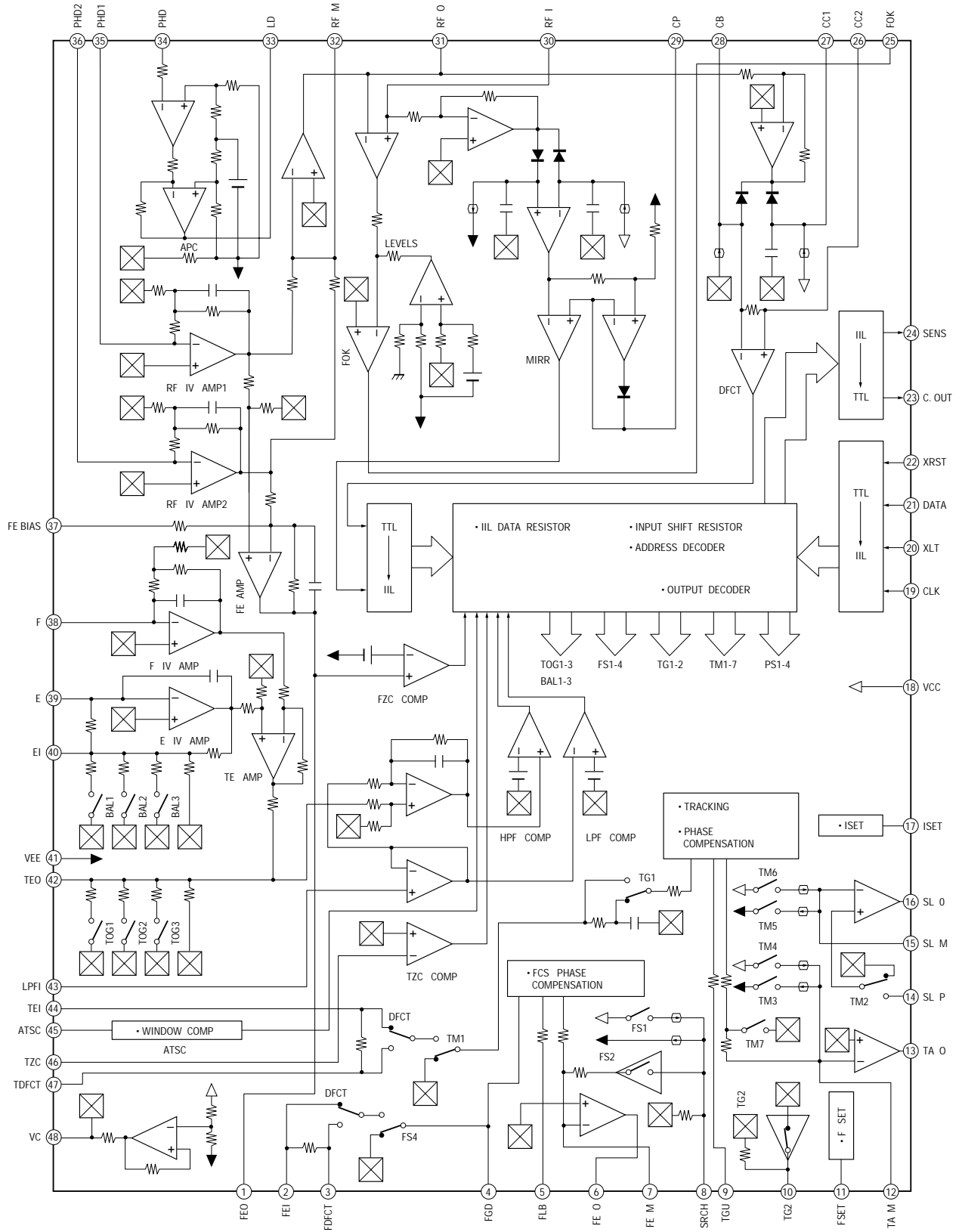
10 IC121 ㉖ (XBCK)



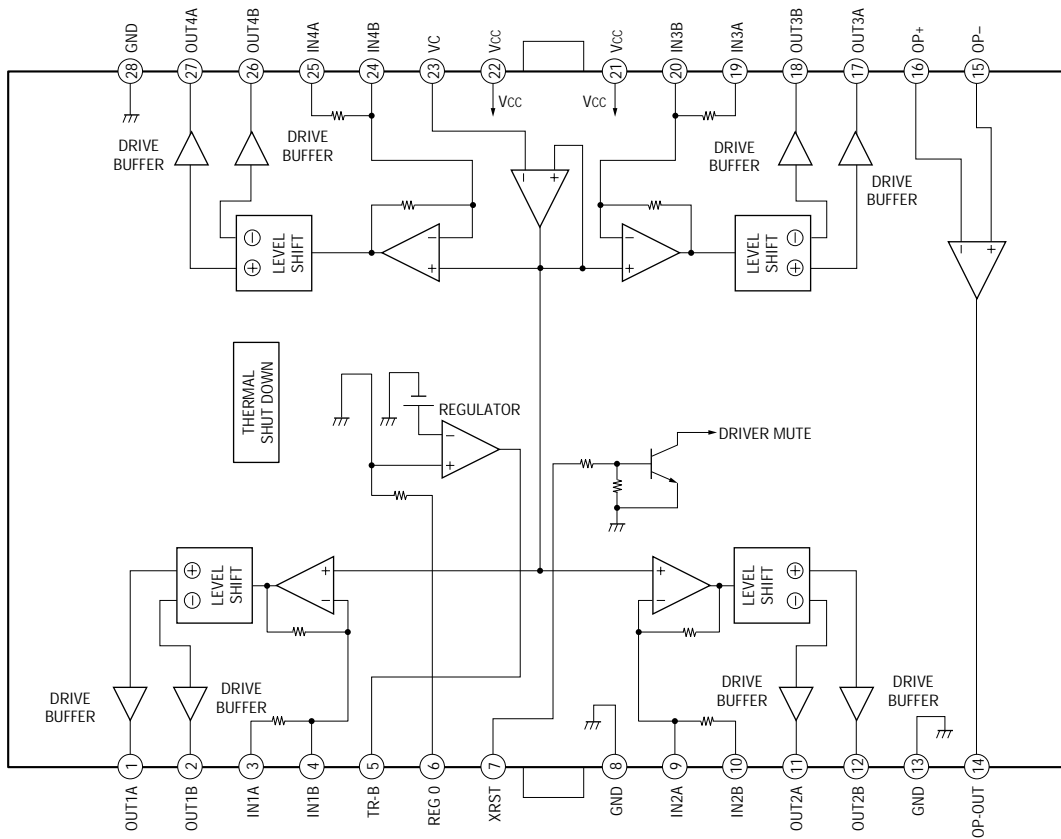
2 IC901 ㉔ (XIN)



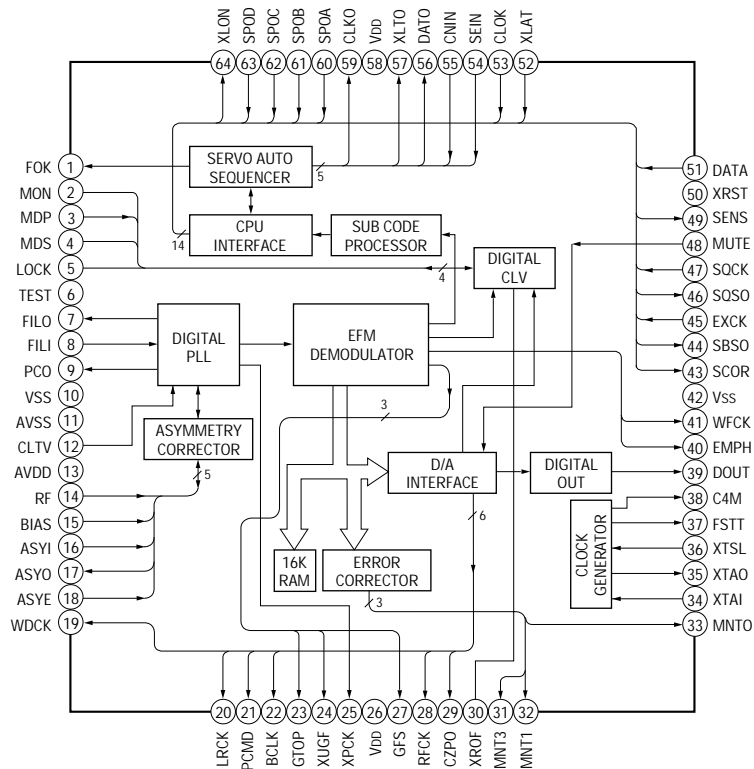
• IC Block Diagrams
 – BD (CD) Board –
 IC101 CXA1782BQ



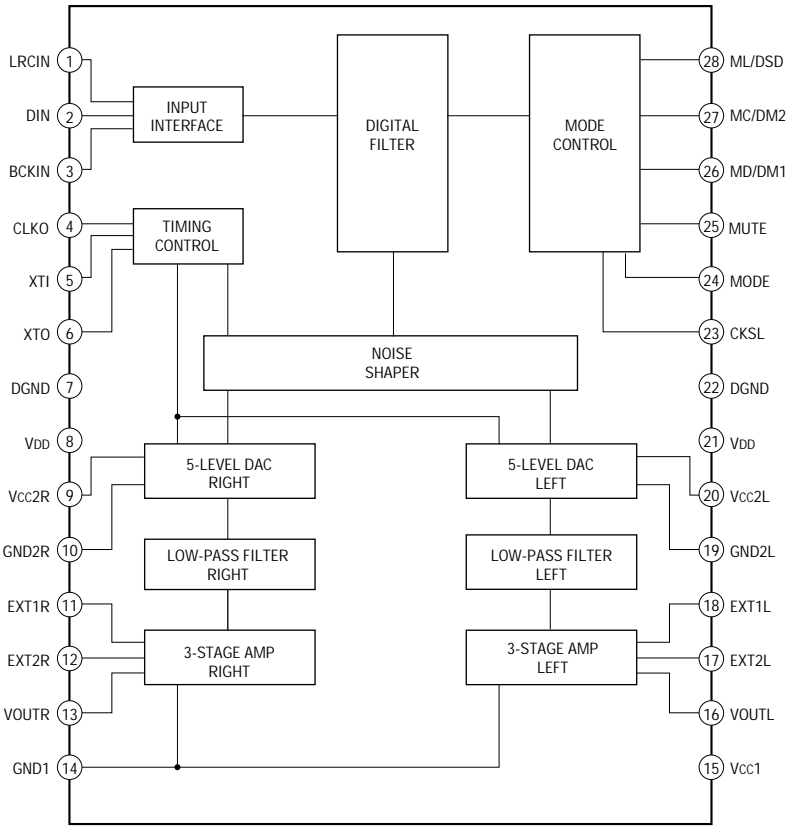
IC102 BA6397FP



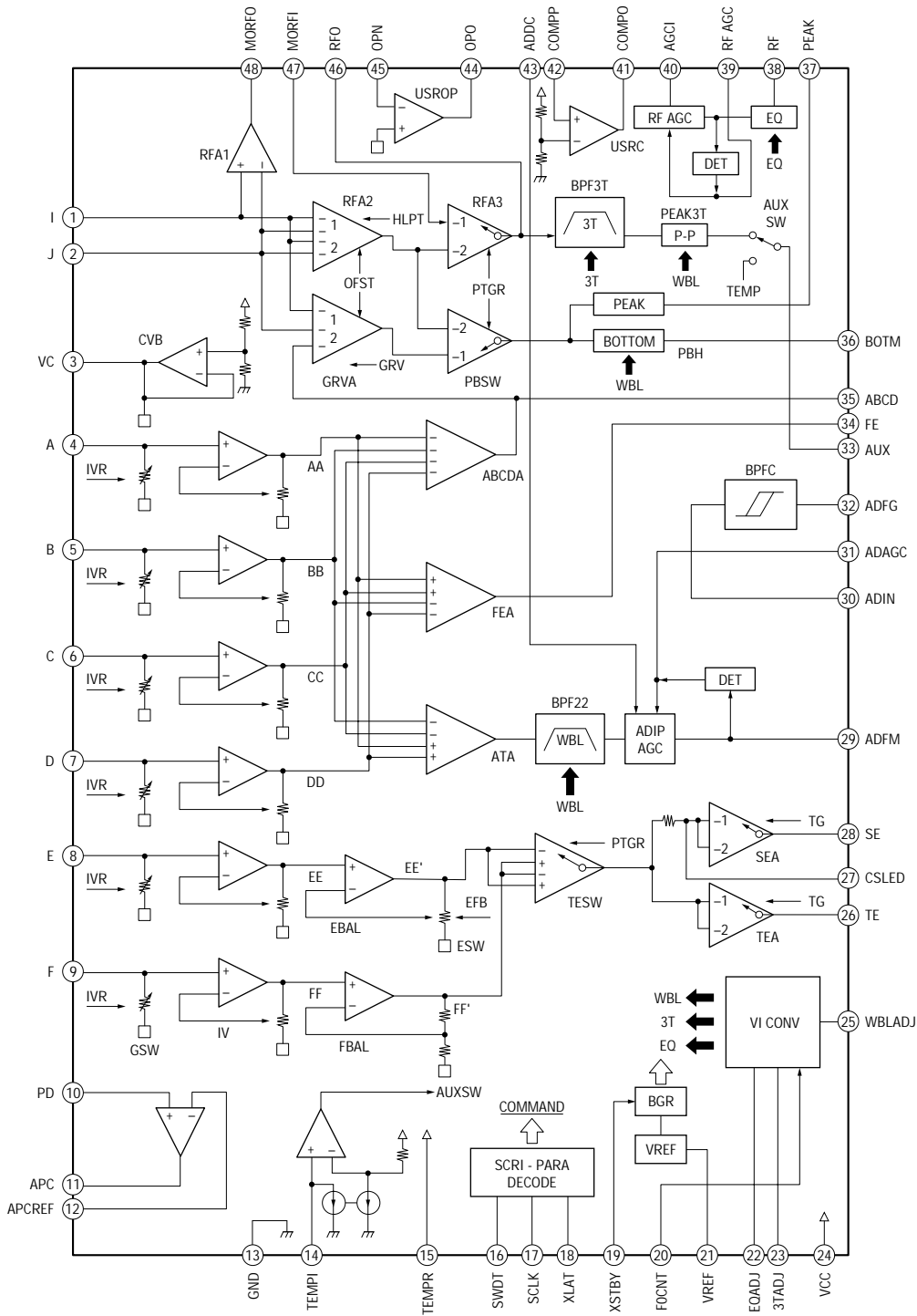
IC103 CXD2507AQ



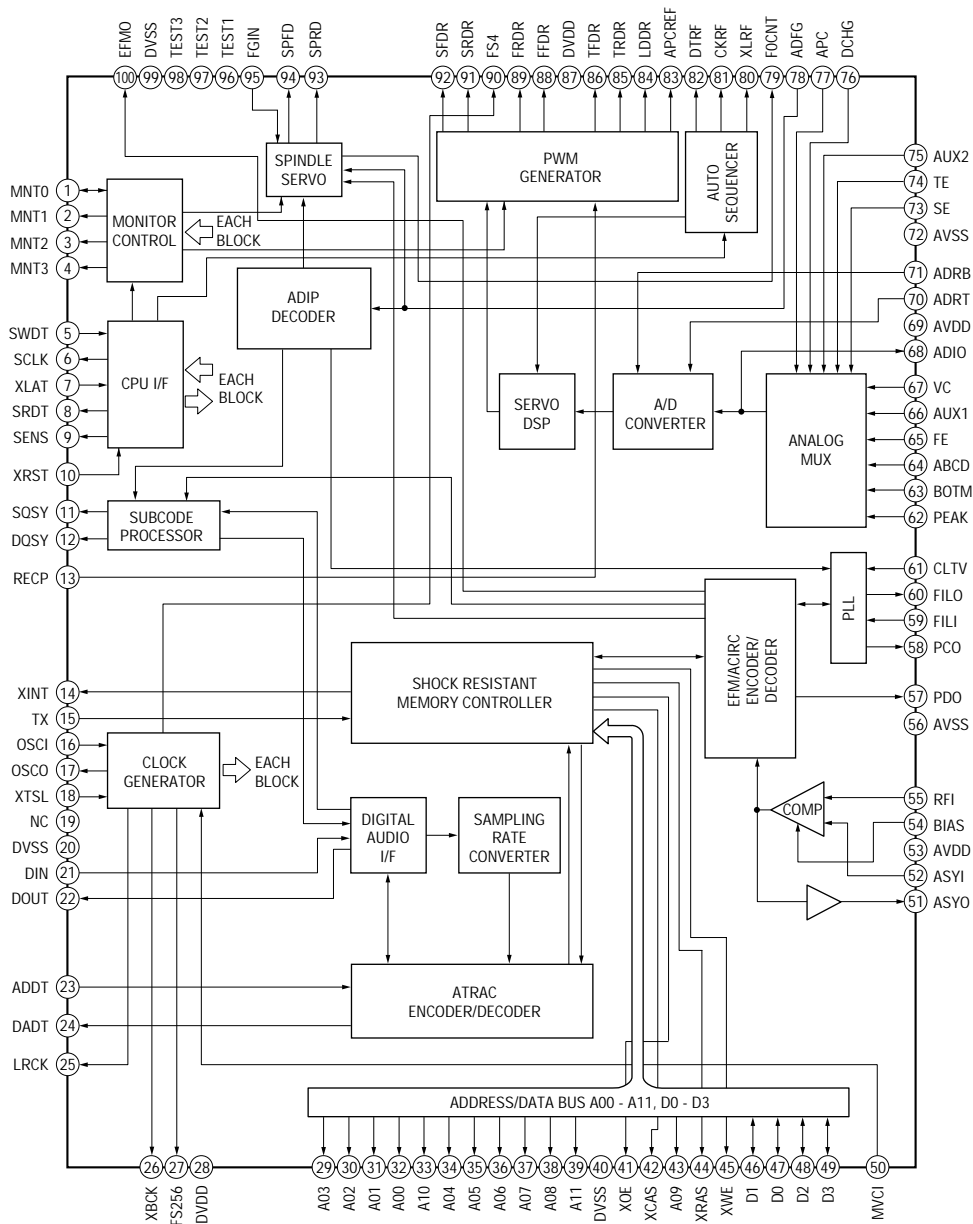
IC104 PCM1710U-B



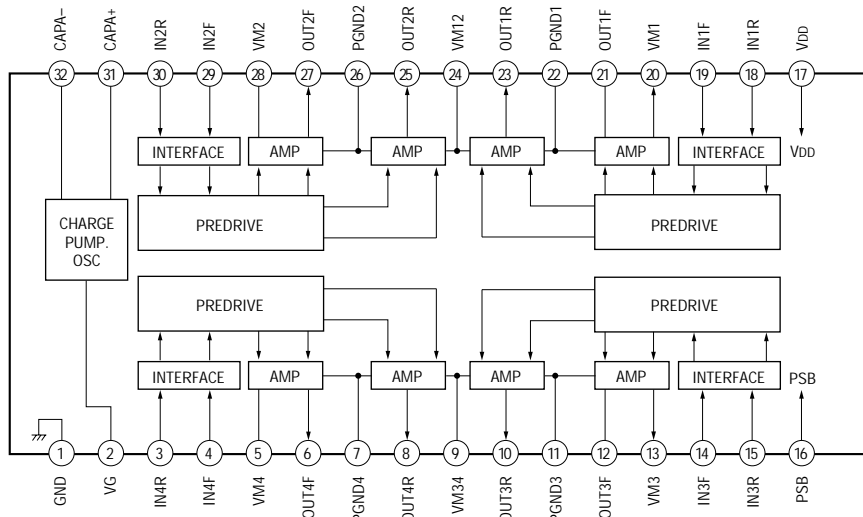
– BD (MD) Board –
 IC101 CXA2523AR



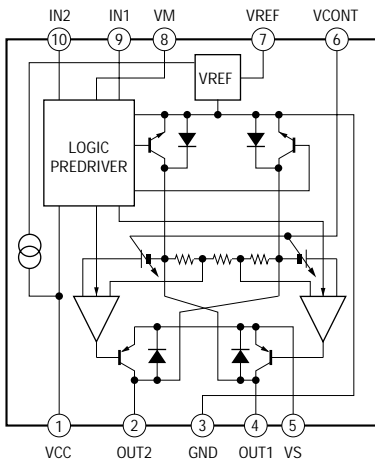
IC121 CXD2652AR



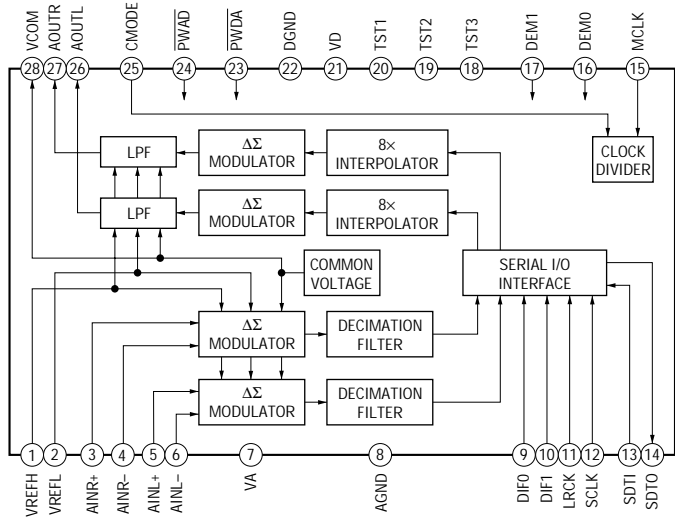
IC152 BH6511FS-E2



IC153 LB1830M-S-TE-L

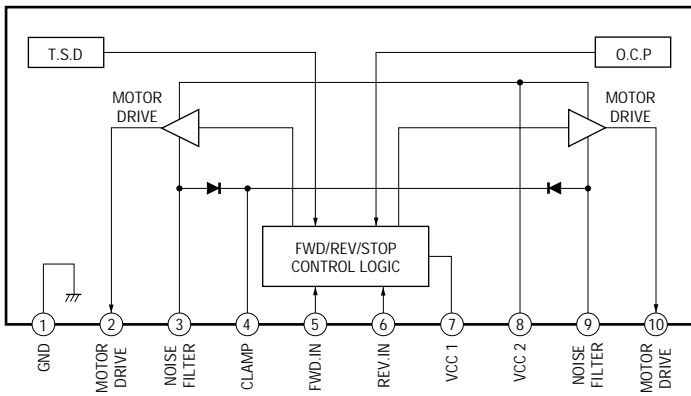


IC201 AK4520A-VF-E2

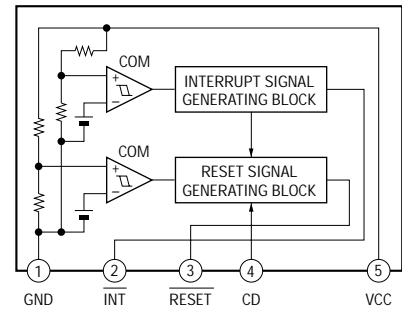


– MAIN Board –

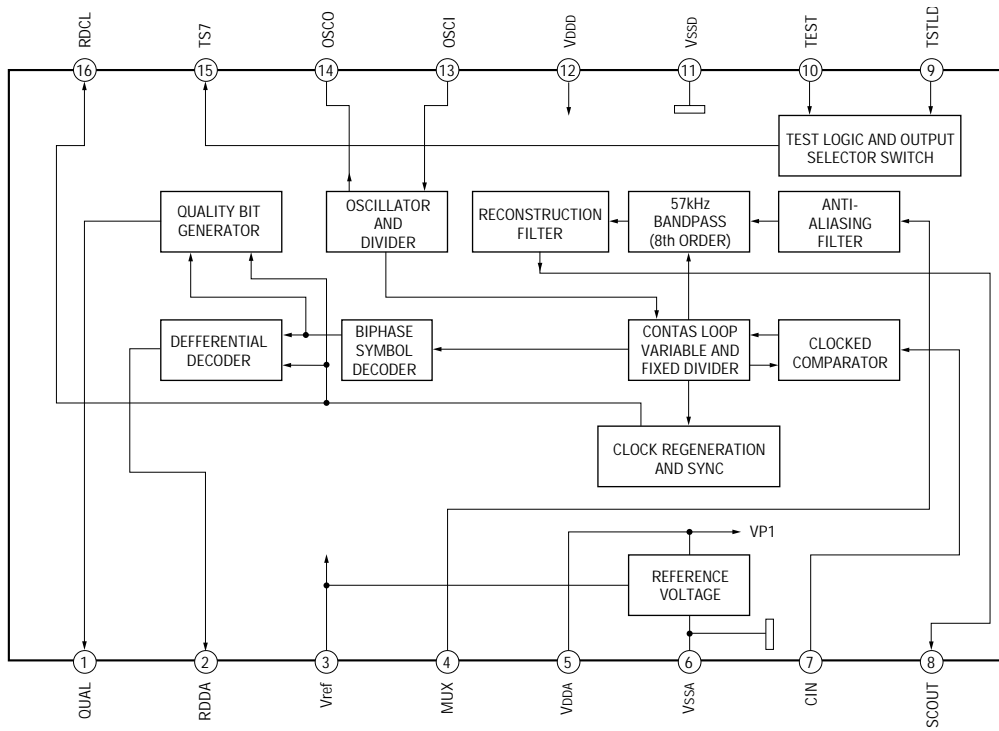
IC702 LB1641



IC706 M62016L

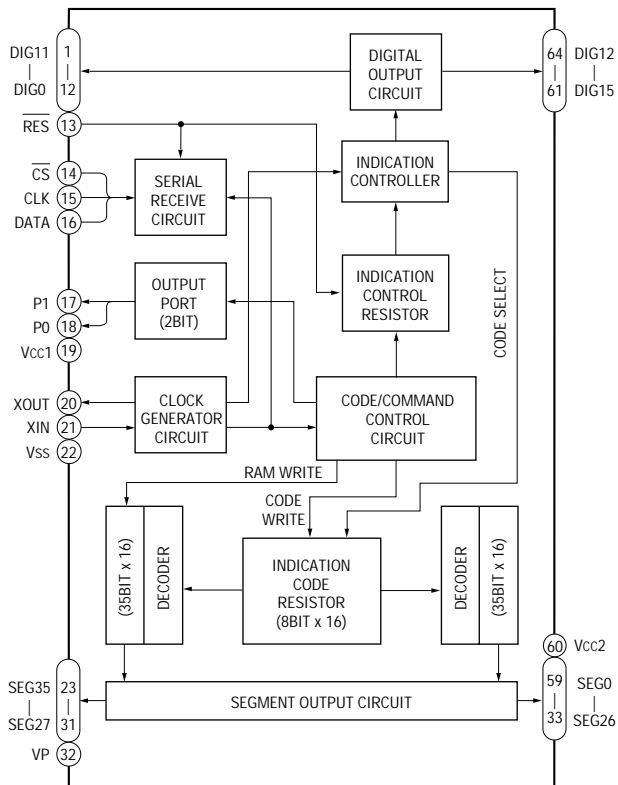


IC710 BU1922-E2 (AEP, UK)



- PANEL Board -

IC901 M66004M8FP



7-24. IC PIN FUNCTION DESCRIPTION

• BD (MD) BOARD IC101 CXA2523AR (RF AMP, FOCUS/TRACKING ERROR AMP)

Pin No.	Pin Name	I/O	Function
1	I	I	I-V converted RF signal I input from the optical pick-up block detector
2	J	I	I-V converted RF signal J input from the optical pick-up block detector
3	VC	O	Middle point voltage (+1.65V) generation output terminal
4 to 9	A to F	I	Signal input from the optical pick-up detector
10	PD	I	Light amount monitor input from the optical pick-up block laser diode
11	APC	O	Laser amplifier output terminal to the automatic power control circuit
12	APCREF	I	Reference voltage input terminal for setting laser power
13	GND	—	Ground terminal
14	TEMPI	I	Connected to the temperature sensor
15	TEMPR	O	Output terminal for a temperature sensor reference voltage
16	SWDT	I	Writing serial data input from the CXD2652AR (IC121)
17	SCLK	I	Serial data transfer clock signal input from the CXD2652AR (IC121)
18	XLAT	I	Serial data latch pulse signal input from the CXD2652AR (IC121)
19	$\overline{\text{XSTBY}}$	I	Standby signal input terminal “L”: standby (fixed at “H” in this set)
20	F0CNT	I	Center frequency control voltage input terminal of internal circuit (BPF22, BPF3T, EQ) input from the CXD2652AR (IC121)
21	VREF	O	Reference voltage output terminal Not used (open)
22	EQADJ	I	Center frequency setting terminal for the internal circuit (EQ)
23	3TADJ	I	Center frequency setting terminal for the internal circuit (BPF3T)
24	VCC	—	Power supply terminal (+3.3V)
25	WBLADJ	I	Center frequency setting terminal for the internal circuit (BPF22)
26	TE	O	Tracking error signal output to the CXD2652AR (IC121)
27	CSLED	I	Connected to the external capacitor for low-pass filter of the sled error signal
28	SE	O	Sled error signal output to the CXD2652AR (IC121)
29	ADFM	O	FM signal output of the ADIP
30	ADIN	I	Receives a ADIP FM signal in AC coupling
31	ADAGC	I	Connected to the external capacitor for ADIP AGC
32	ADFG	O	ADIP duplex signal (22.05 kHz \pm 1 kHz) output to the CXD2652AR (IC121)
33	AUX	O	Auxiliary signal (Is signal/temperature signal) output to the CXD2652AR (IC121)
34	FE	O	Focus error signal output to the CXD2652AR (IC121)
35	ABCD	O	Light amount signal (ABCD) output to the CXD2652AR (IC121)
36	BOTM	O	Light amount signal (RF/ABCD) bottom hold output to the CXD2652AR (IC121)
37	PEAK	O	Light amount signal (RF/ABCD) peak hold output to the CXD2652AR (IC121)
38	RF	O	Playback EFM RF signal output to the CXD2652AR (IC121)
39	RFAGC	I	Connected to the external capacitor for RF auto gain control circuit
40	AGCI	I	Receives a RF signal in AC coupling
41	COMPO	O	User comparator output terminal Not used (open)
42	COMPP	I	User comparator input terminal Not used (fixed at “L”)
43	ADDC	I	Connected to the external capacitor for cutting the low band of the ADIP amplifier
44	OPO	O	User operational amplifier output terminal Not used (open)
45	OPN	I	User operational amplifier inversion input terminal Not used (fixed at “L”)
46	RFO	O	RF signal output terminal
47	MORFI	I	Receives a MO RF signal in AC coupling
48	MORFO	O	MO RF signal output terminal

• **BD (MD) BOARD IC121 CXD2652AR**
(DIGITAL SIGNAL PROCESSOR, DIGITAL SERVO PROCESSOR, EFM/ACIRC ENCODER/DECODER,
SHOCK PROOF MEMORY CONTROLLER, ATRAC ENCODER/DECODER, 2M BIT D-RAM)

Pin No.	Pin Name	I/O	Function
1	MNT0 (FOK)	O	Focus OK signal output to the MD mechanism controller (IC316) “H” is output when focus is on (“L”: NG)
2	MNT1 (SHCK)	O	Track jump detection signal output to the MD mechanism controller (IC316)
3	MNT2 (XBUSY)	O	Busy signal output to the MD mechanism controller (IC316)
4	MNT3 (SLOC)	O	Spindle servo lock status monitor signal output to the MD mechanism controller (IC316)
5	SWDT	I	Writing serial data signal input from the MD mechanism controller (IC316)
6	SCLK	I	Serial data transfer clock signal input from the MD mechanism controller (IC316)
7	XLAT	I	Serial data latch pulse signal input from the MD mechanism controller (IC316)
8	SRDT	O (3)	Reading serial data signal output to the MD mechanism controller (IC316)
9	SENS	O (3)	Internal status (SENSE) output to the MD mechanism controller (IC316)
10	$\overline{\text{XRST}}$	I	Reset signal input from the MD mechanism controller (IC316) “L”: reset
11	SQSY	O	Subcode Q sync (SCOR) output to the MD mechanism controller (IC316) “L” is output every 13.3 msec Almost all, “H” is output
12	DQSY	O	Digital In U-bit CD format subcode Q sync (SCOR) output to the MD mechanism controller (IC316) “L” is output every 13.3 msec Almost all, “H” is output
13	RECP	I	Laser power selection signal input from the MD mechanism controller (IC316) “H”: recording mode, “L”: playback mode
14	XINT	O	Interrupt status output to the MD mechanism controller (IC316)
15	TX	I	Recording data output enable signal input from the MD mechanism controller (IC316) Writing data transmission timing input (Also serves as the magnetic head on/off output)
16	OSCI	I	System clock signal (512Fs=22.5792 MHz) input terminal
17	OSCO	O	System clock signal (512Fs=22.5792 MHz) output terminal
18	XTSL	I	Input terminal for the system clock frequency setting “L”: 45.1584 MHz, “H”: 22.5792 MHz (fixed at “H” in this set)
19	RVDD	—	Power supply terminal (+3.3V) (digital system)
20	RVSS	—	Ground terminal (digital system)
21	DIN	I	Digital audio signal input terminal when recording mode (for digital in)
22	DOUT	O	Digital audio signal output terminal when playback mode (for digital out) Not used
23	ADDT	I	Recording data input from the A/D, D/A converter (IC201)
24	DADT	O	Playback data output to the A/D, D/A converter (IC201)
25	LRCK	O	L/R sampling clock signal (44.1 kHz) output to the A/D, D/A converter (IC201)
26	XBCK	O	Bit clock signal (2.8224 MHz) output to the A/D, D/A converter (IC201)
27	FS256	O	Clock signal (11.2896 MHz) output to the A/D, D/A converter (IC201)
28	DVDD	—	Power supply terminal (+3.3V) (digital system)
29 to 32	A03 to A00	O	Address signal output to the D-RAM (IC124)
33	A10	O	Address signal output to the external D-RAM Not used (open)
34 to 38	A04 to A08	O	Address signal output to the D-RAM (IC124)
39	A11	O	Address signal output to the external D-RAM Not used (open)
40	DVSS	—	Ground terminal (digital system)
41	$\overline{\text{XOE}}$	O	Output enable signal output to the D-RAM (IC124) “L” active
42	$\overline{\text{XCAS}}$	O	Column address strobe signal output to the D-RAM (IC124) “L” active
43	A09	O	Address signal output to the D-RAM (IC124)
44	$\overline{\text{XRAS}}$	O	Row address strobe signal output to the D-RAM (IC124) “L” active
45	$\overline{\text{XWE}}$	O	Write enable signal output to the D-RAM (IC124) “L” active
46	D1	I/O	Two-way data bus with the D-RAM (IC124)

* I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

Pin No.	Pin Name	I/O	Function
47	D0	I/O	Two-way data bus with the D-RAM (IC124)
48	D2	I/O	
49	D3	I/O	
50	MVCI	I	Digital in PLL oscillation input from the external VCO Not used (fixed at "L")
51	ASYO	O	Playback EFM full-swing output terminal
52	ASYI	I (A)	Playback EFM asymmetry comparator voltage input terminal
53	AVDD	—	Power supply terminal (+3.3V) (analog system)
54	BIAS	I (A)	Playback EFM asymmetry circuit constant current input terminal
55	RFI	I (A)	Playback EFM RF signal input from the CXA2523AR (IC101)
56	AVSS	—	Ground terminal (analog system)
57	PDO	O (3)	Phase comparison output for clock playback analog PLL of the playback EFM Not used (open)
58	PCO	O (3)	Phase comparison output for master clock of the recording/playback EFM master PLL
59	FILI	I (A)	Filter input for master clock of the recording/playback master PLL
60	FILO	O (A)	Filter output for master clock of the recording/playback master PLL
61	CLTV	I (A)	Internal VCO control voltage input of the recording/playback master PLL
62	PEAK	I (A)	Light amount signal (RF/ABCD) peak hold input from the CXA2523AR (IC101)
63	BOTM	I (A)	Light amount signal (RF/ABCD) bottom hold input from the CXA2523AR (IC101)
64	ABCD	I (A)	Light amount signal (ABCD) input from the CXA2523AR (IC101)
65	FE	I (A)	Focus error signal input from the CXA2523AR (IC101)
66	AUX1	I (A)	Auxiliary signal (I ₃ signal/temperature signal) input from the CXA2523AR (IC101)
67	VC	I (A)	Middle point voltage (+1.65V) input from the CXA2523AR (IC101)
68	ADIO	O (A)	Monitor output of the A/D converter input signal Not used (open)
69	AVDD	—	Power supply terminal (+3.3V) (analog system)
70	ADRT	I (A)	A/D converter operational range upper limit voltage input terminal (fixed at "H" in this set)
71	ADRB	I (A)	A/D converter operational range lower limit voltage input terminal (fixed at "L" in this set)
72	AVSS	—	Ground terminal (analog system)
73	SE	I (A)	Sled error signal input from the CXA2523AR (IC101)
74	TE	I (A)	Tracking error signal input from the CXA2523AR (IC101)
75	AUX2	I (A)	Auxiliary signal input terminal Not used (fixed at "H")
76	DCHG	I (A)	Connected to the +3.3V power supply
77	APC	I (A)	Error signal input for the laser automatic power control Not used (fixed at "H")
78	ADFG	I	ADIP duplex FM signal (22.05 kHz ± 1 kHz) input from the CXA2523AR (IC101)
79	F0CNT	O	Filter f0 control signal output to the CXA2523AR (IC101)
80	XLRF	O	Serial data latch pulse signal output to the CXA2523AR (IC101)
81	CKRF	O	Serial data transfer clock signal output to the CXA2523AR (IC101)
82	DTRF	O	Writing serial data output to the CXA2523AR (IC101)
83	APCREF	O	Control signal output to the reference voltage generator circuit for the laser automatic power control
84	LDDR	O	PWM signal output for the laser automatic power control Not used (open)
85	TRDR	O	Tracking servo drive PWM signal (–) output to the BH6511FS (IC152)
86	TFDR	O	Tracking servo drive PWM signal (+) output to the BH6511FS (IC152)
87	DVDD	—	Power supply terminal (+3.3V) (digital system)
88	FFDR	O	Focus servo drive PWM signal (+) output to the BH6511FS (IC152)
89	FRDR	O	Focus servo drive PWM signal (–) output to the BH6511FS (IC152)
90	FS4	O	Clock signal (176.4 kHz) output terminal (X'tal system) Not used (open)
91	SRDR	O	Sled servo drive PWM signal (–) output to the BH6511FS (IC152)
92	SFDR	O	Sled servo drive PWM signal (+) output to the BH6511FS (IC152)

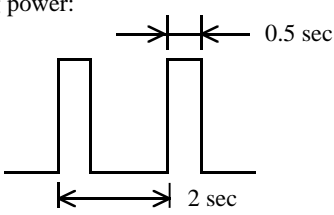
* I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

Pin No.	Pin Name	I/O	Function
93	SPRD	O	Spindle servo drive PWM signal (–) output to the BH6511FS (IC152)
94	SPFD	O	Spindle servo drive PWM signal (+) output to the BH6511FS (IC152)
95	FGIN	I	Input terminal for the test (fixed at “L”)
96	TEST1	I	
97	TEST2	I	
98	TEST3	I	
99	DVSS	—	Ground terminal (digital system)
100	EFMO	O	EFM signal output terminal when recording mode

* I (A) for analog input, O (3) for 3-state output, and O (A) for analog output in the column I/O.

• **BD (MD) BOARD IC316 M30610MCA-272FP (MD MECHANISM CONTROLLER)**

Pin No.	Pin Name	I/O	Function
1	JOG0	I	Rotary encoder jog dial pulse input terminal Not used (fixed at “H”)
2	JOG1	I	Rotary encoder jog dial pulse input terminal Not used (fixed at “H”)
3	DAOUT0	O	Monitor output terminal for the test C1 error rate is output when test mode
4	DAOUT1	O	Monitor output terminal for the test ADER is output when test mode
5	SQSY	I	Subcode Q sync (SCOR) input from the CXD2652AR (IC121) “L” is input every 13.3 msec Almost all, “H” is input
6	REMCN	I	Remote control signal input terminal Not used (fixed at “H”)
7	EMP	O	Emphasis control signal output to the A/D, D/A converter (IC201)
8	BYTE	I	External data bus line byte selection signal input “L”: 16 bit, “H”: 8 bit (fixed at “L”)
9	CNVSS	—	Ground terminal
10	XT-IN	I	Sub system clock input terminal Not used (fixed at “L”)
11	XT-OUT	O	Sub system clock output terminal Not used (pull down)
12	$\overline{\text{SYSTEM-RST}}$	I	System reset signal input from the reset signal generator (IC706) and master controller (IC707) “L”: reset For several hundreds msec. after the power supply rises, “L” is input, then it changes to “H”
13	XOUT	O	Main system clock output terminal (7 MHz)
14	GND	—	Ground terminal
15	XIN	I	Main system clock input terminal (7 MHz)
16	+3.3V	—	Power supply terminal (+3.3V)
17	$\overline{\text{NMI}}$	I	Non-maskable interrupt input terminal (fixed at “H” in this set)
18	AMUTE	O	Audio line muting on/off control signal output terminal “L”: line muting on Not used (pull down)
19	$\overline{\text{PWR-DWN}}$	I	Power down detection signal input terminal “L”: power down, normally: “H”
20	DQSY	I	Digital In U-bit CD format subcode Q sync (SCOR) input from the CXD2652AR (IC121) “L” is input every 13.3 msec Almost all, “H” is input
21	STB	O	Strobe signal output to the power supply circuit “H”: power on, “L”: standby mode Not used (pull down)
22	$\overline{\text{DARST}}$	O	Reset signal output terminal “L”: reset Not used (pull down)
23	XINT	I	Interrupt status input from the CXD2652AR (IC121)
24	$\overline{\text{DA-EN}}$	O	Enable signal output to the A/D, D/A converter (IC201) (for D/A converter block) “L”: enable
25	$\overline{\text{AD-EN}}$	O	Enable signal output to the A/D, D/A converter (IC201) (for A/D converter block) “L”: enable
26	MEC-BUSY	O	MD mechanism controller busy status monitor output to the master controller (IC707)
27	FLCS	O	Chip select signal output terminal Not used (pull down)
28	FLCLK	O	Display serial data transfer clock signal output terminal Not used (pull down)
29	—	I	Not used (fixed at “L”)
30	FLDATA	O	Display serial data output terminal Not used (pull down)
31	TXD	O	UART communication data output to the master controller (IC707)
32	RXD	I	UART communication data input from the master controller (IC707)
33	CLK	I	Serial clock signal input from the master controller (IC707)
34	MAS-BUSY	I	Master controller busy status monitor input from the master controller (IC707)
35	SWDT	O	Writing data output to the CXD2652AR (IC121)
36	SRDT	I	Reading data input from the CXD2652AR (IC121)
37	SCLK	O	Serial clock signal output to the CXD2652AR (IC121)
38	XLAT	O	Serial data latch pulse signal output to the CXD2652AR (IC121)
39	—	I	Not used (fixed at “L”)
40	$\overline{\text{DIG-RST}}$	O	Reset signal output to the CXD2652AR (IC121) and BH6511FS (IC152) “L”: reset

Pin No.	Pin Name	I/O	Function
41	SENS	I	Internal status (SENSE) input from the CXD2652AR (IC121)
42	SCTX	O	Recording data output enable signal output to the CXD2652AR (IC121) and overwrite head driver (IC181) Writing data transmission timing output (Also serves as the magnetic head on/off output)
43	XINT	O	Not used (pull down)
44	WRPWR	O	Laser power select signal output to the CXD2652AR (IC121) and HF module switch circuit "L": playback mode, "H": recording mode
45	MNT3	I	Spindle servo lock status monitor signal input from the CXD2652AR (IC121)
46	MNT2	I	Busy signal input from the CXD2652AR (IC121)
47	MNT1	I	Track jump detection signal input from the CXD2652AR (IC121)
48	MNT0	I	Focus OK signal input from the CXD2652AR (IC121) "H" is input when focus is on ("L": NG)
49	LDON	O	Laser diode on/off control signal output to the automatic power control circuit "H": laser on
50	MOD	O	Laser modulation select signal output to the HF module switch circuit Playback power: "H", Stop: "L", Recording power: 
51	LDIN	O	Motor control signal output to the loading motor driver (IC153) "L" active *1
52	LDOUT	O	Motor control signal output to the loading motor driver (IC153) "L" active *1
53	LD-LOW	O	Loading motor drive voltage control signal output for the loading motor driver (IC153) "H" active
54	PROTECT	I	Rec-proof claw detect input from the protect detect switch (S683) "H": write protect
55	REFLECT	I	Detection input from the disc reflection rate detect switch (S682) "L": high reflection rate disc, "H": low reflection rate disc
56	PACK-IN	I	Detection input from the disc detect switch Not used (fixed at "H")
57	PACK-OUT	I	Detection input from the loading-out detect switch (S686) "L" at a load-out position, others: "H"
58	CHUCK-IN	I	Detection input from the disc chucking-in detect switch (S685) "L": chucking
59	LIMIT-IN	I	Detection input from the sled limit-in detect switch (S681) The optical pick-up is inner position when "L"
60	REC-P	I	Detection input from the recording position detect switch (S688) "L" active
61	PB-P	I	Detection input from the playback position detect switch (S687) "L" active
62	+3.3V	—	Power supply terminal (+3.3V)
63	—	I	Not used (fixed at "L")
64	GND	—	Ground terminal
65 to 78	—	I	Not used (fixed at "L")
79	SDA	I/O	Two-way data bus with the EEPROM (IC171)
80	SCL	O	Serial clock signal output to the EEPROM (IC171)

*1 Loading motor (M903) control

Terminal \ Mode	LOADING	EJECT	BRAKE	RUN IDLE
LDIN (pin ⑤)	"L"	"H"	"L"	"H"
LDOUT (pin ②)	"H"	"L"	"L"	"H"

Pin No.	Pin Name	I/O	Function
81, 82	—	I	Not used (fixed at “L”)
83	POWER	O	Power on/off control signal output terminal Not used (pull down)
84 to 90	—	I	Not used (fixed at “L”)
91 to 93	KEY0 to KEY2	I	Key input terminal (A/D input) Not used (fixed at “H”)
94	—	I	Not used (fixed at “L”)
95	SOURCE	I	Not used (fixed at “L”)
96	AVSS	—	Ground terminal (for A/D converter)
97	—	I	Not used (fixed at “L”)
98	VREF3.3V	I	Reference voltage (+3.3V) input terminal (for A/D converter)
99	+3.3V	—	Power supply terminal (+3.3V) (for analog system)
100	—	I	Not used (fixed at “L”)

• MAN BOARD IC707 μ PD78078GF-083-3BA
(MASTER CONTROLLER (CD MECHANISM CONTROL/SYSTEM CONTROL))

Pin No.	Pin Name	I/O	Function
1	VER	I	Destination setting terminal Not used (open)
2	VER	I	Destination setting terminal US, Canadian models: fixed at "L", Other models: open
3	VER	I	Destination setting terminal US, Canadian, Singapore, Hong Kong models: fixed at "L", Other models: open
4	VER	I	Destination setting terminal Not used (open)
5 to 7	NC	O	Not used (open)
8	—	O	Not used (open)
9	IC	—	Connected to ground
10	X2	O	Main system clock output terminal (5 MHz)
11	X1	I	Main system clock input terminal (5 MHz)
12	VDD	—	Power supply terminal (+5V)
13	XT2	O	Sub system clock output terminal (32 kHz)
14	XT1	I	Sub system clock input terminal (32 kHz)
15	$\overline{\text{RESET}}$	I	System reset signal input from the reset signal generator (IC708) "L": reset For several hundreds msec. after the power supply rises, "L" is input, then it changes to "H"
16	AU-BUS IN	I	Audio bus signal input terminal
17	AU-BUS OUT	O	Audio bus signal output terminal
18	ENC/A	I	Rotary encoder jog dial pulse input terminal (A phase input) Not used (fixed at "L")
19	ENC/B	I	Rotary encoder jog dial pulse input terminal (B phase input) Not used (fixed at "L")
20	RDS/CLK	I	RDS serial data transfer clock signal input from the RDS decoder (IC710) Used for the AEP, UK models
21	RDS/DATA	I	RDS serial data input from the RDS decoder (IC710) Used for the AEP, UK models
22	SCOR	I	Subcode sync (S0+S1) detection signal input from the CXD2507AQ (IC103)
23	AVDD	—	Power supply terminal (+5V) (for A/D converter)
24	AVREF0	I	Reference voltage (+5V) input terminal (for A/D converter)
25	KEY0	I	Key input terminal (A/D input) I/Ⓛ (power) key input (S903)
26	KEY1	I	Key input terminal (A/D input) CD ■, CD ►■, CD ≡, MD ■, MD ►■, MD ≡, VOLUME +/- keys input (S902, 905, 907, 909, 911, 913 to 915)
27	KEY2	I	Key input terminal (A/D input) FUNCTION, CD/MD ►►►► TUNING +, TUNER/BAND, CD/MD ◄◄◄◄ TUNING -, REC, CD-MD SYNC keys input (S901, 904, 906, 908, 910, 912)
28 to 30	—	O	Not used (open)
31	RTS	O	Master controller busy status monitor output to the MD mechanism controller (IC316)
32	MD-POWER	O	MD system power supply on/off control signal output terminal Not used (open)
33	AVSS	—	Ground terminal (for A/D converter)
34	$\overline{\text{POWER-ON}}$	O	System power supply on/off control signal output terminal "L": power on, "H": standby
35	MD-REST	O	Reset signal output to the MD mechanism controller (IC316) "H": reset
36	AVREF1	I	Reference voltage (+5V) input terminal (for A/D converter)
37	RXD	I	UART communication data input from the MD mechanism controller (IC316)
38	TXD	O	UART communication data output to the MD mechanism controller (IC316)
39	MD-CLK	O	Serial clock signal output to the MD mechanism controller (IC316)
40	VSS	—	Ground terminal
41	CTS	I	MD mechanism controller busy status monitor input from the MD mechanism controller (IC316)
42	DATA	O	Display serial data output to the FL driver (IC901)
43	CLOCK	O	Display serial data transfer clock signal output to the FL driver (IC901)
44	$\overline{\text{CS}}$	O	Chip select signal output to the FL driver (IC901) "L": data output

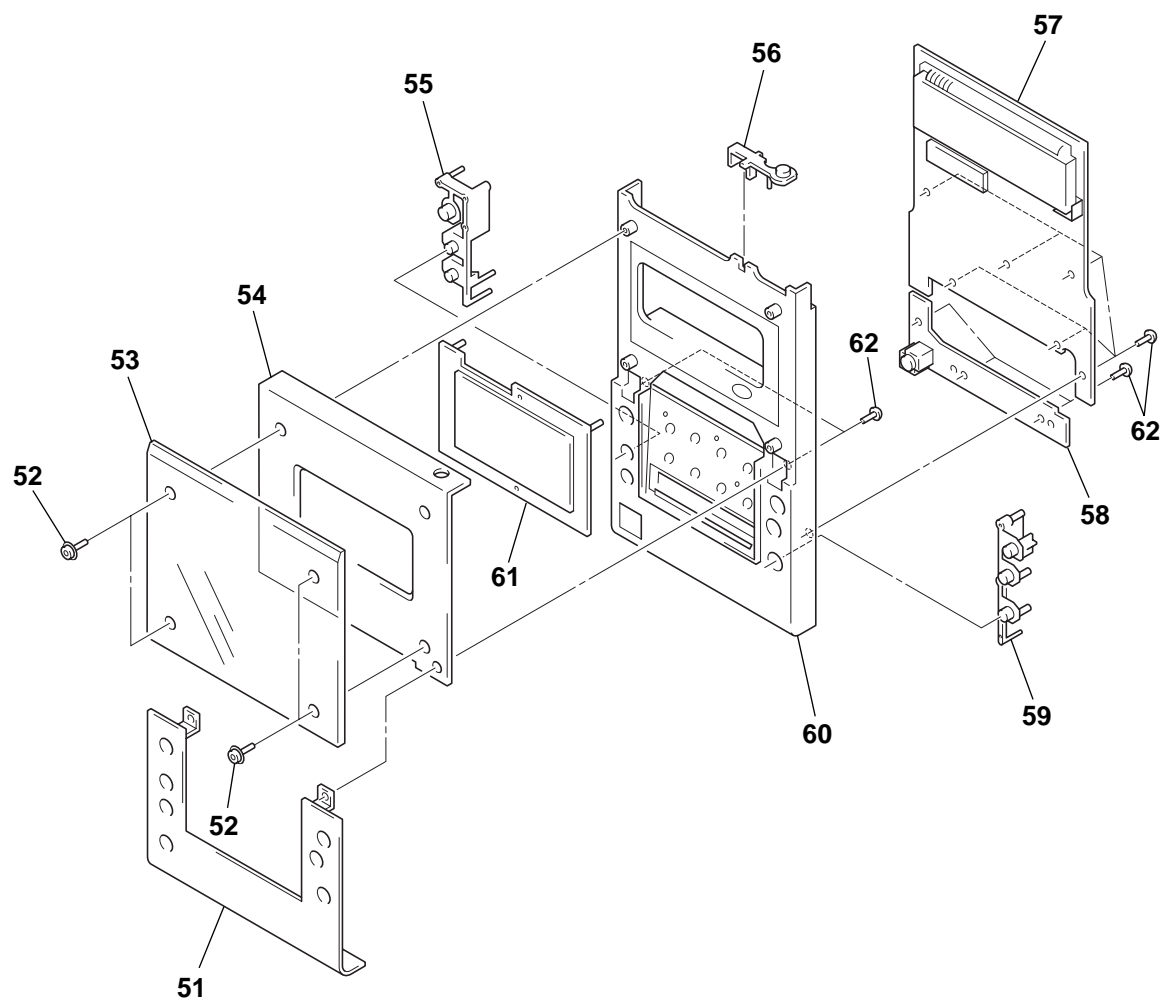
Pin No.	Pin Name	I/O	Function
45	RESET	O	Reset signal output to the FL driver (IC901) “L”: reset
46	SUBQ	I	Subcode Q data input from the CXD2507AQ (IC103)
47	NC	O	Not used (open)
48	SQCLK	O	Subcode Q data reading clock signal output to the CXD2507AQ (IC103)
49	CLOCK	O	Serial data transfer clock signal output to the CXD2507AQ (IC103) and PCM1710U (IC104)
50	DATA	O	Serial data output to the CXD2507AQ (IC103) and PCM1710U (IC104)
51	XLT	O	Serial data latch pulse signal output to the CXD2507AQ (IC103)
52	PRGL (DF-LAT)	O	Serial data latch pulse signal output to the PCM1710U (IC104)
53	SENSE	I	Internal status input from the CXD2507AQ (IC103)
54	ADJ	I	Setting terminal for the CD test mode “L”: CD test mode Normally: fixed at “H”
55	IN-SW	I	Detection input from the disc detect switch (S104) “L”: disc in
56	OUT-SW	I	Detection input from the disc detect (S104) “L”: disc out
57	LOAD-OUT	O	Motor control signal output to the CD lid open/close motor driver (IC702) “L” active *1
58	LOAD-IN	O	Motor control signal output to the CD lid open/close motor driver (IC702) “L” active *1
59	FOCUS-SW	O	Focus gain control signal output to the CXA1782BQ (IC101) “L”: normal, “H”: down
60	BD-REST	O	Reset signal output to the CXA1782BQ (IC101), BA6297FP (IC102) and CXD2507AQ (IC103) “L”: reset
61	CD-POWER	O	CD servo system power supply on/off control signal output terminal “H”: power on
62	ST-POWER	O	Tuner system power supply on/off control signal output terminal “H”: power on Not used (open)
63	D.IN.SELECT	O	Digital input selection signal output terminal Not used (open)
64 to 66	—	O	Not used (open)
67	LED-MD DISC	O	LED drive signal output of the MD disc slot indicator (D906) “L”: LED on
68	LED-MD REC	O	LED drive signal output of the REC indicator (D905) “L”: LED on
69	LED-CD PAUSE	O	LED drive signal output of the CD ■■ indicator (D907 amber) “L”: LED on
70	LED-CD PLAY	O	LED drive signal output of the CD ► indicator (D907 green) “L”: LED on
71	VSS	—	Ground terminal
72	LED-MD PAUSE	O	LED drive signal output of the MD ■■ indicator (D903 amber) “L”: LED on
73	LED-MD PLAY	O	LED drive signal output of the MD ► indicator (D903 green) “L”: LED on
74	DBFB	O	DBFB on/off control signal output terminal “L”: DBFB on
75	RECOUT-MUTE	O	Muting on/off control signal output for the TAPE OUT signal “L”: muting on
76	MUTE	O	Audio muting on/off control signal output terminal
77	ATT/6DB	O	–6 dB attenuator control signal output for the TAPE IN signal “L”: attenuator on
78	DATA	O	Serial data output to the M62428AFP (IC705)
79	CLOCK	O	Serial data transfer clock signal output to the M62428AFP (IC705)
80	LAT	O	Serial data latch pulse signal output to the M62428AFP (IC705)
81	GND	—	Ground terminal
82	STEREO	I	FM stereo detection signal input from the FM/AM tuner unit “L”: stereo
83	TUNED	I	Tuning detection signal input from the FM/AM tuner unit “L”: tuned, “H”: detuned
84	DATA-IN	I	PLL serial data input from the FM/AM tuner unit
85	DATA-OUT	O	PLL serial data output to the FM/AM tuner unit
86	CLOCK	O	PLL serial data transfer clock signal output to the FM/AM tuner unit

*1 CD lid open/close motor (M103) control

Terminal	Mode	OFF	OPEN	CLOSE	BRAKE
	LOAD-OUT (pin ⑦)		“H”	“L”	“H”
LOAD-IN (pin ⑧)		“H”	“H”	“L”	“L”

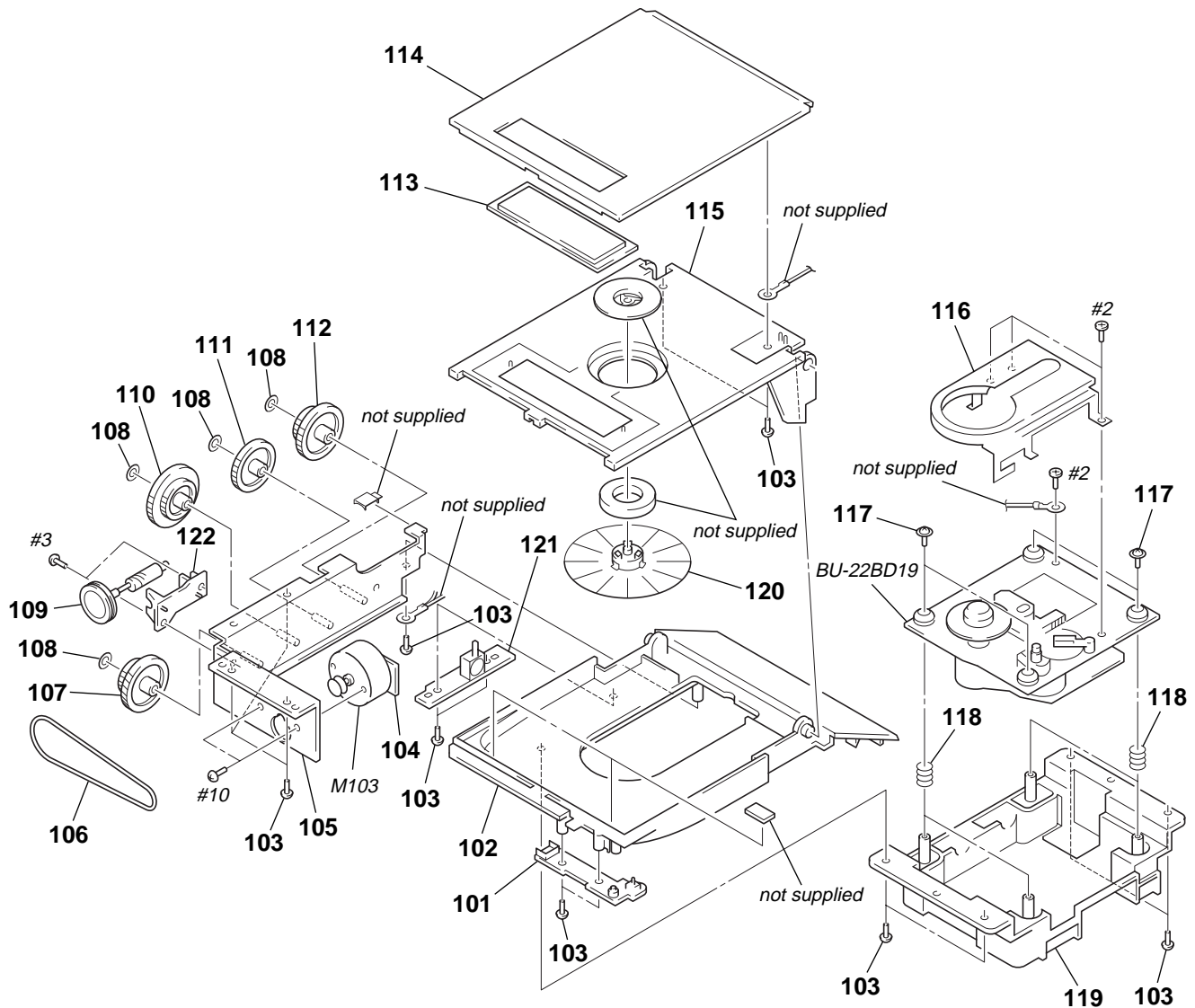
Pin No.	Pin Name	I/O	Function
87	CE	O	PLL serial chip enable signal output to the FM/AM tuner unit
88	ST-MUTE	O	Tuner muting on/off control signal output to the FM/AM tuner unit "L": muting on
89	FM/AM SELECT	O	FM/AM selection signal output terminal Not used (open)
90	SIRCS	I	Sircs signal input from the remote control receiver (IC902)
91	—	O	Not used (open)
92	—	I	Not used (fixed at "L")
93	FAN SPEED	O	Fan motor speed control signal output terminal Not used (open)
94	FAN STOP	O	Fan motor on/off control signal output terminal Not used (open)
95	—	O	Not used (open)
96	MD1	I	Setting terminal for the CPU operational mode (fixed at "H" in this set)
97 to 99	—	I	Not used (fixed at "L")
100	BACKUP	I	System reset signal input from the reset signal generator (IC708) "L": reset For several hundreds msec. after the power supply rises, "L" is input, then it changes to "H"

(2) FRONT PANEL SECTION



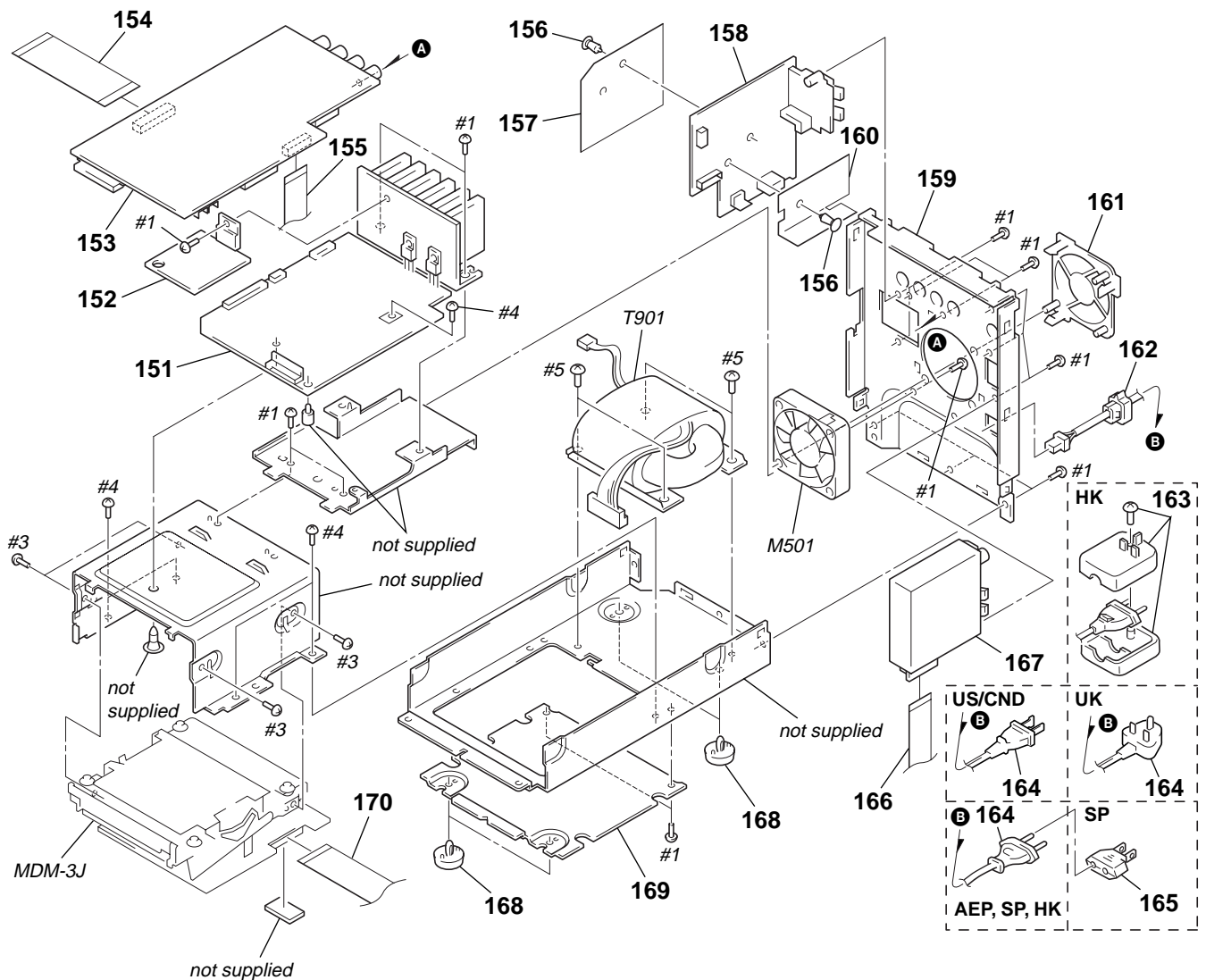
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
51	4-212-503-01	PLATE (BUTTON), ORNAMENTAL		* 57	A-4417-231-A	PANEL BOARD, COMPLETE	
52	4-212-531-01	SCREW		* 58	1-671-424-11	HP BOARD	
53	4-212-103-01	PLATE (GLASS), ORNAMENTAL		59	4-212-533-01	BUTTON (VOL)	
54	4-212-502-01	PLATE (INDICATION WINDOW)		60	X-4950-365-1	PANEL ASSY, FRONT	
55	4-212-532-01	BUTTON (POWER) (+, -, ≡)		61	4-212-528-01	WINDOW, INDICATION	
56	4-212-507-01	BUTTON (EJECT) (≡)		62	4-951-620-41	SCREW (2.6), +BVTP	

(3) CD SECTION



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 101	1-671-426-11	EJECT BOARD		113	4-212-525-01	WINDOW (CD)	
102	4-212-497-01	TABLE, DISC		114	4-212-504-01	PLATE (LID), ORNAMENTAL	
103	4-951-620-41	SCREW (2.6), +BVTP		115	4-212-495-01	ARM, CHUCKING	
* 104	1-671-428-11	MOTOR BOARD		116	4-212-500-01	PLATE (BU), ORNAMENTAL	
105	X-4950-366-1	BRACKET (GEAR) ASSY		117	4-985-672-01	SCREW (+PTPWHM2.6), FLOATING	
106	4-212-529-01	BELT		118	4-959-996-01	SPRING (932), COMPRESSION	
107	4-212-492-01	GEAR (A)		119	4-212-499-01	HOLDER (BU)	
108	3-325-697-01	WASHER		120	4-993-142-11	PULLEY (L), PRESS	
109	X-4950-379-1	GEAR ASSY, WORM		* 121	1-671-427-11	SENSOR BOARD	
110	4-212-493-01	GEAR (B)		122	4-212-709-01	BRACKET (WORM)	
111	4-212-494-01	GEAR (C)		M103	A-4411-278-A	MOTOR ASSY (CD LID OPEN/CLOSE)	
112	4-212-708-01	GEAR (D)					

(4) CHASSIS SECTION

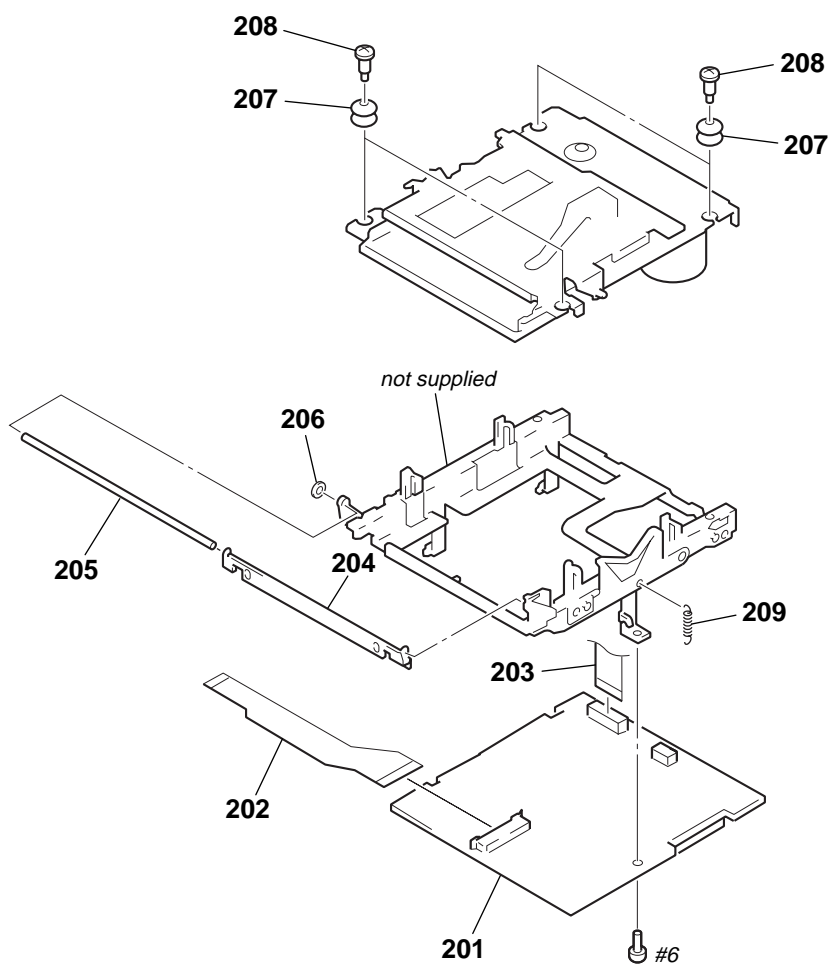


The components identified by mark ▲ or dotted line with mark ▲ are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque ▲ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

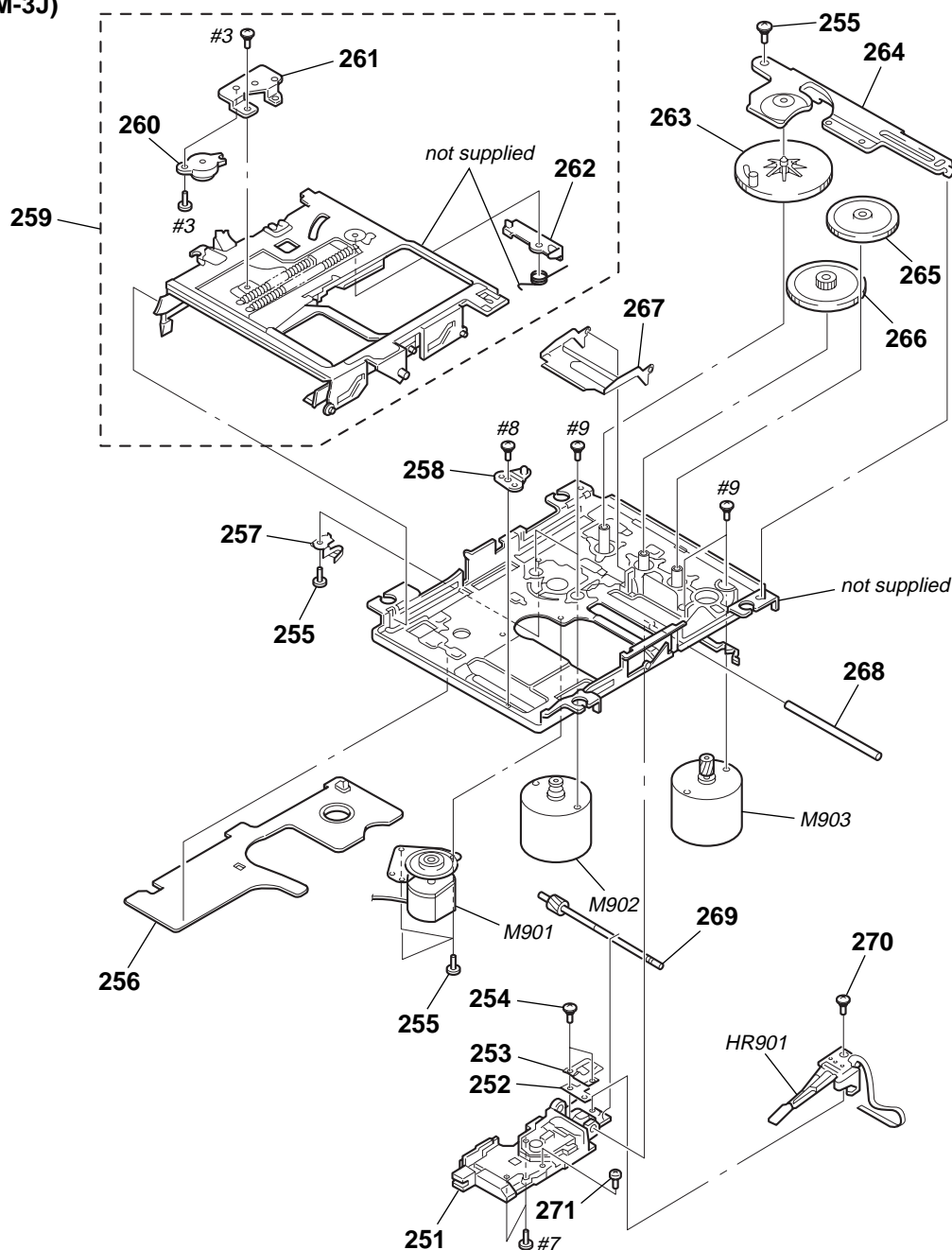
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 151	A-4417-232-A	POWER BOARD, COMPLETE		▲ 163	1-770-019-11	ADAPTOR, CONVERSION PLUG 3P (HK)	
* 152	1-671-772-11	AMP BOARD		▲ 164	1-575-651-21	CORD, POWER (AEP, SP, HK)	
* 153	A-4417-230-A	MAIN BOARD, COMPLETE (AEP, UK)		▲ 164	1-696-571-11	CORD, POWER (UK)	
* 153	A-4417-310-A	MAIN BOARD, COMPLETE (SP, HK)		▲ 164	1-783-531-31	CORD, POWER (US, CND)	
* 153	A-4417-312-A	MAIN BOARD, COMPLETE (US, CND)		▲ 165	1-569-008-21	ADAPTOR, CONVERSION 2P (SP)	
154	1-790-106-11	WIRE (FLAT TYPE) (31 CORE)		166	1-773-009-11	WIRE (FLAT TYPE) (15 CORE)	
155	1-775-170-11	WIRE (FLAT TYPE) (19 CORE)		167	1-693-407-21	TUNER (US, CND)	
156	4-812-134-11	RIVET (DIA. 3.5), NYLON		167	1-693-409-21	TUNER (AEP, UK, SP, HK)	
* 157	4-213-167-01	INSULATED PLATE		168	4-965-822-01	FOOT	
* 158	1-671-425-11	JOINT BOARD		169	4-212-522-01	BRACKET (BOTTOM)	
* 159	4-212-513-01	PANEL, BACK (US, CND, AEP, UK)		170	1-790-105-11	WIRE (FLAT TYPE) (25 CORE)	
* 159	4-212-513-11	PANEL, BACK (SP, HK)		M501	1-698-997-11	FAN, D.C.	
* 160	4-212-527-01	COVER (FUSE)		▲ T901	1-433-472-11	TRANSFORMER, POWER (US, CND)	
161	4-212-526-01	BRACKET (FAN)		▲ T901	1-433-473-11	TRANSFORMER, POWER (AEP, UK)	
162	4-966-267-11	BUSHING (FBS001), CORD		▲ T901	1-433-474-11	TRANSFORMER, POWER (SP, HK)	

(5) MD MECHANISM DECK SECTION-1
(MDM-3J)



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 201	A-4699-808-A	BD (MD) BOARD, COMPLETE		206	4-986-959-01	WASHER, STOPPER	
202	1-660-966-11	OP RELAY FLEXIBLE BOARD		207	4-987-327-01	INSULATOR	
203	1-782-683-11	WIRE (FLAT TYPE) (14 CORE)		208	4-628-167-01	SCREW, STEP	
204	X-4949-900-1	SHUTTER ASSY		209	4-997-962-01	SPRING (O/C), TENSION	
205	4-997-456-02	SHAFT (SHUTTER) (A)					

(6) MD MECHANISM DECK SECTION-2
(MDM-3J)

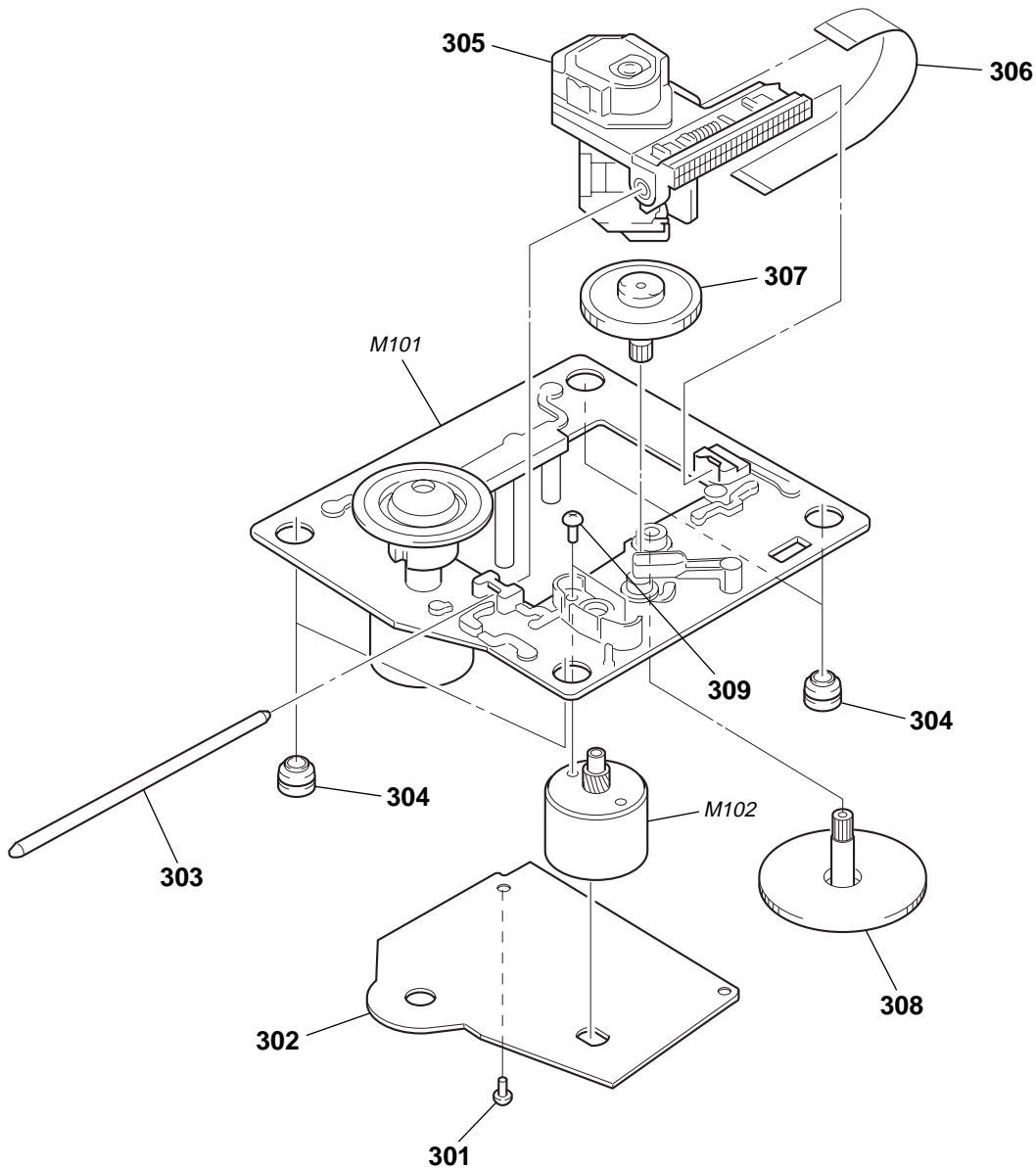


The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
Δ 251	8-583-028-02	OPTICAL PICK-UP KMS-260A/J1N (for MD)		264	4-979-890-11	RETAINER (GEAR)	
252	4-987-061-01	SPACER (RACK)		265	4-979-899-01	GEAR (LC)	
253	4-963-914-02	RACK (INSERTER)		266	4-979-897-01	GEAR (LA)	
254	3-366-890-11	SCREW (M1.4)		267	4-979-885-01	LEVER (HEAD UP)	
255	3-342-375-11	SCREW (M1.7X1.4), SPECIAL		268	4-984-556-01	SHAFT (MAIN SHAFT)	
* 256	1-667-719-11	SW BOARD		269	A-3304-200-A	SCREW ASSY, LEAD	
257	4-979-906-11	SPRING (LEAD SCREW)		270	4-988-560-01	SCREW (+P 1.7X6)	
* 258	4-983-511-02	PIN (OUTSERT)		271	4-955-841-11	SCREW	
259	A-4672-138-A	SLIDER COMPLETE ASSY		HR901	1-500-396-11	HEAD, OVER LIGHT (RF325-74A)	
260	3-953-235-01	DAMPER, OIL		M901	A-4672-135-A	MOTOR ASSY, SPINDLE (for MD)	
* 261	4-983-439-01	BRACKET (DAMPER)		M902	A-4672-133-A	MOTOR ASSY, SLED (for MD)	
* 262	4-983-437-01	SLIDER (CAM)		M903	A-4672-134-A	MOTOR ASSY, LOADING (for MD)	
263	4-979-898-01	GEAR (LB)					

(7) CD BASE UNIT SECTION
(BU-22BD19)



<p>The components identified by mark \triangle or dotted line with mark \triangle are critical for safety. Replace only with part number specified.</p>	<p>Les composants identifiés par une marque \triangle sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.</p>
---	--

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
301	4-951-620-01	SCREW (2.6X8), +BVTP		307	4-917-567-01	GEAR (M)	
302	A-4673-402-A	BD (CD) BOARD, COMPLETE		308	4-917-564-01	GEAR (P), FLATNESS	
303	4-917-565-01	SHAFT, SLED		309	3-713-786-51	SCREW +P 2X3	
304	4-951-940-01	INSULATOR (BU)		M101	X-4942-405-1	BASE (OUTSART) ASSY (SPINDLE) (for CD)	
\triangle 305	8-848-379-31	OPTICAL PICK-UP KSS-213B/K-N (for CD)		M102	X-4917-504-1	MOTOR ASSY (SLED) (for CD)	
306	1-769-069-11	WIRE (FLAT TYPE) (16 CORE)					

SECTION 9 ELECTRICAL PARTS LIST

AMP

BD (CD)

NOTE:

- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- -XX and -X mean standardized parts, so they may have some difference from the original one.
- RESISTORS
All resistors are in ohms.
METAL: Metal-film resistor.
METAL OXIDE: Metal oxide-film resistor.
F: nonflammable
- Abbreviation
CND : Canadian
HK : Hong Kong
SP : Singapore

- Items marked “*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- SEMICONDUCTORS
In each case, u: μ , for example:
uA. . : μ A. . uPA. . : μ PA. .
uPB. . : μ PB. . uPC. . : μ PC. .
uPD. . : μ PD. .
- CAPACITORS
uF: μ F
- COILS
uH: μ H

The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

When indicating parts by reference number, please include the board.

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
*	1-671-772-11	AMP BOARD *****		C105	1-163-038-00	CERAMIC CHIP 0.1uF	25V
		< CAPACITOR >		C106	1-164-690-91	CERAMIC CHIP 0.0022uF 5%	50V
C534	1-126-047-91	ELECT 4.7uF 20%	50V	C107	1-164-690-91	CERAMIC CHIP 0.0022uF 5%	50V
C535	1-126-047-91	ELECT 4.7uF 20%	50V	C108	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V
C536	1-163-003-11	CERAMIC CHIP 330PF 10%	50V	C109	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V
C537	1-163-003-11	CERAMIC CHIP 330PF 10%	50V	C110	1-163-989-11	CERAMIC CHIP 0.033uF 10%	25V
C539	1-126-022-11	ELECT 47uF 20%	25V	C111	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C540	1-126-022-11	ELECT 47uF 20%	25V	C112	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C541	1-163-113-00	CERAMIC CHIP 68PF 5%	50V	C113	1-164-690-91	CERAMIC CHIP 0.0022uF 5%	50V
C542	1-163-113-00	CERAMIC CHIP 68PF 5%	50V	C114	1-164-005-11	CERAMIC CHIP 0.47uF	25V
C543	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V	C115	1-126-607-11	ELECT CHIP 47uF 20%	4V
C546	1-126-964-11	ELECT 10uF 20%	50V	C116	1-163-016-00	CERAMIC CHIP 0.0039uF 10%	50V
C547	1-126-964-11	ELECT 10uF 20%	50V	C117	1-164-005-11	CERAMIC CHIP 0.47uF	25V
C556	1-130-483-00	MYLAR 0.01uF 5%	50V	C118	1-107-823-11	CERAMIC CHIP 0.47uF 10%	16V
C557	1-130-483-00	MYLAR 0.01uF 5%	50V	C119	1-163-038-00	CERAMIC CHIP 0.1uF	25V
		< CONNECTOR >		C120	1-135-201-11	TANTALUM CHIP 10uF 20%	4V
* CN505	1-564-525-11	PLUG, CONNECTOR 10P		C121	1-163-038-00	CERAMIC CHIP 0.1uF	25V
		< IC >		C122	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V
IC506	8-759-333-24	IC LM1876TF		C123	1-163-038-00	CERAMIC CHIP 0.1uF	25V
		< RESISTOR >		C124	1-126-607-11	ELECT CHIP 47uF 20%	4V
R520	1-216-049-11	RES, CHIP 1K 5%	1/10W	C125	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V
R521	1-216-081-00	METAL CHIP 22K 5%	1/10W	C126	1-163-038-00	CERAMIC CHIP 0.1uF	25V
R522	1-216-081-00	METAL CHIP 22K 5%	1/10W	C127	1-164-690-91	CERAMIC CHIP 0.0022uF 5%	50V
R523	1-216-049-11	RES, CHIP 1K 5%	1/10W	C128	1-163-135-00	CERAMIC CHIP 560PF 5%	50V
R526	1-216-045-00	METAL CHIP 680 5%	1/10W	C129	1-163-038-00	CERAMIC CHIP 0.1uF	25V
R527	1-216-045-00	METAL CHIP 680 5%	1/10W	C130	1-164-336-11	CERAMIC CHIP 0.33uF	25V
R528	1-216-081-00	METAL CHIP 22K 5%	1/10W	C131	1-163-038-00	CERAMIC CHIP 0.1uF	25V
R529	1-216-081-00	METAL CHIP 22K 5%	1/10W	C132	1-163-037-11	CERAMIC CHIP 0.022uF 10%	25V
R550	1-216-069-00	METAL CHIP 6.8K 5%	1/10W	C133	1-163-145-00	CERAMIC CHIP 0.0015uF 5%	50V
R551	1-216-069-00	METAL CHIP 6.8K 5%	1/10W	C134	1-164-346-11	CERAMIC CHIP 1uF	16V
*****				C135	1-163-251-11	CERAMIC CHIP 100PF 5%	50V
A-4673-402-A		BD (CD) BOARD, COMPLETE *****		C136	1-164-005-11	CERAMIC CHIP 0.47uF	25V
		< CAPACITOR >		C137	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V
C101	1-126-607-11	ELECT CHIP 47uF 20%	4V	C139	1-163-235-11	CERAMIC CHIP 22PF 5%	50V
C102	1-163-275-11	CERAMIC CHIP 0.001uF 5%	50V	C140	1-163-235-11	CERAMIC CHIP 22PF 5%	50V
C103	1-164-346-11	CERAMIC CHIP 1uF	16V	C141	1-163-038-00	CERAMIC CHIP 0.1uF	25V
				C142	1-163-038-00	CERAMIC CHIP 0.1uF	25V
				C145	1-135-201-11	TANTALUM CHIP 10uF 20%	4V
				C146	1-135-201-11	TANTALUM CHIP 10uF 20%	4V
				C147	1-163-275-11	CERAMIC CHIP 0.001uF 5%	50V
				C148	1-163-275-11	CERAMIC CHIP 0.001uF 5%	50V
				C149	1-164-346-11	CERAMIC CHIP 1uF	16V
				C153	1-135-259-11	TANTALUM CHIP 10uF 20%	6.3V

BD (CD)

BD (MD)

Ref. No.	Part No.	Description	Remark
C154	1-163-235-11	CERAMIC CHIP 22PF	5% 50V
< CONNECTOR >			
CNU101	1-770-014-11	CONNECTOR, FFC/FPC 16P	
CNU102	1-770-013-11	CONNECTOR, FFC/FPC 19P	
< IC >			
IC101	8-752-069-56	IC CXA1782BQ	
IC102	8-759-291-06	IC BA6397FP	
IC103	8-752-372-94	IC CXD2507AQ	
IC104	8-759-185-29	IC PCM1710U-B	
< TRANSISTOR >			
Q101	8-729-010-08	TRANSISTOR MSB710-R	
Q102	8-729-424-08	TRANSISTOR UN2111	
Q103	8-729-421-22	TRANSISTOR UN2211	
< RESISTOR >			
R102	1-216-001-00	METAL CHIP 10	5% 1/10W
R103	1-216-049-11	RES, CHIP 1K	5% 1/10W
R104	1-216-097-00	RES, CHIP 100K	5% 1/10W
R105	1-216-093-00	METAL CHIP 68K	5% 1/10W
R106	1-216-093-00	METAL CHIP 68K	5% 1/10W
R107	1-216-093-00	METAL CHIP 68K	5% 1/10W
R108	1-216-093-00	METAL CHIP 68K	5% 1/10W
R109	1-216-097-00	RES, CHIP 100K	5% 1/10W
R112	1-216-083-00	METAL CHIP 27K	5% 1/10W
R113	1-216-083-00	METAL CHIP 27K	5% 1/10W
R114	1-216-101-00	METAL CHIP 150K	5% 1/10W
R115	1-216-101-00	METAL CHIP 150K	5% 1/10W
R116	1-216-061-00	METAL CHIP 3.3K	5% 1/10W
R117	1-216-069-00	METAL CHIP 6.8K	5% 1/10W
R118	1-216-049-11	RES, CHIP 1K	5% 1/10W
R119	1-216-089-00	RES, CHIP 47K	5% 1/10W
R120	1-216-089-00	RES, CHIP 47K	5% 1/10W
R121	1-216-114-00	RES, CHIP 510K	5% 1/10W
R122	1-216-097-00	RES, CHIP 100K	5% 1/10W
R123	1-216-099-00	METAL CHIP 120K	5% 1/10W
R124	1-216-091-00	METAL CHIP 56K	5% 1/10W
R125	1-216-069-00	METAL CHIP 6.8K	5% 1/10W
R126	1-216-063-00	RES, CHIP 3.9K	5% 1/10W
R127	1-216-089-00	RES, CHIP 47K	5% 1/10W
R128	1-216-105-00	RES, CHIP 220K	5% 1/10W
R129	1-216-049-11	RES, CHIP 1K	5% 1/10W
R130	1-216-079-00	METAL CHIP 18K	5% 1/10W
R131	1-216-079-00	METAL CHIP 18K	5% 1/10W
R132	1-216-061-00	METAL CHIP 3.3K	5% 1/10W
R133	1-216-061-00	METAL CHIP 3.3K	5% 1/10W
R134	1-216-065-00	RES, CHIP 4.7K	5% 1/10W
R135	1-216-065-00	RES, CHIP 4.7K	5% 1/10W
R136	1-216-073-00	METAL CHIP 10K	5% 1/10W
R137	1-216-065-00	RES, CHIP 4.7K	5% 1/10W
R138	1-216-049-11	RES, CHIP 1K	5% 1/10W
R139	1-216-033-00	METAL CHIP 220	5% 1/10W
R140	1-216-081-00	METAL CHIP 22K	5% 1/10W
R141	1-216-061-00	METAL CHIP 3.3K	5% 1/10W
R142	1-216-061-00	METAL CHIP 3.3K	5% 1/10W
R143	1-216-121-00	RES, CHIP 1M	5% 1/10W

Ref. No.	Part No.	Description	Remark
R144	1-216-073-00	METAL CHIP 10K	5% 1/10W
R145	1-216-097-00	RES, CHIP 100K	5% 1/10W
R146	1-216-097-00	RES, CHIP 100K	5% 1/10W
R147	1-216-049-11	RES, CHIP 1K	5% 1/10W
R148	1-216-049-11	RES, CHIP 1K	5% 1/10W
R149	1-216-049-11	RES, CHIP 1K	5% 1/10W
R150	1-216-037-00	METAL CHIP 330	5% 1/10W
R151	1-216-037-00	METAL CHIP 330	5% 1/10W
R152	1-216-037-00	METAL CHIP 330	5% 1/10W
R153	1-216-082-00	RES, CHIP 24K	5% 1/10W
R154	1-216-065-00	RES, CHIP 4.7K	5% 1/10W
R156	1-216-085-00	METAL CHIP 33K	5% 1/10W
R157	1-216-069-00	METAL CHIP 6.8K	5% 1/10W
R158	1-216-001-00	METAL CHIP 10	5% 1/10W
< VARIABLE RESISTOR >			
RV101	1-223-587-11	RES, ADJ, CARBON 22K	
RV102	1-223-587-11	RES, ADJ, CARBON 22K	
RV103	1-223-587-11	RES, ADJ, CARBON 22K	
< SWITCH >			
S101	1-572-085-11	SWITCH, LEAF (LIMIT)	
< VIBRATOR >			
X101	1-579-280-11	VIBRATOR, CRYSTAL (16.9344MHz)	

*	A-4699-808-A	BD (MD) BOARD, COMPLETE	*****
< CAPACITOR >			
C101	1-104-851-11	TANTALUM CHIP 10uF	20% 10V
C102	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C103	1-104-851-11	TANTALUM CHIP 10uF	20% 10V
C104	1-104-851-11	TANTALUM CHIP 10uF	20% 10V
C105	1-163-021-11	CERAMIC CHIP 0.01uF	10% 50V
C106	1-163-275-11	CERAMIC CHIP 0.001uF	5% 50V
C107	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C108	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C109	1-163-037-11	CERAMIC CHIP 0.022uF	10% 25V
C110	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C111	1-164-344-11	CERAMIC CHIP 0.068uF	10% 25V
C112	1-163-017-00	CERAMIC CHIP 0.0047uF	5% 50V
C113	1-164-346-11	CERAMIC CHIP 1uF	16V
C115	1-164-489-11	CERAMIC CHIP 0.22uF	10% 16V
C116	1-163-037-11	CERAMIC CHIP 0.022uF	10% 25V
C117	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C118	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C119	1-104-851-11	TANTALUM CHIP 10uF	20% 10V
C121	1-126-206-11	ELECT CHIP 100uF	20% 6.3V
C122	1-163-021-11	CERAMIC CHIP 0.01uF	10% 50V
C123	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C124	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C127	1-163-038-00	CERAMIC CHIP 0.1uF	25V
C128	1-163-021-11	CERAMIC CHIP 0.01uF	10% 50V
C129	1-107-823-11	CERAMIC CHIP 0.47uF	10% 16V
C130	1-163-251-11	CERAMIC CHIP 100PF	5% 50V

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
C131	1-163-023-00	CERAMIC CHIP	0.015uF 5% 50V	C363	1-163-251-11	CERAMIC CHIP 100PF 5% 50V	
C132	1-107-823-11	CERAMIC CHIP	0.47uF 10% 16V	C401	1-163-038-00	CERAMIC CHIP 0.1uF 25V	
C133	1-163-017-00	CERAMIC CHIP	0.0047uF 5% 50V	C402	1-163-021-11	CERAMIC CHIP 0.01uF 10% 50V	
C134	1-163-038-00	CERAMIC CHIP	0.1uF 25V	C2001	1-163-038-00	CERAMIC CHIP 0.1uF 25V	
C135	1-163-038-00	CERAMIC CHIP	0.1uF 25V	C2002	1-163-038-00	CERAMIC CHIP 0.1uF 25V	
C136	1-126-206-11	ELECT CHIP	100uF 20% 6.3V	C2003	1-163-038-00	CERAMIC CHIP 0.1uF 25V	
C139	1-163-235-11	CERAMIC CHIP	22PF 5% 50V	C2004	1-163-038-00	CERAMIC CHIP 0.1uF 25V	
C140	1-163-099-00	CERAMIC CHIP	18PF 5% 50V				
C142	1-163-251-11	CERAMIC CHIP	100PF 5% 50V			< CONNECTOR >	
C143	1-163-251-11	CERAMIC CHIP	100PF 5% 50V	CN101	1-766-508-11	CONNECTOR, FFC/FPC (ZIF) 22P	
C144	1-163-251-11	CERAMIC CHIP	100PF 5% 50V	CN104	1-778-283-11	CONNECTOR, FFC/FPC 4P	
C151	1-126-206-11	ELECT CHIP	100uF 20% 6.3V	CN106	1-774-771-11	CONNECTOR, FFC/FPC 14P	
C152	1-163-038-00	CERAMIC CHIP	0.1uF 25V	CN107	1-779-854-11	CONNECTOR, FFC/FPC 25P	
C153	1-163-021-11	CERAMIC CHIP	0.01uF 10% 50V			< DIODE >	
C156	1-163-038-00	CERAMIC CHIP	0.1uF 25V	D101	8-719-988-62	DIODE 1SS355	
C158	1-163-019-00	CERAMIC CHIP	0.0068uF 10% 50V	D181	8-719-046-86	DIODE F1J6TP	
C160	1-104-601-11	ELECT CHIP	10uF 20% 10V	D183	8-719-046-86	DIODE F1J6TP	
C161	1-104-601-11	ELECT CHIP	10uF 20% 10V			< IC/TRANSISTOR >	
C163	1-163-021-11	CERAMIC CHIP	0.01uF 10% 50V	IC101	8-752-080-95	IC CXA2523AR	
C164	1-163-021-11	CERAMIC CHIP	0.01uF 10% 50V	IC103	8-729-903-10	TRANSISTOR FMW1	
C167	1-163-038-00	CERAMIC CHIP	0.1uF 25V	IC121	8-752-384-47	IC CXD2652AR	
C168	1-163-038-00	CERAMIC CHIP	0.1uF 25V	IC124	8-759-536-21	IC MSM51V4400D-10TSK-FS	
C169	1-104-851-11	TANTALUM CHIP	10uF 20% 10V	IC152	8-759-430-25	IC BH6511FS-E2	
C171	1-163-038-00	CERAMIC CHIP	0.1uF 25V	IC153	8-759-481-19	IC LB1830M-S-TE-L	
C181	1-126-206-11	ELECT CHIP	100uF 20% 6.3V	IC171	8-759-484-73	IC BR24C01AF-E2	
C182	1-163-038-00	CERAMIC CHIP	0.1uF 25V	IC181	8-759-481-17	IC MC74ACT08DTR2	
C183	1-163-038-00	CERAMIC CHIP	0.1uF 25V	IC192	8-759-460-72	IC BA033FP-E2	
C184	1-117-970-11	ELECT CHIP	22uF 20% 10V	IC201	8-759-471-38	IC AK4520A-VF-E2	
C185	1-164-611-11	CERAMIC CHIP	0.001uF 10% 500V	IC316	8-759-568-55	IC M30610MCA-272FP	
C188	1-163-021-11	CERAMIC CHIP	0.01uF 10% 50V	IC401	8-759-242-70	IC TC7WU04F	
C189	1-163-989-11	CERAMIC CHIP	0.033uF 10% 25V			< COIL/RESISTOR >	
C190	1-126-206-11	ELECT CHIP	100uF 20% 6.3V	L101	1-414-235-22	INDUCTOR CHIP 0uH	
C191	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L102	1-414-235-22	INDUCTOR CHIP 0uH	
C192	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L103	1-414-235-22	INDUCTOR CHIP 0uH	
C197	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L105	1-414-235-22	INDUCTOR CHIP 0uH	
C201	1-164-690-91	CERAMIC CHIP	0.0022uF 5% 50V	L106	1-414-235-22	INDUCTOR CHIP 0uH	
C202	1-164-690-91	CERAMIC CHIP	0.0022uF 5% 50V	L121	1-414-235-22	INDUCTOR CHIP 0uH	
C203	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L122	1-414-235-22	INDUCTOR CHIP 0uH	
C205	1-126-206-11	ELECT CHIP	100uF 20% 6.3V	L151	1-412-622-51	INDUCTOR 10uH	
C206	1-115-363-11	CERAMIC CHIP	10uF 10V	L152	1-412-622-51	INDUCTOR 10uH	
C207	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L153	1-412-039-51	INDUCTOR CHIP 100uH	
C208	1-115-363-11	CERAMIC CHIP	10uF 10V	L154	1-412-039-51	INDUCTOR CHIP 100uH	
C209	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L161	1-414-235-22	INDUCTOR CHIP 0uH	
C210	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L162	1-414-235-22	INDUCTOR CHIP 0uH	
C212	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L181	1-424-675-11	INDUCTOR 0uH	
C213	1-115-363-11	CERAMIC CHIP	10uF 10V	L201	1-412-776-11	INDUCTOR 1uH	
C214	1-115-363-11	CERAMIC CHIP	10uF 10V	L301	1-414-235-22	INDUCTOR CHIP 0uH	
C216	1-124-779-00	ELECT CHIP	10uF 20% 16V	L351	1-216-295-00	SHORT 0	
C350	1-163-038-00	CERAMIC CHIP	0.1uF 25V	L401	1-216-025-00	RES,CHIP 100 5% 1/10W	
C352	1-124-779-00	ELECT CHIP	10uF 20% 16V	L1001	1-500-445-21	FERRITE 0uH	
C353	1-163-038-00	CERAMIC CHIP	0.1uF 25V			< TRANSISTOR >	
C354	1-163-038-00	CERAMIC CHIP	0.1uF 25V	Q101	8-729-028-91	TRANSISTOR DTA144EUA-T106	
C355	1-163-251-11	CERAMIC CHIP	100PF 5% 50V	Q102	8-729-026-53	TRANSISTOR 2SA1576A-T106-QR	
C357	1-163-021-11	CERAMIC CHIP	0.01uF 10% 50V				
C358	1-163-251-11	CERAMIC CHIP	100PF 5% 50V				
C359	1-163-251-11	CERAMIC CHIP	100PF 5% 50V				
C361	1-163-038-00	CERAMIC CHIP	0.1uF 25V				
C362	1-163-251-11	CERAMIC CHIP	100PF 5% 50V				

BD (MD)

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
Q103	8-729-028-99	TRANSISTOR RT1N144M-TP-1		R189	1-216-073-00	METAL CHIP 10K 5%	1/10W
Q104	8-729-028-99	TRANSISTOR RT1N144M-TP-1					
Q162	8-729-101-07	TRANSISTOR 2SB798-DL		R190	1-216-073-00	METAL CHIP 10K 5%	1/10W
				R195	1-216-295-00	SHORT 0	
Q163	8-729-028-91	TRANSISTOR DTA144EUA-T106		R196	1-216-295-00	SHORT 0	
Q181	8-729-018-75	FET 2SJ278MY		R197	1-216-295-00	SHORT 0	
Q182	8-729-017-65	FET 2SK1764KY		R198	1-216-295-00	SHORT 0	
Q350	8-729-028-99	TRANSISTOR RT1N144M-TP-1					
		< RESISTOR >		R199	1-216-295-00	SHORT 0	
				R200	1-216-295-00	SHORT 0	
R101	1-216-025-00	RES, CHIP 100 5%	1/10W	R202	1-216-041-00	METAL CHIP 470 5%	1/10W
R103	1-216-049-11	RES, CHIP 1K 5%	1/10W	R203	1-216-025-00	RES, CHIP 100 5%	1/10W
R104	1-216-073-00	METAL CHIP 10K 5%	1/10W	R204	1-216-025-00	RES, CHIP 100 5%	1/10W
R105	1-216-065-00	RES, CHIP 4.7K 5%	1/10W				
R106	1-216-133-00	METAL CHIP 3.3M 5%	1/10W	R210	1-216-041-00	METAL CHIP 470 5%	1/10W
				R330	1-216-073-00	METAL CHIP 10K 5%	1/10W
R107	1-216-113-00	METAL CHIP 470K 5%	1/10W	R331	1-216-073-00	METAL CHIP 10K 5%	1/10W
R110	1-216-073-00	METAL CHIP 10K 5%	1/10W	R332	1-216-097-00	RES, CHIP 100K 5%	1/10W
R112	1-216-089-00	RES, CHIP 47K 5%	1/10W	R333	1-216-073-00	METAL CHIP 10K 5%	1/10W
R113	1-216-049-11	RES, CHIP 1K 5%	1/10W				
R115	1-216-049-11	RES, CHIP 1K 5%	1/10W	R351	1-216-053-00	METAL CHIP 1.5K 5%	1/10W
				R352	1-216-061-00	METAL CHIP 3.3K 5%	1/10W
R117	1-216-113-00	METAL CHIP 470K 5%	1/10W	R356	1-216-025-00	RES, CHIP 100 5%	1/10W
R121	1-216-097-00	RES, CHIP 100K 5%	1/10W	R361	1-216-073-00	METAL CHIP 10K 5%	1/10W
R125	1-216-025-00	RES, CHIP 100 5%	1/10W	R362	1-216-025-00	RES, CHIP 100 5%	1/10W
R128	1-216-041-00	METAL CHIP 470 5%	1/10W				
R131	1-216-073-00	METAL CHIP 10K 5%	1/10W	R363	1-216-073-00	METAL CHIP 10K 5%	1/10W
				R366	1-216-097-00	RES, CHIP 100K 5%	1/10W
R132	1-216-097-00	RES, CHIP 100K 5%	1/10W	R367	1-216-097-00	RES, CHIP 100K 5%	1/10W
R133	1-216-117-00	METAL CHIP 680K 5%	1/10W	R379	1-216-073-00	METAL CHIP 10K 5%	1/10W
R134	1-216-049-11	RES, CHIP 1K 5%	1/10W	R380	1-216-073-00	METAL CHIP 10K 5%	1/10W
R135	1-216-061-00	METAL CHIP 3.3K 5%	1/10W				
R136	1-216-049-11	RES, CHIP 1K 5%	1/10W	R381	1-216-073-00	METAL CHIP 10K 5%	1/10W
				R382	1-216-073-00	METAL CHIP 10K 5%	1/10W
R137	1-216-025-00	RES, CHIP 100 5%	1/10W	R383	1-216-073-00	METAL CHIP 10K 5%	1/10W
R140	1-216-029-00	METAL CHIP 150 5%	1/10W	R384	1-216-073-00	METAL CHIP 10K 5%	1/10W
R142	1-216-073-00	METAL CHIP 10K 5%	1/10W	R386	1-216-073-00	METAL CHIP 10K 5%	1/10W
R143	1-216-073-00	METAL CHIP 10K 5%	1/10W				
R144	1-216-025-00	RES, CHIP 100 5%	1/10W	R387	1-216-069-00	METAL CHIP 6.8K 5%	1/10W
				R388	1-216-069-00	METAL CHIP 6.8K 5%	1/10W
R146	1-216-037-00	METAL CHIP 330 5%	1/10W	R389	1-216-069-00	METAL CHIP 6.8K 5%	1/10W
R147	1-216-025-00	RES, CHIP 100 5%	1/10W	R391	1-216-073-00	METAL CHIP 10K 5%	1/10W
R148	1-216-045-00	METAL CHIP 680 5%	1/10W	R393	1-216-073-00	METAL CHIP 10K 5%	1/10W
R158	1-216-097-00	RES, CHIP 100K 5%	1/10W				
R159	1-216-097-00	RES, CHIP 100K 5%	1/10W	R400	1-216-073-00	METAL CHIP 10K 5%	1/10W
				R401	1-216-089-00	RES, CHIP 47K 5%	1/10W
R161	1-216-057-00	METAL CHIP 2.2K 5%	1/10W	R402	1-216-113-00	METAL CHIP 470K 5%	1/10W
R162	1-216-057-00	METAL CHIP 2.2K 5%	1/10W	R405	1-216-063-00	RES, CHIP 3.9K 5%	1/10W
R163	1-216-057-00	METAL CHIP 2.2K 5%	1/10W	R420	1-216-097-00	RES, CHIP 100K 5%	1/10W
R164	1-216-033-00	METAL CHIP 220 5%	1/10W				
R165	1-216-097-00	RES, CHIP 100K 5%	1/10W	R421	1-216-097-00	RES, CHIP 100K 5%	1/10W
				R422	1-216-097-00	RES, CHIP 100K 5%	1/10W
R166	1-220-149-11	REGISTER 2.2 10%	1/2W	R423	1-216-097-00	RES, CHIP 100K 5%	1/10W
R167	1-216-065-00	RES, CHIP 4.7K 5%	1/10W	R424	1-216-097-00	RES, CHIP 100K 5%	1/10W
R169	1-219-724-11	METAL CHIP 1 1%	1/4W	R425	1-216-097-00	RES, CHIP 100K 5%	1/10W
R170	1-216-073-00	METAL CHIP 10K 5%	1/10W				
R171	1-216-073-00	METAL CHIP 10K 5%	1/10W	R429	1-216-097-00	RES, CHIP 100K 5%	1/10W
				R430	1-216-097-00	RES, CHIP 100K 5%	1/10W
R175	1-216-061-00	METAL CHIP 3.3K 5%	1/10W	R431	1-216-097-00	RES, CHIP 100K 5%	1/10W
R177	1-216-061-00	METAL CHIP 3.3K 5%	1/10W	R432	1-216-097-00	RES, CHIP 100K 5%	1/10W
R178	1-216-295-00	SHORT 0		R433	1-216-097-00	RES, CHIP 100K 5%	1/10W
R179	1-216-091-00	METAL CHIP 56K 5%	1/10W				
R180	1-216-073-00	METAL CHIP 10K 5%	1/10W	R434	1-216-097-00	RES, CHIP 100K 5%	1/10W
				R435	1-216-097-00	RES, CHIP 100K 5%	1/10W
R182	1-216-089-00	RES, CHIP 47K 5%	1/10W	R438	1-216-097-00	RES, CHIP 100K 5%	1/10W
R183	1-216-089-00	RES, CHIP 47K 5%	1/10W	R439	1-216-097-00	RES, CHIP 100K 5%	1/10W
R184	1-216-073-00	METAL CHIP 10K 5%	1/10W	R440	1-216-097-00	RES, CHIP 100K 5%	1/10W
R188	1-216-073-00	METAL CHIP 10K 5%	1/10W				
				R441	1-216-097-00	RES, CHIP 100K 5%	1/10W

BD (MD)**EJECT****HP****JOINT**

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
R442	1-216-097-00	RES, CHIP	100K 5% 1/10W			< DIODE >	
R443	1-216-097-00	RES, CHIP	100K 5% 1/10W				
R444	1-216-097-00	RES, CHIP	100K 5% 1/10W				
R445	1-216-097-00	RES, CHIP	100K 5% 1/10W	D906	8-719-069-45	LED SELU5E23C-TP15 (MD DISC SLOT INDICATOR)	
R448	1-216-097-00	RES, CHIP	100K 5% 1/10W			< JACK >	
R449	1-216-097-00	RES, CHIP	100K 5% 1/10W	J101	1-691-293-51	JACK (PHONES)	
R451	1-216-097-00	RES, CHIP	100K 5% 1/10W			< RESISTOR >	
R454	1-216-097-00	RES, CHIP	100K 5% 1/10W	R104	1-202-997-11	RES, CHIP 270 5% 1/2W	
R455	1-216-097-00	RES, CHIP	100K 5% 1/10W	R105	1-202-997-11	RES, CHIP 270 5% 1/2W	
R456	1-216-097-00	RES, CHIP	100K 5% 1/10W	R935	1-216-025-00	RES, CHIP 100 5% 1/10W	
R457	1-216-097-00	RES, CHIP	100K 5% 1/10W			< SWITCH >	
R458	1-216-097-00	RES, CHIP	100K 5% 1/10W	S906	1-762-875-21	SWITCH, KEYBOARD (TUNER/BAND)	
R460	1-216-073-00	METAL CHIP	10K 5% 1/10W	*****			
R462	1-216-073-00	METAL CHIP	10K 5% 1/10W	*	1-671-425-11	JOINT BOARD	
R502	1-216-295-00	SHORT	0	*****			
R504	1-216-295-00	SHORT	0				
R600	1-216-053-00	METAL CHIP	1.5K 5% 1/10W		1-533-293-11	FUSE HOLDER	
R602	1-216-025-00	RES, CHIP	100 5% 1/10W			< CAPACITOR >	
R603	1-216-025-00	RES, CHIP	100 5% 1/10W	C101	1-115-339-11	CERAMIC CHIP 0.1uF 10% 50V (AEP, UK)	
R604	1-216-061-00	METAL CHIP	3.3K 5% 1/10W	C102	1-115-339-11	CERAMIC CHIP 0.1uF 10% 50V (AEP, UK)	
R605	1-216-025-00	RES, CHIP	100 5% 1/10W	C103	1-164-222-11	CERAMIC CHIP 0.22uF 25V (AEP, UK)	
R606	1-216-061-00	METAL CHIP	3.3K 5% 1/10W	C104	1-164-222-11	CERAMIC CHIP 0.22uF 25V (AEP, UK)	
R607	1-216-061-00	METAL CHIP	3.3K 5% 1/10W	C105	1-164-222-11	CERAMIC CHIP 0.22uF 25V (AEP, UK)	
R608	1-216-025-00	RES, CHIP	100 5% 1/10W	C106	1-164-222-11	CERAMIC CHIP 0.22uF 25V (AEP, UK)	
R2001	1-216-001-00	METAL CHIP	10 5% 1/10W			< CONNECTOR >	
R2002	1-216-296-00	SHORT	0	CN101	1-564-321-00	PIN, CONNECTOR 2P (US, CND, AEP, UK)	
		< VIBRATOR >		* CN101	1-564-687-11	PIN, CONNECTOR 3P (SP, HK)	
X101	1-767-286-11	VIBRATOR, CRYSTAL (22.5792MHz)		CN102	1-784-038-21	CONNECTOR, BOARD TO BOARD 9P	
X302	1-767-670-11	VIBRATOR, CERAMIC (7MHz)		CN103	1-580-230-11	PIN, CONNECTOR (PC BOARD) 2P	
*****				* CN104	1-564-520-11	PLUG, CONNECTOR 5P	
*	1-671-426-11	EJECT BOARD	*****			< DIODE >	
		< CONNECTOR >		D522	8-719-988-62	DIODE 1SS355	
* CN902	1-568-942-11	PIN, CONNECTOR 4P		D523	8-719-988-62	DIODE 1SS355	
		< SWITCH >				< FUSE >	
S907	1-762-875-21	SWITCH, KEYBOARD (▲ (CD))		△F101	1-532-388-51	FUSE (T2AL/250V) (SP, HK)	
S916	1-570-953-11	SWITCH, PUSH		△F101	1-532-463-51	FUSE (T1AL/250V) (AEP, UK)	
		(CD LID OPEN/CLOSE DETECT)		△F101	1-576-104-11	FUSE (2A/250V) (US, CND)	
*****						< RESISTOR >	
*	1-671-424-11	HP BOARD	*****	△R101	1-202-725-00	SOLID 3.3M 10% 1/2W (US, CND)	
		< CAPACITOR >		R102	1-218-232-91	RES, CHIP 4.7 10% 1/2W (AEP, UK)	
C107	1-115-339-11	CERAMIC CHIP 0.1uF 10% 50V		R103	1-218-232-91	RES, CHIP 4.7 10% 1/2W (AEP, UK)	
C108	1-163-141-00	CERAMIC CHIP 0.001uF 5% 50V		R544	1-216-077-00	METAL CHIP 15K 5% 1/10W	
C109	1-163-141-00	CERAMIC CHIP 0.001uF 5% 50V					
C932	1-163-141-00	CERAMIC CHIP 0.001uF 5% 50V					
		< CONNECTOR >					
CN903	1-506-468-11	PIN, CONNECTOR 3P					

The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.	Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.
--	---

JOINT

MAIN

Ref. No.	Part No.	Description	Remark		
R547	1-216-077-00	METAL CHIP 15K 5%	1/10W		
		< SWITCH >			
△ S101	1-572-675-11	SWITCH, POWER VOLTAGE CHANGE (VOLTAGE SELECTOR) (SP, HK)			
		< TERMINAL >			
TM101	1-694-471-11	TERMINAL BOARD (SPEAKER)			

*	A-4417-230-A	MAIN BOARD, COMPLETE (AEP, UK)			
*	A-4417-310-A	MAIN BOARD, COMPLETE (SP, HK)			
*	A-4417-312-A	MAIN BOARD, COMPLETE (US, CND)			
		< CAPACITOR >			
C702	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C703	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C704	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C705	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C709	1-126-925-11	ELECT 470uF 20%	10V		
C710	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C711	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C712	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C713	1-104-664-11	ELECT 47uF 20%	16V		
C714	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C715	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C716	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C717	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C718	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C719	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C720	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C721	1-126-964-11	ELECT 10uF 20%	50V		
C722	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C723	1-164-004-11	CERAMIC CHIP 0.1uF 10%	25V		
C724	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C726	1-104-664-11	ELECT 47uF 20%	16V		
C727	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C728	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C729	1-126-916-11	ELECT 1000uF 20%	6.3V		
C731	1-104-664-11	ELECT 47uF 20%	16V		
C732	1-126-964-11	ELECT 10uF 20%	50V		
C733	1-126-964-11	ELECT 10uF 20%	50V		
C734	1-163-117-00	CERAMIC CHIP 100PF 5%	50V		
C735	1-163-005-11	CERAMIC CHIP 470PF 10%	50V		
C736	1-163-005-11	CERAMIC CHIP 470PF 10%	50V		
C737	1-163-009-11	CERAMIC CHIP 0.001uF 10%	50V		
C738	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C739	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C740	1-126-047-91	ELECT 4.7uF 20%	50V		
C741	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C742	1-126-047-91	ELECT 4.7uF 20%	50V		
C743	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C744	1-104-664-11	ELECT 47uF 20%	16V		
C746	1-164-004-11	CERAMIC CHIP 0.1uF 10%	25V		
C748	1-130-475-00	MYLAR 0.0022uF 5%	50V		
C749	1-130-475-00	MYLAR 0.0022uF 5%	50V		
C750	1-104-664-11	ELECT 47uF 20%	16V		

Ref. No.	Part No.	Description	Remark		
C751	1-163-009-11	CERAMIC CHIP 0.001uF 10%	50V		
C752	1-104-664-11	ELECT 47uF 20%	16V		
C753	1-130-477-00	MYLAR 0.0033uF 5%	50V		
C754	1-104-664-11	ELECT 47uF 20%	16V		
C755	1-126-047-91	ELECT 4.7uF 20%	50V		
C756	1-126-047-91	ELECT 4.7uF 20%	50V		
C757	1-126-047-91	ELECT 4.7uF 20%	50V		
C758	1-126-047-91	ELECT 4.7uF 20%	50V		
C759	1-126-047-91	ELECT 4.7uF 20%	50V		
C760	1-126-047-91	ELECT 4.7uF 20%	50V		
C761	1-126-047-91	ELECT 4.7uF 20%	50V		
C762	1-126-047-91	ELECT 4.7uF 20%	50V		
C763	1-136-165-00	FILM 0.1uF 5%	50V		
C764	1-136-165-00	FILM 0.1uF 5%	50V		
C766	1-164-004-11	CERAMIC CHIP 0.1uF 10%	25V		
C768	1-126-960-11	ELECT 1uF 20%	50V		
C769	1-126-957-11	ELECT 0.22uF 20%	50V		
C770	1-126-957-11	ELECT 0.22uF 20%	50V		
C772	1-130-473-00	MYLAR 0.0015uF 5%	50V		
C773	1-130-473-00	MYLAR 0.0015uF 5%	50V		
C774	1-117-749-11	FILM CHIP 0.1uF 20%	50V		
C775	1-117-749-11	FILM CHIP 0.1uF 20%	50V		
C776	1-117-749-11	FILM CHIP 0.1uF 20%	50V		
C777	1-117-749-11	FILM CHIP 0.1uF 20%	50V		
C779	1-126-964-11	ELECT 10uF 20%	50V		
C780	1-163-009-11	CERAMIC CHIP 0.001uF 10%	50V		
C781	1-104-664-11	ELECT 47uF 20%	16V		
C782	1-104-664-11	ELECT 47uF 20%	16V		
C783	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V		
C784	1-163-235-11	CERAMIC CHIP 22PF 5%	50V		
C785	1-163-234-11	CERAMIC CHIP 20PF 5%	50V		
C787	1-104-664-11	ELECT 47uF 20%	16V		
C788	1-163-009-11	CERAMIC CHIP 0.001uF 10%	50V		
C789	1-126-059-11	ELECT 10uF 20%	50V		
C790	1-126-059-11	ELECT 10uF 20%	50V		
C791	1-164-004-11	CERAMIC CHIP 0.1uF 10%	25V		
C792	1-163-005-11	CERAMIC CHIP 470PF 10%	50V		
C793	1-163-005-11	CERAMIC CHIP 470PF 10%	50V		
C794	1-164-004-11	CERAMIC CHIP 0.1uF 10%	25V		
C795	1-104-664-11	ELECT 47uF 20%	16V		
			(AEP, UK)		
C796	1-164-004-11	CERAMIC CHIP 0.1uF 10%	25V		
			(AEP, UK)		
C797	1-164-004-11	CERAMIC CHIP 0.1uF 10%	25V		
C799	1-163-139-00	CERAMIC CHIP 820PF 5%	50V		
			(AEP, UK)		
C800	1-104-664-11	ELECT 47uF 20%	16V		
C801	1-163-003-11	CERAMIC CHIP 330PF 10%	50V		
			(AEP, UK)		
C802	1-163-011-11	CERAMIC CHIP 1500PF 10%	50V		
			(AEP, UK)		
C803	1-126-964-11	ELECT 10uF 20%	50V		
			(AEP, UK)		
C804	1-163-017-00	CERAMIC CHIP 4700PF 10%	50V		
			(AEP, UK)		
C805	1-126-961-11	ELECT 2.2uF 20%	50V		
			(AEP, UK)		
C806	1-163-239-11	CERAMIC CHIP 33PF 5%	50V		
			(AEP, UK)		

The components identified by mark △ or dotted line with mark △ are critical for safety. Replace only with part number specified.	Les composants identifiés par une marque △ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.
--	--

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
C807	1-163-239-11	CERAMIC CHIP 33PF 5%	50V (AEP, UK)	IC704	8-759-269-09	IC SN74HCT04ANS	
C808	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V (AEP, UK)	IC705	8-759-494-40	IC M62428AFP600C	
C809	1-163-009-11	CERAMIC CHIP 0.001uF 10%	50V (AEP, UK)	IC706	8-759-481-02	IC M62016L	
C810	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V (AEP, UK)	IC707	8-759-545-08	IC uPD78078GF-083-3BA	
C811	1-126-964-11	ELECT 10uF 20%	50V (AEP, UK)	IC708	8-759-635-63	IC M51943BSL	
C812	1-126-059-11	ELECT 10uF 20%	50V	IC710	8-759-450-88	IC BU1922-E2 (AEP, UK)	
C813	1-126-059-11	ELECT 10uF 20%	50V			< JACK >	
C814	1-126-047-91	ELECT 4.7uF 20%	50V	J501	1-764-593-21	JACK 2P (TAPE, OUT)	
C815	1-126-047-91	ELECT 4.7uF 20%	50V	J502	1-764-593-21	JACK 2P (TAPE, IN)	
C816	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V			< SHORT >	
		< CONNECTOR >		JW702	1-216-296-00	SHORT 0	
CN701	1-770-167-11	CONNECTOR, FFC/FPC 19P		JW703	1-216-295-00	SHORT 0	
* CN702	1-568-941-11	PIN, CONNECTOR 3P		JW704	1-216-295-00	SHORT 0 (US, CND, SP, HK)	
CN703	1-784-776-11	CONNECTOR, FFC 15P		JW705	1-216-295-00	SHORT 0 (US, CND)	
CN704	1-779-636-11	CONNECTOR, FFC/FPC 25P		JW707	1-216-296-00	SHORT 0	
CN705	1-779-967-12	SOCKET, CONNECTOR (PC BOARD) 24P				< COIL >	
CN706	1-779-568-11	CONNECTOR, FFC (LIF(NON-ZIF)) 31P		L701	1-412-029-11	INDUCTOR CHIP 10uH	
CN707	1-506-481-11	PIN, CONNECTOR 2P		L702	1-412-028-11	INDUCTOR CHIP 4.7uH	
		< DIODE >		L703	1-412-032-11	INDUCTOR CHIP 100uH	
D701	8-719-988-62	DIODE 1SS355		L704	1-412-032-11	INDUCTOR CHIP 100uH	
D702	8-719-988-62	DIODE 1SS355		L705	1-412-032-11	INDUCTOR CHIP 100uH	
D703	8-719-977-03	DIODE DTZ5.6B				< TRANSISTOR >	
D704	8-719-422-31	DIODE MA8047-M		Q701	8-729-202-38	TRANSISTOR 2SC3326N	
D705	8-719-988-62	DIODE 1SS355		Q702	8-729-202-38	TRANSISTOR 2SC3326N	
D707	8-719-988-62	DIODE 1SS355		Q703	8-729-202-38	TRANSISTOR 2SC3326N	
D708	8-719-988-62	DIODE 1SS355		Q704	8-729-202-38	TRANSISTOR 2SC3326N	
D709	8-719-210-33	DIODE EC10DS2		Q705	8-729-424-08	TRANSISTOR UN2111	
D710	8-719-988-62	DIODE 1SS355				< RESISTOR >	
D711	8-719-988-62	DIODE 1SS355 (AEP, UK)		Q706	8-729-424-08	TRANSISTOR UN2111	
D712	8-719-988-62	DIODE 1SS355 (AEP, UK)		Q707	8-729-421-22	TRANSISTOR UN2211	
D713	8-719-210-33	DIODE EC10DS2		Q708	8-729-202-38	TRANSISTOR 2SC3326N	
D714	8-719-210-33	DIODE EC10DS2		Q709	8-729-202-38	TRANSISTOR 2SC3326N	
D715	8-719-210-33	DIODE EC10DS2 (AEP, UK)		Q710	8-729-120-28	TRANSISTOR 2SC1623-L5L6	
D716	8-719-210-33	DIODE EC10DS2				< RESISTOR >	
D717	8-719-210-33	DIODE EC10DS2		Q711	8-729-421-22	TRANSISTOR UN2211	
D718	8-719-210-39	DIODE EC10QS-04		Q712	8-729-421-22	TRANSISTOR UN2211	
D719	8-719-210-39	DIODE EC10QS-04		Q713	8-729-120-28	TRANSISTOR 2SC1623-L5L6 (AEP, UK)	
D720	8-719-422-49	DIODE MA8056-L				< RESISTOR >	
D721	8-719-210-33	DIODE EC10DS2		R701	1-216-049-11	RES, CHIP 1K 5% 1/10W	
		< FERRITE BEAD >		R702	1-216-049-11	RES, CHIP 1K 5% 1/10W	
FB702	1-500-445-21	FERRITE 0uH		R703	1-216-097-00	RES, CHIP 100K 5% 1/10W	
FB704	1-500-445-21	FERRITE 0uH		R704	1-216-097-00	RES, CHIP 100K 5% 1/10W	
FB705	1-500-445-21	FERRITE 0uH		R705	1-216-097-00	RES, CHIP 100K 5% 1/10W	
FB706	1-500-445-21	FERRITE 0uH				< RESISTOR >	
FB707	1-500-445-21	FERRITE 0uH		R706	1-216-097-00	RES, CHIP 100K 5% 1/10W	
FB708	1-500-445-21	FERRITE 0uH (AEP, UK)		R707	1-216-073-00	METAL CHIP 10K 5% 1/10W	
FB709	1-500-445-21	FERRITE 0uH		R708	1-216-073-00	METAL CHIP 10K 5% 1/10W	
		< IC >		R709	1-216-057-00	METAL CHIP 2.2K 5% 1/10W	
IC702	8-759-822-09	IC LB1641		R710	1-216-057-00	METAL CHIP 2.2K 5% 1/10W	
						< RESISTOR >	
				R711	1-216-057-00	METAL CHIP 2.2K 5% 1/10W	
				R712	1-216-057-00	METAL CHIP 2.2K 5% 1/10W	
				R713	1-216-037-00	METAL CHIP 330 5% 1/10W	
				R714	1-216-077-00	METAL CHIP 15K 5% 1/10W	

MAIN

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
R715	1-216-077-00	METAL CHIP	15K 5%	1/10W	R772	1-216-065-00	RES, CHIP 4.7K 5% 1/10W
R716	1-216-065-00	RES, CHIP	4.7K 5%	1/10W	R773	1-216-061-00	METAL CHIP 3.3K 5% 1/10W
R717	1-216-065-00	RES, CHIP	4.7K 5%	1/10W	R774	1-216-041-00	METAL CHIP 470 5% 1/10W
R718	1-216-065-00	RES, CHIP	4.7K 5%	1/10W	R775	1-216-065-00	RES, CHIP 4.7K 5% 1/10W
R719	1-216-065-00	RES, CHIP	4.7K 5%	1/10W	R776	1-216-061-00	METAL CHIP 3.3K 5% 1/10W
R720	1-216-073-00	METAL CHIP	10K 5%	1/10W	R777	1-216-041-00	METAL CHIP 470 5% 1/10W
R721	1-216-073-00	METAL CHIP	10K 5%	1/10W	R778	1-216-061-00	METAL CHIP 3.3K 5% 1/10W
R722	1-216-097-00	RES, CHIP	100K 5%	1/10W	R779	1-216-025-00	RES, CHIP 100 5% 1/10W
R723	1-216-097-00	RES, CHIP	100K 5%	1/10W	R780	1-216-025-00	RES, CHIP 100 5% 1/10W
R724	1-216-049-11	RES, CHIP	1K 5%	1/10W	R781	1-216-025-00	RES, CHIP 100 5% 1/10W
R725	1-216-049-11	RES, CHIP	1K 5%	1/10W	R785	1-216-049-11	RES, CHIP 1K 5% 1/10W
R726	1-216-025-00	RES, CHIP	100 5%	1/10W	R786	1-216-049-11	RES, CHIP 1K 5% 1/10W
R727	1-216-057-00	METAL CHIP	2.2K 5%	1/10W	R787	1-216-109-00	METAL CHIP 330K 5% 1/10W
R728	1-216-097-00	RES, CHIP	100K 5%	1/10W	R788	1-216-049-11	RES, CHIP 1K 5% 1/10W
R729	1-216-057-00	METAL CHIP	2.2K 5%	1/10W	R789	1-216-049-11	RES, CHIP 1K 5% 1/10W
R730	1-216-097-00	RES, CHIP	100K 5%	1/10W	R790	1-216-049-11	RES, CHIP 1K 5% 1/10W
R731	1-216-121-00	RES, CHIP	1M 5%	1/10W	R791	1-216-049-11	RES, CHIP 1K 5% 1/10W
R732	1-216-121-00	RES, CHIP	1M 5%	1/10W	R792	1-216-073-00	METAL CHIP 10K 5% 1/10W
R733	1-216-055-00	METAL CHIP	1.8K 5%	1/10W	R793	1-216-081-00	METAL CHIP 22K 5% 1/10W
R734	1-216-055-00	METAL CHIP	1.8K 5%	1/10W	R794	1-216-113-00	METAL CHIP 470K 5% 1/10W
R735	1-216-069-00	METAL CHIP	6.8K 5%	1/10W	R795	1-216-113-00	METAL CHIP 470K 5% 1/10W
R736	1-216-069-00	METAL CHIP	6.8K 5%	1/10W	R796	1-216-089-00	RES, CHIP 47K 5% 1/10W
R737	1-216-055-00	METAL CHIP	1.8K 5%	1/10W	R797	1-216-089-00	RES, CHIP 47K 5% 1/10W
R738	1-216-069-00	METAL CHIP	6.8K 5%	1/10W	R798	1-216-025-00	RES, CHIP 100 5% 1/10W
R739	1-216-085-00	METAL CHIP	33K 5%	1/10W			(AEP, UK)
R740	1-216-055-00	METAL CHIP	1.8K 5%	1/10W	R799	1-216-073-00	METAL CHIP 10K 5% 1/10W
R741	1-216-073-00	METAL CHIP	10K 5%	1/10W	R800	1-216-025-00	RES, CHIP 100 5% 1/10W
R742	1-216-069-00	METAL CHIP	6.8K 5%	1/10W	R801	1-216-025-00	RES, CHIP 100 5% 1/10W
R743	1-216-081-00	METAL CHIP	22K 5%	1/10W	R802	1-216-025-00	RES, CHIP 100 5% 1/10W
R744	1-216-081-00	METAL CHIP	22K 5%	1/10W	R803	1-216-025-00	RES, CHIP 100 5% 1/10W
R745	1-216-121-00	RES, CHIP	1M 5%	1/10W	R804	1-216-025-00	RES, CHIP 100 5% 1/10W
R746	1-216-101-00	METAL CHIP	150K 5%	1/10W	R805	1-216-025-00	RES, CHIP 100 5% 1/10W
R747	1-216-101-00	METAL CHIP	150K 5%	1/10W	R806	1-216-025-00	RES, CHIP 100 5% 1/10W
R748	1-216-121-00	RES, CHIP	1M 5%	1/10W	R807	1-216-025-00	RES, CHIP 100 5% 1/10W
R749	1-216-059-00	METAL CHIP	2.7K 5%	1/10W	R808	1-216-025-00	RES, CHIP 100 5% 1/10W
R750	1-216-059-00	METAL CHIP	2.7K 5%	1/10W	R809	1-216-025-00	RES, CHIP 100 5% 1/10W
R751	1-216-025-00	RES, CHIP	100 5%	1/10W	R810	1-216-025-00	RES, CHIP 100 5% 1/10W
R752	1-216-025-00	RES, CHIP	100 5%	1/10W	R811	1-216-025-00	RES, CHIP 100 5% 1/10W
R753	1-216-073-00	METAL CHIP	10K 5%	1/10W	R813	1-216-073-00	METAL CHIP 10K 5% 1/10W
R754	1-216-025-00	RES, CHIP	100 5%	1/10W	R814	1-216-047-00	RES, CHIP 820 5% 1/10W
R755	1-216-049-11	RES, CHIP	1K 5%	1/10W			(AEP, UK)
R756	1-216-025-00	RES, CHIP	100 5%	1/10W	R815	1-216-056-00	RES, CHIP 2K 5% 1/10W
R757	1-216-025-00	RES, CHIP	100 5%	1/10W			(AEP, UK)
R758	1-216-025-00	RES, CHIP	100 5%	1/10W	R816	1-216-061-00	METAL CHIP 3.3K 5% 1/10W
R759	1-216-073-00	METAL CHIP	10K 5%	1/10W	R817	1-216-073-00	METAL CHIP 10K 5% 1/10W
R760	1-216-041-00	METAL CHIP	470 5%	1/10W	R818	1-216-093-00	METAL CHIP 68K 5% 1/10W
R761	1-216-073-00	METAL CHIP	10K 5%	1/10W			(AEP, UK)
R762	1-216-041-00	METAL CHIP	470 5%	1/10W	R819	1-216-100-00	RES, CHIP 130K 5% 1/10W
R763	1-216-025-00	RES, CHIP	100 5%	1/10W			(AEP, UK)
R764	1-216-025-00	RES, CHIP	100 5%	1/10W	R820	1-216-041-00	METAL CHIP 470 5% 1/10W
R765	1-216-025-00	RES, CHIP	100 5%	1/10W	R821	1-216-073-00	RES, CHIP 10K 5% 1/10W
R766	1-216-025-00	RES, CHIP	100 5%	1/10W			(AEP, UK)
R767	1-216-041-00	METAL CHIP	470 5%	1/10W	R822	1-216-073-00	RES, CHIP 10K 5% 1/10W
R768	1-216-073-00	METAL CHIP	10K 5%	1/10W			(AEP, UK)
R769	1-216-025-00	RES, CHIP	100 5%	1/10W	R823	1-216-049-11	RES, CHIP 1K 5% 1/10W
R770	1-216-025-00	RES, CHIP	100 5%	1/10W			(AEP, UK)
R771	1-216-025-00	RES, CHIP	100 5%	1/10W	R824	1-218-282-11	RES, CHIP 22 5% 1/2W
							(AEP, UK)
				R825	1-216-061-00	METAL CHIP 3.3K 5% 1/10W	

PANEL **POWER**

Ref. No.	Part No.	Description	Remark
R929	1-216-045-00	METAL CHIP 680 5%	1/10W
R930	1-216-037-00	METAL CHIP 330 5%	1/10W
R931	1-216-049-11	RES, CHIP 1K 5%	1/10W
R932	1-216-049-11	RES, CHIP 1K 5%	1/10W
R933	1-216-053-00	METAL CHIP 1.5K 5%	1/10W
R934	1-216-053-00	METAL CHIP 1.5K 5%	1/10W
R936	1-216-057-00	METAL CHIP 2.2K 5%	1/10W
R937	1-216-057-00	METAL CHIP 2.2K 5%	1/10W
R938	1-216-001-00	METAL CHIP 10 5%	1/10W
R939	1-216-065-00	RES, CHIP 4.7K 5%	1/10W
R940	1-216-029-00	METAL CHIP 150 5%	1/10W
R941	1-216-075-00	METAL CHIP 12K 5%	1/10W
R944	1-216-029-00	METAL CHIP 150 5%	1/10W
R945	1-216-029-00	METAL CHIP 150 5%	1/10W
< SWITCH >			
S901	1-762-875-21	SWITCH, KEYBOARD (FUNCTION)	
S902	1-762-875-21	SWITCH, KEYBOARD (CD, ■)	
S903	1-762-875-21	SWITCH, KEYBOARD (I/⏪)	
S904	1-762-875-21	SWITCH, KEYBOARD (CD/MD, ►►►►)	
S905	1-762-875-21	SWITCH, KEYBOARD (CD, ►►)	
S908	1-762-875-21	SWITCH, KEYBOARD (CD/MD, ◀◀◀◀)	
S909	1-762-875-21	SWITCH, KEYBOARD (MD, ■)	
S910	1-762-875-21	SWITCH, KEYBOARD (REC)	
S911	1-762-875-21	SWITCH, KEYBOARD (MD, ►►)	
S912	1-762-875-21	SWITCH, KEYBOARD (CD-MD SYNC)	
S913	1-762-875-21	SWITCH, KEYBOARD (▲ (MD))	
S914	1-762-875-21	SWITCH, KEYBOARD (VOLUME, +)	
S915	1-762-875-21	SWITCH, KEYBOARD (VOLUME, -)	

*	A-4417-232-A	POWER BOARD, COMPLETE	*****
	1-533-293-11	FUSE HOLDER	
	7-685-646-79	SCREW +BVTP 3X8 TYPE2 N-S	
< CAPACITOR >			
C501	1-126-968-11	ELECT 100uF 20%	50V
C502	1-115-339-11	CERAMIC CHIP 0.1uF 10%	50V
C503	1-115-339-11	CERAMIC CHIP 0.1uF 10%	50V
C504	1-126-968-11	ELECT 100uF 20%	50V
C505	1-126-968-11	ELECT 100uF 20%	50V
C506	1-126-964-11	ELECT 10uF 20%	50V
C507	1-115-339-11	CERAMIC CHIP 0.1uF 10%	50V
C508	1-126-964-11	ELECT 10uF 20%	50V
C509	1-115-339-11	CERAMIC CHIP 0.1uF 10%	50V
C510	1-126-968-11	ELECT 100uF 20%	50V
C511	1-117-850-11	ELECT 15000uF 20%	16V
C512	1-126-042-11	ELECT 3300uF 20%	35V
C513	1-126-042-11	ELECT 3300uF 20%	35V
C514	1-126-964-11	ELECT 10uF 20%	50V
C515	1-126-964-11	ELECT 10uF 20%	50V
C516	1-126-960-11	ELECT 1uF 20%	50V
C517	1-126-964-11	ELECT 10uF 20%	50V
C518	1-126-964-11	ELECT 10uF 20%	50V
C519	1-126-933-11	ELECT 100uF 20%	16V
C520	1-126-952-11	ELECT 1000uF 20%	35V

Ref. No.	Part No.	Description	Remark
C522	1-126-916-11	ELECT 1000uF 20%	6.3V
C523	1-126-933-11	ELECT 100uF 20%	16V
C524	1-126-933-11	ELECT 100uF 20%	16V
C525	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V
C527	1-126-933-11	ELECT 100uF 20%	16V
C528	1-163-021-11	CERAMIC CHIP 0.01uF 10%	50V
C530	1-126-933-11	ELECT 100uF 20%	16V
C531	1-126-934-11	ELECT 220uF 20%	16V
C532	1-126-933-11	ELECT 100uF 20%	16V
C533	1-126-933-11	ELECT 100uF 20%	16V
C538	1-126-965-11	ELECT 22uF 20%	50V
C544	1-126-963-11	ELECT 4.7uF 20%	50V
C545	1-126-963-11	ELECT 4.7uF 20%	50V
C548	1-126-959-11	ELECT 0.47uF 20%	50V
C549	1-115-340-11	CERAMIC CHIP 0.22uF 10%	25V
C550	1-115-340-11	CERAMIC CHIP 0.22uF 10%	25V
C551	1-115-340-11	CERAMIC CHIP 0.22uF 10%	25V
C552	1-115-340-11	CERAMIC CHIP 0.22uF 10%	25V
C553	1-115-339-11	CERAMIC CHIP 0.1uF 10%	50V
C554	1-115-339-11	CERAMIC CHIP 0.1uF 10%	50V
C555	1-126-964-11	ELECT 10uF 20%	50V
< CONNECTOR >			
* CN501	1-564-915-11	PIN, CONNECTOR 7P	
CN502	1-779-568-11	CONNECTOR,FFC(LIF(NON-ZIF))31P	
CN503	1-784-041-41	CONNECTOR, BOARD TO BOARD 9P	
* CN504	1-564-518-11	PLUG, CONNECTOR 3P	
< DIODE >			
D501	8-719-988-62	DIODE 1SS355	
D502	8-719-988-62	DIODE 1SS355	
D503	8-719-210-33	DIODE EC10DS2	
D504	8-719-210-33	DIODE EC10DS2	
D505	8-719-210-33	DIODE EC10DS2	
D506	8-719-988-62	DIODE 1SS355	
D507	8-719-988-62	DIODE 1SS355	
D508	8-719-018-12	DIODE MA8330-L-TX	
D509	8-719-025-03	DIODE RBA-402-SL	
D510	8-719-210-33	DIODE EC10DS2	
D511	8-719-210-33	DIODE EC10DS2	
D512	8-719-210-33	DIODE EC10DS2	
D513	8-719-210-33	DIODE EC10DS2	
D518	8-719-420-14	DIODE MA8082-M	
D519	8-719-988-62	DIODE 1SS355	
D520	8-719-017-86	DIODE MA8140-M-TX	
D521	8-719-988-62	DIODE 1SS355	
D524	8-719-210-33	DIODE EC10DS2	
D525	8-719-210-33	DIODE EC10DS2	
D526	8-719-422-76	DIODE MA8075-M	
D527	8-719-988-62	DIODE 1SS355	
< FUSE >			
△ F501	1-532-504-51	FUSE (T4AL/250V) (AEP, UK, SP, HK)	
△ F501	1-576-108-11	FUSE (4A/125V) (US, CND)	
△ F502	1-532-504-51	FUSE (T4AL/250V) (AEP, UK, SP, HK)	
△ F502	1-576-108-11	FUSE (4A/125V) (US, CND)	
△ F503	1-532-464-51	FUSE (T2.5AL/250V) (AEP, UK, SP, HK)	

The components identified by mark △ or dotted line with mark △ are critical for safety. Replace only with part number specified.	Les composants identifiés par une marque △ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.
--	--

POWER

SENSOR

SW

Ref. No.	Part No.	Description	Remark
△ F503	1-576-105-11	FUSE (2.5A/250V) (US, CND)	
		< GROUND TERMINAL >	
EPT501	1-537-771-21	TERMINAL BOARD, GROUND	
		< IC >	
IC501	8-759-708-05	IC NJM78L05A	
IC502	8-759-445-59	IC BA033T	
IC503	8-759-158-62	IC TA78057S	
IC504	8-759-604-86	IC M5F7807L	
IC505	8-759-231-58	IC TA7812S	
		< COIL >	
L501	1-420-872-00	COIL, AIR-CORE	
L502	1-420-872-00	COIL, AIR-CORE	
		< TRANSISTOR >	
Q503	8-729-140-97	TRANSISTOR 2SB734-34	
Q504	8-729-424-59	TRANSISTOR UN2212	
Q505	8-729-424-12	TRANSISTOR UN2112	
Q506	8-729-120-28	TRANSISTOR 2SC1623-L5L6	
Q507	8-729-118-01	TRANSISTOR 2SB1116	
Q508	8-729-424-59	TRANSISTOR UN2212	
Q509	8-729-111-29	TRANSISTOR 2SD1616A-K	
Q510	8-729-120-28	TRANSISTOR 2SC1623-L5L6	
Q511	8-729-120-28	TRANSISTOR 2SC1623-L5L6	
Q512	8-729-424-12	TRANSISTOR UN2112	
Q514	8-729-120-28	TRANSISTOR 2SC1623-L5L6	
Q516	8-729-120-28	TRANSISTOR 2SC1623-L5L6	
Q518	8-729-216-22	TRANSISTOR 2SA1162-G	
Q519	8-729-021-82	TRANSISTOR 2SD2396K	
Q520	8-729-424-59	TRANSISTOR UN2212	
		< RESISTOR >	
R458	1-216-061-00	METAL CHIP 3.3K 5%	1/10W
△ R504	1-249-394-11	CARBON 12 5%	1/4W F
R505	1-216-065-00	RES, CHIP 4.7K 5%	1/10W
R506	1-216-065-00	RES, CHIP 4.7K 5%	1/10W
R507	1-216-065-00	RES, CHIP 4.7K 5%	1/10W
R508	1-216-081-00	RES, CHIP 22K 5%	1/10W
R509	1-216-097-00	RES, CHIP 100K 5%	1/10W
R510	1-216-073-00	METAL CHIP 10K 5%	1/10W
R511	1-216-057-00	METAL CHIP 2.2K 5%	1/10W
R512	1-216-033-00	METAL CHIP 220 5%	1/10W
R513	1-216-047-00	RES, CHIP 820 5%	1/10W
△ R514	1-249-397-11	CARBON 22 5%	1/4W F
R515	1-216-049-11	RES, CHIP 1K 5%	1/10W
R516	1-216-091-00	METAL CHIP 56K 5%	1/10W
R517	1-216-049-11	RES, CHIP 1K 5%	1/10W
R518	1-216-057-00	METAL CHIP 2.2K 5%	1/10W
R519	1-216-081-00	METAL CHIP 22K 5%	1/10W
R524	1-216-081-00	METAL CHIP 22K 5%	1/10W
R525	1-216-073-00	METAL CHIP 10K 5%	1/10W
R530	1-216-073-00	METAL CHIP 10K 5%	1/10W
R531	1-216-073-00	METAL CHIP 10K 5%	1/10W
R532	1-216-093-00	RES, CHIP 68K 5%	1/10W
R534	1-216-097-00	RES, CHIP 100K 5%	1/10W
R535	1-216-065-00	RES, CHIP 4.7K 5%	1/10W

Ref. No.	Part No.	Description	Remark
△ R536	1-249-387-11	CARBON 3.3 5%	1/4W F
R537	1-216-057-00	METAL CHIP 2.2K 5%	1/10W
R538	1-216-091-00	METAL CHIP 56K 5%	1/10W
R539	1-216-089-00	RES, CHIP 47K 5%	1/10W
R540	1-216-077-00	METAL CHIP 15K 5%	1/10W
R541	1-216-071-00	METAL CHIP 8.2K 5%	1/10W
R542	1-216-121-00	RES, CHIP 1M 5%	1/10W
R543	1-216-077-00	METAL CHIP 15K 5%	1/10W
R545	1-218-232-91	RES, CHIP 4.7 10%	1/2W
R546	1-218-232-91	RES, CHIP 4.7 10%	1/2W
R548	1-220-250-11	RES, CHIP 10 5%	1/2W
R549	1-220-250-11	RES, CHIP 10 5%	1/2W
		< RELAY >	
RY501	1-515-833-11	RELAY	

*	1-671-427-11	SENSOR BOARD	

		< SWITCH >	
S104	1-571-300-21	SWITCH, ROTARY (DISC DETECT)	

*	1-667-719-11	SW BOARD	

		< CONNECTOR >	
CN601	1-770-697-11	CONNECTOR, FFC/FPC 14P	
CN602	1-778-638-21	PIN, CONNECTOR (PC BOARD) 2P	
CN603	1-778-638-21	PIN, CONNECTOR (PC BOARD) 2P	
		< SWITCH >	
S681	1-572-467-61	SWITCH, PUSH (1 KEY) (LIMIT IN)	
S682	1-692-377-31	SWITCH, PUSH (1 KEY) (REFLECT)	
S683	1-692-847-21	SWITCH, PUSH (1 KEY) (PROTECT)	
S685	1-572-467-61	SWITCH, PUSH (1 KEY) (CHUCKING IN)	
S686	1-762-621-21	SWITCH, PUSH (1 KEY) (PACK OUT)	
S687	1-572-688-11	SWITCH, PUSH (1 KEY) (PB POSITION)	
S688	1-762-621-21	SWITCH, PUSH (1 KEY) (REC POSITION)	

		MISCELLANEOUS	

154	1-790-106-11	WIRE (FLAT TYPE) (31 CORE)	
155	1-775-170-11	WIRE (FLAT TYPE) (19 CORE)	
△ 163	1-770-019-11	ADAPTOR, CONVERSION PLUG 3P (HK)	
△ 164	1-575-651-21	CORD, POWER (AEP, SP, HK)	
△ 164	1-696-571-11	CORD, POWER (UK)	
△ 164	1-783-531-31	CORD, POWER (US, CND)	
△ 165	1-569-008-21	ADAPTOR, CONVERSION 2P (SP)	
166	1-773-009-11	WIRE (FLAT TYPE) (15 CORE)	
167	1-693-407-21	TUNER (US, CND)	
167	1-693-409-21	TUNER (AEP, UK, SP, HK)	
170	1-790-105-11	WIRE (FLAT TYPE) (25 CORE)	
202	1-660-966-11	OP RELAY FLEXIBLE BOARD	
203	1-782-683-11	WIRE (FLAT TYPE) (14 CORE)	
△ 251	8-583-028-02	OPTICAL PICK-UP KMS-260A/J1N (for MD)	

The components identified by mark △ or dotted line with △ are critical for safety. Replace only with part number specified.	Les composants identifiés par une marque △ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.
---	--

HCD-MD1EX

Ref. No.	Part No.	Description	Remark
△ 305	8-848-379-31	OPTICAL PICK-UP KSS-213B/K-N (for CD)	
306	1-769-069-11	WIRE (FLAT TYPE) (16 CORE)	
HR901	1-500-396-11	HEAD, OVER LIGHT (RF325-74A)	
M101	X-4942-405-1	BASE (OUTSART) ASSY (SPINDLE) (for CD)	
M102	X-4917-504-1	MOTOR ASSY (SLED) (for CD)	
M103	A-4411-278-A	MOTOR ASSY (CD LID OPEN/CLOSE)	
M501	1-698-997-11	FAN, D.C.	
M901	A-4672-135-A	MOTOR ASSY, SPINDLE (for MD)	
M902	A-4672-133-A	MOTOR ASSY, SLED (for MD)	
M903	A-4672-134-A	MOTOR ASSY, LOADING (for MD)	
△ T901	1-433-472-11	TRANSFORMER, POWER (US, CND)	
△ T901	1-433-473-11	TRANSFORMER, POWER (AEP, UK)	
△ T901	1-433-474-11	TRANSFORMER, POWER (SP, HK)	

 HARDWARE LIST

#1	7-685-646-79	SCREW +BVTP 3X8 TYPE2 N-S
#2	7-685-791-09	SCREW +PTT 2.6X5 (S)
#3	7-685-850-04	SCREW +BVTT 2X3 (S)
#4	7-685-871-01	SCREW +BVTT 3X6 (S)
#5	7-685-880-09	SCREW +BVTT 4X6 (S)
#6	7-685-851-04	SCREW +BVTT 2X4 (S)
#7	7-627-552-27	SCREW,PRECISION +P 1.7X2
#8	7-627-852-28	+P 1.7X3
#9	7-627-553-17	PRECISION SCREW +P 2X2 TYPE 3
#10	7-621-775-00	SCREW +B 2.6X3

The components identified by mark △ or dotted line with mark △ are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque △ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

MEMO

